Go, change the world



RV Educational Institutions [®] RV College of Engineering [®]

Autonomous Institution Affiliated to Visvesvaraya Technological University, Belagavi Approved by AICTE, New Delhi



Bachelor of Engineering (B.E) Scheme and Syllabus of VII & VIII Semesters

2018 SCHEME

ELECTRONICS AND COMMUNICATION ENGINEERING 2021-2022

VISION

Leadership in Quality Technical Education, Interdisciplinary Research & Innovation, with a Focus on Sustainable and Inclusive Technology

MISSION

- 1. To deliver outcome based Quality education, emphasizing on experiential learning with the state of the art infrastructure.
- 2. To create a conducive environment for interdisciplinary research and innovation.
- 3. To develop professionals through holistic education focusing on individual growth, discipline, integrity, ethics and social sensitivity.
- 4. To nurture industry-institution collaboration leading to competency enhancement and entrepreneurship.
- 5. To focus on technologies that are sustainable and inclusive, benefiting all sections of the society.

QUALITY POLICY

Achieving Excellence in Technical Education, Research and Consulting through an Outcome Based Curriculum focusing on Continuous Improvement and Innovation by Benchmarking against the global Best Practices.

CORE VALUES

Professionalism, Commitment, Integrity, Team Work, Innovation

RV COLLEGE OF ENGINEERING[®]

(Autonomous Institution Affiliated to VTU, Belagavi) R.V. Vidyaniketan Post, Mysore Road Bengaluru – 560 059



Bachelor of Engineering (B.E.) Scheme and Syllabus of VII & VIII Semesters

2018 SCHEME

DEPARTMENT OF ELECTRONICS AND COMMUNICATION ENGINEERING

DEPARTMENT VISION

Imparting quality technical education through interdisciplinary research, innovation and teamwork for developing inclusive & sustainable technology in the area of Electronics and Communication Engineering.

DEPARTMENT MISSION

- To impart quality technical education to produce industry-ready engineers with a research outlook.
- To train the Electronics & Communication Engineering graduates to meet future global challenges by inculcating a quest for modern technologies in the emerging areas.
- To create centers of excellence in the field of Electronics & Communication Engineering with industrial and university collaborations.
- To develop entrepreneurial skills among the graduates to create new employment opportunities.

PROGRAM EDUCATIONAL OBJECTIVES (PEOs)

- **PEO1.** To apply concepts of mathematics, science and computing to Electronics and Communication Engineering
- **PEO2.** To design and develop interdisciplinary and innovative systems.
- **PEO3.** To inculcate effective communication skills, team work, ethics, leadership in preparation for a successful career in industry and R & D organizations.

PSO	Description
PSO1	Should be able to clearly understand the concepts and applications in the field of Communication/networking, signal processing, embedded systems and semiconductor technology.
PSO2	Should be able to associate the learning from the courses related to Microelectronics, Signal processing, Microcomputers, Embedded and Communication Systems to arrive at solutions to real world problems.
PSO3	Should have the capability to comprehend the technological advancements in the usage of modern design tools to analyze and design subsystems/processes for a variety of applications.
PSO4	Should possess the skills to communicate in both oral and written forms, the work already done and the future plans with necessary road maps, demonstrating the practice of professional ethics and the concerns for societal and environmental wellbeing.

PROGRAM SPECIFIC OUTCOMES (PSOS)

Lead Society: Institute of Electrical and Electronics Engineers (IEEE)

Sl. No.	Abbreviation	Meaning				
1.	VTU	Visvesvaraya Technological University				
2.	BS	Basic Sciences				
3.	CIE	Continuous Internal Evaluation				
4.	SEE	Semester End Examination				
5.	PE	Professional Elective				
6.	GE	Global Elective				
7.	HSS	Humanities and Social Sciences				
8.	CV	Civil Engineering				
9.	ME	Mechanical Engineering				
10.	EE	Electrical & Electronics Engineering				
11.	EC	Electronics & Communication Engineering				
12.	IM	Industrial Engineering & Management				
13.	EI	Electronics & Instrumentation Engineering				
14.	СН	Chemical Engineering				
15.	CS	Computer Science & Engineering				
16.	TE	Telecommunication Engineering				
17.	IS	Information Science & Engineering				
18.	BT	Biotechnology				
19.	AS	Aerospace Engineering				
20.	PY	Physics				
21.	СҮ	Chemistry				
22.	MA	Mathematics				

ABBREVIATIONS

RV COLLEGE OF ENGINEERING® (Autonomous Institution Affiliated to VTU, Belagavi)

ELECTRONICS AND COMMUNICATION ENGINEERING

	SEVENTH SEMESTER CREDIT SCHEME										
SI.	Course			Cree	dit Alloo	cation	Total Credits				
No	Code	Course Title	BOS	L	Т	Р					
1.	18HS71	Constitution of India and Professional Ethics	HSS	3	0	0	3				
2.	18EC72	Microwave and Radiating Systems	EC	4	0	1	5				
3.	18EC73	Broadband Wireless -LTE 4G	EC	3	1	0	4				
4.	18EC74	Internship	EC	0	0	2	2				
5.	18EC7FX	Elective F (PE)	EC	3	0	0	3				
6.	18EC7GX	Elective G (PE)	EC	3	0	0	3				
7.	18G7HXX	Elective H (GE)*	Respective BOS	3	0	0	3				
	·	Total Number of Credits	19	1	3	23					
		Total Number of Hours/Week		19	2	7.5					

*Students should take other department global elective courses.

EIGTHSEMESTER CREDIT SCHEME										
Sl. No	Course			Cre	Total					
	Code	Course Title	BOS				Credits			
				L	Т	Р				
1.	18ECP81	Major Project	EC	0	0	16	16			
		Total Number of Credits	0	0	16	16				
		Total Number of Hours/Week			32					

	VII Semester PROFESSIONAL ELECTIVES (GROUP F)								
SI No									
1	18EC7F1	High Performance Computing	3						
2	18EC7F2	Mixed Signal Integrated Circuit Design	3						
3	18EC7F3	Design of Testing and Testability	3						
4	18EC7F4	Nanoelectronics	3						
5	18EC7F5	Speech Processing	3						
6	18EC7F6	Radar Systems Engineering	3						

	VII Semester								
	PROFESSIONAL ELECTIVES (GROUP G)								
Sl No	SI No Course code Course Title C								
1	18EC7G1	Automotive Electronics	3						
2	18EC7G2	Optoelectronics and Networks	3						
3	18EC7G3	System on Chip Design	3						
4	18EC7G4	Multimedia Communication	3						
5	18EC7G5	ASIC Design	3						
6	18EC7G6	ARM Programming & Optimization	3						

	VII Semester									
			GLOBAL ELECTIVES (GROUP H)							
Sl No	Host	Course	Course Title	Credits						
	Dept.	code								
1	AS	18G7H01	Unmanned Aerial Vehicles	3						
2	BT	18G7H02	Bioinformatics	3						
3	СН	18G7H03	Industrial Safety and Risk Management	3						
4	CS	18G7H04	Web Programming	3						
5	CV	18G7H05	Solid Waste Management and Statutory Rules	3						
6	EC	18G7H06	Image Processing with Machine Learning	3						
7	EE	18G7H07	Renewable Energy Sources and Storage System	3						
8	EI	18G7H08	MEMS and Applications	3						
9	IM	18G7H09	Project Management	3						
10	IS	18G7H10	Cyber Forensics and Digital Investigations	3						
11	ME	18G7H11	Robotics and Automation	3						
12	TE	18G7H12	Space Technology and Applications	3						
13	PY	18G7H13	Introduction to Astrophysics	3						
14	CY	18G7H14	Materials for Advanced Technology and Spectroscopic Characterization	3						
15	HSS	18G7H15	Applied psychology for Engineers	3						
16	HSS	18G7H16	Advanced Course in Entrepreneurship	3						

				с , м]			
	<u> </u>	NC	TITUTIO	Semester: VII	OFFSSIONAL FT	ПС	C			
	CONSTITUTION OF INDIA AND PROFESSIONAL ETHICS (Theory)									
				(Common to All Prog	(rams)					
Cou	rse Code	:	18HS71		CIE	:	100 Marks			
	dits: L:T:P	:	3:0:0		SEE	:				
Tota	l Hours	:	39L		SEE Duration	:	3.00 Hours			
Cou	rse Learning	Ob	jectives: T	ne students will be able to		_	l			
1				e constitutional literacy t	o become aware of the	fun	damental rights			
	and duties in									
2 Understanding of ethical and legal aspects of advertising, consumer problems and their redressal										
				ct and service standards.						
3			•	substantive Labor law an	d to develop skills for	lega	l reasoning and			
4	statutory into			monaibilities and an1	size on professional/ -		againg athing in			
4	shaping prof			esponsibilities and empha	size on professional/ e	ngin	eering etnics in			
L			10115.							
				Unit – I			10 Hrs			
India	an Constituti	on-	Salient fea	tures of IndianConstitution	on. Preamble to the Co	nsti	tution of India:			
				in India- at the Commer						
				uisition and Termination						
				32 with case studies; R						
studi	es.									
				Unit – II			10 Hrs			
				Policy- Significance o						
				itution of India; Union E						
				gislature; Council of Mini						
	ts Commission	-	provisions	; Elections, Administrat	ive tribunais. Human	Rig	ints & Human			
Kign		1.		Unit –III			06Hrs			
Cons	sumer Protec	tior	1 Law - De	finition and Need of Con	sumer Protection: Con-	sum				
				19; Unfair Trade Practice						
				nsequences, False and M						
	•			nism; Redresses Mechan	•					
2019										
An o	verview of In	dia	n Penal Co	de 1860 (Law of Crimes)					
				Unit – IV			06Hrs			
Intro	duction to L	ab	our Legisla	tions - Industrial Relation	n, Labour Problem an	d La	abour Policy in			
India	; Labour Wel	far	e and Socia	l Security- Factories Act	, 1948, Sexual Harassi	men	t of Women at			
				on and Redressal) Act,						
				y Benefit (Amendment)	Act, 2017; Industrial	Disp	oute Act, 1947,			
Refei	rence of Dispu	ites	toBoards, (Courts or Tribunals.						
				Unit –V			07Hrs			
-			0	g ethics (NSPE Code		•	•			
				Honesty, Integrity and re-						
				Responsibility. Statutor	y Provision regarding	g p	rohibition and			
preve	ention of Ragg	ging	ç.							

Course Outcomes: After completing the course, the students will be able to								
Demonstrate the citizen's fundamental Rights, duties & consumer responsibility capability								
and to take affirmative action as a responsible citizen.								
Identify the conflict management in legal perspective and judicial systems pertaining to								
professional environment, strengthen the ability to contribute to the resolve of human rights								
& Ragging issues and problems through investigative and analytical skills.								
Understanding process of ethical and moral analysis in decision making scenarios and								
inculcate ethical behavior as a trait for professional development.								
Apply the knowledge to solve practical problems with regard to personal issues & business								
Enterprises.								

Refer	ence Books
1	Dr. J. N Pandey, Constitutional Law of India, Central Law Agency, 2020.
2	Avtar Singh: Law of Consumer Protection: Principles and Practice, Eastern Book Company, 5 th Edition, 2015, ISBN -13:978-9351452461
3	S.C. Srivastava: Industrial Relation and Labour Laws, Vikas Publishing House, 6 th Edition, 2012, ISBN: 9789325955400
4	Jr. Charles E Harris, Michael. S. Pritchard and Michael J Rabins, Engineering Ethics, Wadsworth Cengage Learning, 5 th Edition, 2009, ISBN-978-0495502791

CIE is executed by way of quizzes (Q), tests (T) and experiential learning (EL). A minimum of three quizzes are conducted and each quiz is evaluated for 10 marks adding up to 30 marks. All quizzes are conducted online. Faculty may adopt innovative methods for conducting quizzes effectively. The number of quizzes may be more than three also. The three tests are conducted for 50 marks each and the sum of the marks scored from three tests is reduced to 50. The marks component for experiential learning is 20. Total CIE is 30(Q) + 50(T) + 20(EL) = 100 Marks.

Semester End Evaluation (SEE); Theory (100 Marks)

SEE for 100 marksis executed by means of an examination. The Question paper for the course contains two parts, Part – A and Part – B. Part – A consists of objective type questions for 20 marks covering the complete syllabus. Part – B consists of five main questions, one from each unit for 16 marks adding up to 80 marks. Each main question may have sub questions. The question from Units I, IV and V have no internal choice. Units II and III have internal choice in which both questions cover entire unit having same complexity in terms of COs and Bloom's taxonomy level.

	CO-PO Mapping											
CO/PO	PO1	PO2	PO3	PO4	PO5	PO6	PO7	PO8	PO9	PO10	PO11	PO12
CO1	3	2	-	-	-	-	-	-	-	1	-	1
CO2	3	2	2	1	-	-	-	-	-	1	-	1
CO3	3	3	2	2	-	-	-	-	-	1	-	1
CO4	3	3	3	3	-	-	-	-	-	1	-	1

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				Semester: V	II		
			MICR	OWAVE & RADIA			
Co	urse Code	:	18EC72	(Theory & Pra	ctice)	:	150 Marks
	edits: L:T:P	:	4:0:1		SEE	:	150 Marks
To	tal Hours	:	48 L+30 P		SEE Duration		3.00 Hours
Co	urse Learning	Ob	jectives: The	students will be able	to		
1	Ű				concepts of transmission	line t	heory.
2	Describe the	basi	c operation of	microwave devices.	*		-
3	Describe the	radi	ation from is	plated, linear wire an	tennas and from linear el	lemen	ts near or on a
	conducting su	ırfac	æ.				
4	Calculate the	fun	damental par	ameters for antennas	and the radiation field fr	om ar	antenna usin
	potential func	tion	IS.				
				Unit-I			09Hrs
	ansmission Lir						
				•	ns, termination of line	•	
	-			-	line and any load resisti		
-					nding waves and SWR(a		
gen	erator end), Qu	iarte	er wave transf		struction and properties,	Single	1
				Unit – II			10 Hrs
S-p	onant frequency oarameters: Int crowave Passi						
Wa shi	fters (Rotatory	ve D Dii type	Devices rectional coup e), Attenuator	(Rotatory type), (s-p	ver divider, Isolators (Far arameters of all devices)	aday i	
Wa shi	fters (Rotatory	ve D Dii type	Devices rectional coup e), Attenuator	lers, circulators, pow (Rotatory type), (s-p Ilator, Magnetron, T	ver divider, Isolators (Far arameters of all devices)	aday	solator), phas
Wa shi Mi	fters (Rotatory crowave Sourc	ve D Dii type	Devices rectional coup e), Attenuator	lers, circulators, pow (Rotatory type), (s-p	ver divider, Isolators (Far arameters of all devices)	aday	
Wa shi Mi An Intu into effi Wi Ele rad	tenna Basics roduction, anter ensity, beam efficiency, antenna re Antennas cetric dipoles: I iation resistant	ve D Din type ces: nna ficie a ter ntro ce),	Devices rectional coup c), Attenuators Klystron Osc radiation me ency, diversity nperature and duction, shor Half wave o	lers, circulators, pow (Rotatory type), (s-p <u>illator, Magnetron, T</u> <u>Unit – III</u> chanism, basic Anter and gain, antenna ap antenna field zones.	ver divider, Isolators (Far arameters of all devices)	beam bandw radia	10 Hrs area, radiation vidth, radiation ted, directivity
Wa shi Mi An Intu into effi Wi Ele rad	tenna Basics roduction, ante ensity, beam efficiency, antenna re Antennas retric dipoles: I	ve D Din type ces: nna ficie a ter ntro ce),	Devices rectional coup c), Attenuators Klystron Osc radiation me ency, diversity nperature and duction, shor Half wave o	lers, circulators, pow (Rotatory type), (s-p <u>illator, Magnetron, T</u> <u>Unit – III</u> chanism, basic Anter and gain, antenna ap antenna field zones.	ver divider, Isolators (Far parameters of all devices) WT amplifiers. ana parameters, patterns, pertures, effective height, b ds, power density, power	beam bandw radia	isolator), phas 10 Hrs area, radiation vidth, radiation ted, directivity

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Unit – V	10 Hrs
Introduction to Computational Electromagnetics	
Classification of CEM, Classification of EMProblems: Classification of Solution	Region. Finite
Element Method Introduction, Solution of Laplace's Equation, Finite Element Discretiz	ation, Element

Governing Equation, Assembling of All Elements, Solving the Resulting Equations, Solution of Poisson's Equation, Deriving Element-Governing Equation, Solving the Resulting Equations.

Practical's: Microwave and Radiating Systems Lab

Sl No	Experiment Name
1.	Study of Mode Curves of Reflex Klystron Source(X-band)
2.	Radiation Characteristics of Pyramidal Horn Antenna and Microstrip Patch (X-band)
3.	Characterization of Microwave Directional Coupler, Power divider, Hybrid coupler and Ring
	resonator (Strip line type, C-band)
4.	Design and Simulation of Waveguide Magic-Tee and Hybrid Ring using HFSS
5.	Characterization of Microwave Magic Tee, Directional Coupler, Circulator, Tunable
	Attenuator and Isolator (Waveguide type, X-band)
6.	Characterization of Lowpass, bandpass and band stop filters (C-Band)
7.	Illustration of RADAR Range / Target Detection
8.	Performance Analysis of Rayleigh and Rician Fading Channel Models
9.	Time and frequency diversity techniques
10.	Simulation of OFDM Transmission and Reception

Course	e Outcomes: After completing the course, the students will be able to
CO1:	Explain and summarize the working of transmission line, Waveguides, Microwave Passive
	Devices and Antennas.
CO2:	Analyze wave propagation in transmission line, Waveguides and characterize the passive
	microwave components and Antennas.
CO3:	Design the transmission lines, passive microwave components and Antennas for given
	specification and also match the impedance.
CO4:	Evaluate S-Parameter, VSWR for transmission lines, Microwave components and radiation
	pattern for Antennas.

Reference Books Microwave Engineering, David M Pozar,4thEdition, 2011, John Wiley, ISBN: 978-0-470-63155-3 Antenna Theory and Design, C A Balanis, 3rd Edition,2005, John Wiley & sons, Inc. publication, ISBN-13: 978-0471667827 Foundations of Microwave Engineering, R E Collin, 2009, 2nd Edition, IEEE Press on Electromagnetic and Wave Theory, ISBN-13: 978-0-7803-6031-0 Computational Electromagnetics with MATLAB, Matthew N.O. Sadiku, 2019, Taylor & Francis Group, ISBN: 13: 978-1-138-55815-1

Continuous Internal Evaluation (CIE); Theory (100 Marks)

CIE is executed by way of quizzes (Q), tests (T) and experiential learning (EL). A minimum of three quizzes are conducted and each quiz is evaluated for 10 marks adding up to 30 marks. All quizzes are conducted online. Faculty may adopt innovative methods for conducting quizzes effectively. The number of quizzes may be more than three also. The three tests are conducted for 50 marks each and the sum of the marks scored from three tests is reduced to 50. The marks component for experiential learning is 20. Total CIE is 30(Q) + 50(T) + 20(EL) = 100 Marks.

Scheme of Continuous Internal Evaluation (CIE); Practical Test for 50 Marks

Electronics and Communication Engineering

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The Laboratory session is held every week as per the time table and the performance of the student is evaluated in every session. The average marks (AM) over number of weeks is considered for 30 marks. At the end of the semester a test (T) is conducted for 10 marks. The students are encouraged to implement additional innovative experiments (IE) in the lab and are rewarded for 10 marks. Total marks for the laboratory is 50.

Total CIE is 30(AM) +10 (T) +10 (IE) =50 Marks.

Semester End Evaluation (SEE); Theory (100 Marks)

SEE for 100 marksis executed by means of an examination. The Question paper for the course contains two parts, Part A and Part B. Part A consists of objective type questions for 20 marks covering the complete syllabus. Part B consists of five main questions, one from each unit for 16 marks adding up to 80 marks. Each main question may have sub questions. The question from Units I, IV and V have no internal choice. Units II and III have internal choice in which both questions cover entire unit having same complexity in terms of COs and Bloom's taxonomy level.

Scheme of Semester End Examination (SEE); Practical Exam for 50 Marks

SEE for the practical courses will be based on experiment conduction with proper results, is evaluated for 40 marks and Viva is for 10 marks. Total SEE for laboratory is 50 marks.

Semester End Evaluation (SEE): Theory (100 Marks) + Practical (50 Marks) = Total 150 Marks

	CO-PO Mapping											
CO/PO	PO1	PO2	PO3	PO4	PO5	PO6	PO7	PO8	PO9	PO10	PO11	PO12
CO1	3	2	-	-	-	-	2	-	-	2	-	1
CO2	3	2	2	1	-	-	2	-	-	2	-	1
CO3	3	3	2	2	-	-	2	-	-	2	-	1
CO4	3	3	3	3	-	-	2	-	-	2	-	1

Low-1 Medium-2 High-3

				Semester: VII			
			BRO	ADBAND WIRELESS -LTE 4G			
				(Theory)			
Cour	rse Code	:	18EC73	CIE	:	100	Marks
Cred	lits: L:T:P	:	3:1:0	SEE	:	100	Marks
Tota	l Hours	:	39 L+26T	SEE I	Duration :	3.00	Hours
Cour				tudents will be able to			
1	Understand t	the b	asics of LTE	standardization phases, specifications	s and its arch	itectur	e
2				d on the use of OFDMA and SC-FD			
3				interface protocols to set up, reconfig	gure and rele	ase the	2
				the EPS bearer.			
4			of Radio Res	ource Management (RRM) to ensur	e that the ra	dio res	sources are
	efficiently us	sea.					
				UNIT-I			08 Hrs
	ew of Legacy						
				OFDM, Single carrier FDMA, S			
-				heduling, Multi antenna Techniqu	ies, IP base	ed Fla	t network
	itecture, LTE						
				concept, Broadband wireless chann			
						and hear	
Mode	eling BWC – I	стр	irical and Stat	istical models, Mitigation of Narrow	band and Bi	oauba	
	ticarrier Mod			UNIT-II	band and Bi	oadua	08 Hrs
Mult OFD SC-F LTE. Over	ticarrier Mod DM basics, OF F DMA: OFDN rview and C	ulat DM M with	ion in LTE, PAR ith FDMA, TI nel Structur	UNIT-II A, SC-FDE. (Non-Mathematical tre DMA, CDMA, OFDMA, SC-FDMA e of LTE: Introduction to LTE,	eatment only A, OFDMA a	y). OF nd SC	08 Hrs DMA and -FDMA in
Mult OFD SC-F LTE. Over	ticarrier Mod DM basics, OF F DMA: OFDN rview and C	ulat DM M with	ion in LTE, PAR ith FDMA, TI nel Structur	UNIT-II A, SC-FDE. (Non-Mathematical tre DMA, CDMA, OFDMA, SC-FDMA e of LTE: Introduction to LTE, Uplink SC-FDMA Radio Resource.	eatment only A, OFDMA a	y). OF nd SC	08 Hrs DMA and -FDMA in e of LTE,
Mult OFD SC-F LTE. Over Down	ticarrier Mod M basics, OF F DMA: OFDM rview and C mlink OFDMA	ulat DM M w han	ion in LTE, PAR ith FDMA, TI nel Structur dio Resource,	UNIT-II C, SC-FDE. (Non-Mathematical tre DMA, CDMA, OFDMA, SC-FDMA e of LTE: Introduction to LTE, Uplink SC-FDMA Radio Resource. UNIT-III	eatment only A, OFDMA a	y). OF nd SC	08 Hrs DMA and -FDMA in
Mult OFD SC-F LTE. Over Down	ticarrier Mod M basics, OF FDMA: OFDM rview and C nlink OFDMA nlink Transpo	ulat DM M w: han A Ra	ion in LTE, PAR ith FDMA, TI nel Structur dio Resource, Channel Proc	UNIT-II A, SC-FDE. (Non-Mathematical tre DMA, CDMA, OFDMA, SC-FDMA e of LTE: Introduction to LTE, Uplink SC-FDMA Radio Resource. UNIT-III pressing	eatment only A, OFDMA a Channel St	y). OF nd SC ructure	08 Hrs DMA and -FDMA in e of LTE, 08 Hrs
Mult OFD SC-F LTE. Over Down	ticarrier Mod DM basics, OF FDMA: OFDM rview and C nlink OFDMA mlink Transportee view, Downli	ulat DM M with han A Ra ort (ion in LTE, PAR ith FDMA, TI nel Structur dio Resource, Channel Proc shared channe	UNIT-II C, SC-FDE. (Non-Mathematical tre DMA, CDMA, OFDMA, SC-FDMA e of LTE: Introduction to LTE, Uplink SC-FDMA Radio Resource. UNIT-III	eatment only A, OFDMA a Channel St	y). OF nd SC ructure	08 Hrs DMA and -FDMA in e of LTE, 08 Hrs
Mult OFD SC-F LTE. Over Down Over chann	ticarrier Mod M basics, OF FDMA: OFDM rview and C nlink OFDMA mlink Transported view, Downlin nels, Downlin	ulat DM M with han A Rat ort (ink s k ph	ion in LTE, PAR ith FDMA, TI nel Structur dio Resource, Channel Proc shared channel ysical channel	UNIT-II A, SC-FDE. (Non-Mathematical tre DMA, CDMA, OFDMA, SC-FDMA e of LTE: Introduction to LTE, Uplink SC-FDMA Radio Resource. UNIT-III ressing els, Downlink Control Channels, B	eatment only A, OFDMA a Channel St Broadcast cha	7). OF nd SC ructure annels,	08 Hrs DMA and -FDMA in e of LTE, 08 Hrs Multicast
Mult OFD SC-F LTE. Over Down Over chann Uplin	ticarrier Mod M basics, OF FDMA: OFDM rview and C nlink OFDMA nlink Transp view, Downlin nels, Downlin nk Channel	ulat DM M with han A Rai ort (ink s k ph Tra	ion in LTE, PAR ith FDMA, TI nel Structur dio Resource, Channel Proc shared channel ysical channel ansport Proc	UNIT-II A, SC-FDE. (Non-Mathematical tree DMA, CDMA, OFDMA, SC-FDMA e of LTE: Introduction to LTE, Uplink SC-FDMA Radio Resource. UNIT-III ressing els, Downlink Control Channels, B ls, H-ARQ on Downlink	eatment only A, OFDMA a Channel St Broadcast cha d channels,	7). OF nd SC ructure annels,	08 Hrs DMA and -FDMA in e of LTE, 08 Hrs Multicast
Mult OFD SC-F LTE. Over Down Over chann Uplin	ticarrier Mod M basics, OF FDMA: OFDM rview and C nlink OFDMA nlink Transp view, Downlin nels, Downlin nk Channel	ulat DM M with han A Rai ort (ink s k ph Tra	ion in LTE, PAR ith FDMA, TI nel Structur dio Resource, Channel Proc shared channel ysical channel ansport Proc	UNIT-II A, SC-FDE. (Non-Mathematical tre DMA, CDMA, OFDMA, SC-FDMA e of LTE: Introduction to LTE, Uplink SC-FDMA Radio Resource. UNIT-III ressing els, Downlink Control Channels, B ls, H-ARQ on Downlink cessing: Overview, Uplink shared	eatment only A, OFDMA a Channel St Broadcast cha d channels,	7). OF nd SC ructure annels,	08 Hrs DMA and -FDMA in e of LTE, 08 Hrs Multicast
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Mult OFD SC-F LTE. Over Down Over chann Uplin Infor Hybr Oper Alloc Radi PDC	ticarrier Mod M basics, OF FDMA: OFDM rview and C mlink OFDMA mlink Transpo view, Downlin nels, Downlin nk Channel mation, Uplin sical Layer Pr rid – ARQ pro rations, Uplink cation, Cell Se	ulat DM M w han M Ra ort (ink s k ph Tra k Re cocedu c ch earch	ion in LTE, PAR ith FDMA, TI nel Structur dio Resource, Channel Proc shared channel ansport Proc eference signal dures ures, Channel annel soundir , Random Acc agement and	UNIT-II A, SC-FDE. (Non-Mathematical tree DMA, CDMA, OFDMA, SC-FDMA e of LTE: Introduction to LTE, Uplink SC-FDMA Radio Resource. UNIT-III ressing els, Downlink Control Channels, B ls, H-ARQ on Downlink cessing: Overview, Uplink shared ls, Random Access Channels, H-ARC UNIT-IV Quality Indicator CQI feedback, Pre- ng, Buffer status Reporting in uplin cess Procedures, Power Control in up	eatment only a, OFDMA a Channel St Broadcast cha d channels, Q on uplink ecoder for cla hk, Schedulin plink.	y). OF nd SC ructure annels, Uplin osed lo ng and	08 Hrs DMA and -FDMA in e of LTE, 08 Hrs Multicast k Control 08 Hrs pop MIMO Resource 07Hrs

Course	e Outcomes: After completing the course, the students will be able to
CO1:	Associate terms in the system architecture to the functional standard specified in LTE 4G.
CO2:	Analyze the role of LTE radio interface protocols and EPS Data convergence protocols to set up, reconfigure and release data and voice from users.
CO3:	Demonstrate the UTRAN and EPS handling processes from set up to release including mobility management for a variety of data call scenarios.
CO4:	Test and Evaluate the Performance of resource management and packet data processing and transport algorithms.

Reference Books

1	Fundamentals of LTE, Arunabha Ghosh, Jan Zhang, Jefferey Andrews, Riaz Mohammed, 1 st
1.	Edition, 2018, Prentice Hall, Communications Engg and Emerging Technologies, ISBN:
	9780137033638.
2.	LTE for UMTS Evolution to LTE-Advanced, HarriHolma and Antti Toskala, 2 nd Edition, 2011,
-	John Wiley & Sons Ltd. ISBN: 9780470660003.
3.	Evolved Packet System (EPS) - The LTE And SAE Evolution of 3G UMT, Pierre Lescuyer and
	Thierry Lucidarme, 2008, John Wiley & Sons, Ltd. Print ISBN: 978-0-470-05976-0.
4	LTE-The UMTS Long term Evolution; From Theory to Practice' by Stefania Sesia,
	IssamToufik, and Mathew Baler, 2009, John Wiley and Solns Ltd, ISBN 978-0-470-69716-0.

Continuous Internal Evaluation (CIE); Theory (100 Marks)

CIE is executed by way of quizzes (Q), tests (T) and experiential learning (EL). A minimum of three quizzes are conducted and each quiz is evaluated for 10 marks adding up to 30 marks. All quizzes are conducted online. Faculty may adopt innovative methods for conducting quizzes effectively. The number of quizzes may be more than three also. The three tests are conducted for 50 marks each and the sum of the marks scored from three tests is reduced to 50. The marks component for experiential learning is 20. **Total CIE is 30(Q) + 50(T) + 20(EL) = 100 Marks**.

Semester End Evaluation (SEE); Theory (100 Marks)

SEE for 100 marks is executed by means of an examination. The Question paper for the course contains two parts, Part A and Part B. Part A consists of objective type questions for 20 marks covering the complete syllabus. Part B consists of five main questions, one from each unit for 16 marks adding up to 80 marks. Each main question may have sub questions. The question from Units I, IV and V have no internal choice. Units II and III have internal choice in which both questions cover entire unit having same complexity in terms of COs and Bloom's taxonomy level.

	CO-PO Mapping											
CO/PO	PO1	PO2	PO3	PO4	PO5	PO6	PO7	PO8	PO9	PO10	PO11	PO12
CO1	3	2	-	-	2	3	2	2	1	2	2	2
CO2	3	2	2	1	1	1	2	2	2	2	1	3
CO3	3	3	2	2	1	1	2	1	2	2	1	2
CO4	3	3	3	3	3	1	2	3	3	2	1	2

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semester final	18EC74 : 0:0:2	5	CIE Marks SEE Marks	•	50 50
Credit L:T:P : Hours/week : 1) The duration semester final	: 18EC74 : 0:0:2				
Hours/week : 1) The duration semester final			SEE Marks	:	50
1) The duration semester final	: 4				50
1) The duration semester final			SEE Duration	:	3.00 Hours
semester final		GUIDELINES			
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Scheme of Continuous Internal Evaluation (CIE):

The evaluation committee shall consist of Guide, Professor/Associate Professor and Assistant Professor. The committee shall assess the presentation and the progress reports in two reviews.

Electronics and Communication Engineering

Reviews	Activity	Weightag
Review-I	Explanation of the application of engineering knowledge in	
	industries, ability to comprehend the functioning of the organization/	45%
	departments,	
Review-	Importance of resource management, environment and sustainability	
II	presentation skills and report writing	55%

Scheme for Semester End Evaluation (SEE):

The SEE examination shall be conducted by an external examiner (domain expert) and an internal examiner. Evaluation shall be done in batches, not exceeding 6 students per batch.

Semester: VII							
HIGH PERFORMANCE COMPUTING							
	(Group F: Professional Elective)						
Course Code		:	18EC7F1		CIE		100 Marks
	lits: L:T:P	:	3:0:0		SEE	:	100 Marks
					3.00 Hours		
		-		tudents will be able to			
1				l programming.		_	
2				of multiprocessing and paralle	l operations wit	h c	ase studies.
3				programming.	10 10		
4	To demonstra	ite p	barallel progra	mming using MPI, OpenAcc a	nd OpenMP.		
				Unit-I			08 Hrs
M14	in Hooggong on	гь	broad loval r				00 1115
	tiprocessors an			mory architectures; Performa	nce of symmet	ric	shared_memory
				nemory and directory-based co			
	els of memory			iemory and uncetory-based eo.	nerence, Dasies	01	synemonization,
11104		0011	sistency.	Unit – II			08 Hrs
	a versus Core i?			Unit –III			08 Hrs
Moti Deco	omposition Tec	of hni	Parallel Com ques, Charact	ing puting, Principles of Parallel eristics of Tasks and Interaction teraction Overheads, Parallel A	ons, Mapping T	ech	niques for Load
				Unit –IV	•		08Hrs
Programming Using the Message Passing Paradigm Principles of Message Passing Programming, Building Blocks, MPI, Topologies and Embedding, Overlapping Communication with computation, Collective Communication and computation operations, Groups and Communicators.							
Unit –V 07 Hrs						07 Hrs	
	J Programmin						
				OpenACC: A Simple Data-Par			
Amdahl's Law and Scaling, Parallel Execution and Race Conditions, Lock-Free Programming,							
	trolling Parallel						
Pipelining data transfers with OpenACC Introduction to Pipelining, Mandelbrot Generator, Pipelining Across Multiple Devices.							
Intro	auction to Pipe	11111	ng, Mandelbr	ot Generator, Pipelining Across	s Multiple Devic	ces.	
C			ton one 1.4*	- Ale annua Ale et de t	h.a. a.h.] - 4 -		
				g the course, the students wil			
τυι	: Explore the	Tur	nuamentals of	high-performance computing c	concepts.		

CO1:Explore the fundamentals of high-performance computing concepts.CO2:Analyze the performance of parallel programming.

CO3: Design parallel computing constructs for different applications.

CO4: Demonstrate Parallel computing concepts for suitable applications.

Refer	Reference Books							
1	Introduction to Parallel Computing, Ananth Grama, Anshul Gupta, George Karypis, Vipin Kumar, 2 nd Edition, 2013, Pearson Education, ISBN 13: 9788131708071.							
2	CUDA Programming: A Developers Guide to Parallel Computing with GPUs, Shane Cook, 1 st Edition, 2013, Morgan Kaufmann, ISBN:9780124159334.							
3	Parallel Programming with Open ACC, Rob Farber, 1 st Edition, 2016, Morgan Kaufmann (MK) Publication, ISBN :9780124103979.							
4	ARM System Developers Guide, Andrew N Sloss, Dominic Symes, Chris Wright, Elsevier, Morgan Kaufman publishers, 2008, ISBN-13:9788181476463							

CIE is executed by way of quizzes (Q), tests (T) and Assignment/Presentation/Project (A). A minimum of three quizzes are conducted and each quiz is evaluated for 10 marks adding up to 30 marks. All quizzes are conducted online. Faculty may adopt innovative methods for conducting quizzes effectively. The number of quizzes may be more than three also. The three tests are conducted for 50 marks each and the sum of the marks scored from three tests is reduced to 50. The marks component for experiential learning is 20.

Total CIE is 30(Q) +60(T) +10(A) =100 Marks.

Semester End Evaluation (SEE); Theory (100 Marks)

SEE for 100 marksis executed by means of an examination. The Question paper for the course contains two parts, Part – A and Part – B. Part – A consists of objective type questions for 20 marks covering the complete syllabus. Part – B consists of five main questions, one from each unit for 16 marks adding up to 80 marks. Each main question may have sub questions. The question from Units I, IV and V have no internal choice. Units II and III have internal choice in which both questions cover entire unit having same complexity in terms of COs and Bloom's taxonomy level.

	CO-PO Mapping											
CO/PO	PO1	PO2	PO3	PO4	PO5	PO6	PO7	PO8	PO9	PO10	PO11	PO12
CO1	3	2	-	-	-	-	-	-	-	1	-	1
CO2	3	2	2	1	-	-	-	-	-	1	-	1
CO3	3	3	2	2	2	-	-	-	-	1	-	1
CO4	3	3	3	3	2	-	-	-	-	1	-	1

		I		NAL INTEGRATED		GN		
C		<u> </u>		Froup F: Professiona	í í		100 Marks	
	rse Code	:	18EC7F2			CIE :		
	dits: L:T:P	:	3:0:0		SEE	:	100 Marks	
	al Hours	:	39 L		SEE Durati	on :	3.00 Hours	
	0	v		tudents will be able to)			
1	U 1		nd Hold circu					
2				mplifiers and its non-o				
<u>3</u> 4				DAC for a given spec				
4	Evaluate vari	lous	performance	parameters of ADC/ I	JAC.			
				Unit-I			08 Hrs	
Raci	c Sampling Ci	rou	ite	Unit-1			00 111 5	
				Gate switch, Distor	tion due to swit	ch Snee	d and Precisio	
				lock feedthrough, Th				
		injection cancellation – Dummy switch, complementary switches, differential circuits, Bottom plate						
sampling, Gate bootstrapped switch, Nakagome charge pump.								
	, c <i>ute</i> coo	otstra	pped switch,	<u> </u>	mp.		08 Hrs	
Buil Two Opar	ding Blocks of stage Opamp, mp for stability	f Da des y, ch	ta Conversion ign of buffer st aaracterizing t	Unit – II n Systems – Operatio stage, Operational Tra he Opamp open loop	onal Amplifiers ansconductance An gain, common m	ode range	e, common mod	
Buil Two Opar rejec detec	ding Blocks of stage Opamp, mp for stability ction ratio, po ctor, CMFB c	f Da des y, ch wer	ta Conversion ign of buffer aracterizing t supply rejec	Unit – II n Systems – Operatio stage, Operational Tra	onal Amplifiers insconductance An gain, common m mode feedback	ode range (CMFB)	compensating th e, common mod – resistive CN	
Buil Two Opar rejec detec	ding Blocks of stage Opamp, mp for stability ction ratio, po	f Da des y, ch wer	ta Conversion ign of buffer aracterizing t supply rejec	Unit – II n Systems – Operation stage, Operational Tra the Opamp open loop tion ratio. Common	onal Amplifiers insconductance An gain, common m mode feedback	ode range (CMFB)	compensating th e, common mod – resistive CN	
Buil Two Opar rejec detec Capa	ding Blocks of stage Opamp, mp for stability ction ratio, po ctor, CMFB c acitor amplifier	f Da des y, ch wer comp s.	ta Conversion ign of buffer s aaracterizing t supply rejec bensation. Sw	Unit – II n Systems – Operational Transformation stage, Operational Transformation the Opamp open loop stion ratio. Common vitched Capacitor (So	onal Amplifiers ansconductance An gain, common m mode feedback C) circuits– Paras	ode range (CMFB)	compensating th e, common mod – resistive CM nsitive Switche	
Buil Two Opar rejec detec Capa Buil	ding Blocks of stage Opamp, mp for stability ction ratio, po ctor, CMFB c acitor amplifier ding Blocks of	f Da des y, ch wer omp s. f Da	ta Conversion ign of buffer s aaracterizing t supply reject bensation. Sw ta Conversion	Unit – II n Systems – Operatio stage, Operational Tra the Opamp open loop stion ratio. Common vitched Capacitor (So Unit –III	onal Amplifiers ansconductance An gain, common m mode feedback C) circuits– Paras rators	ode range (CMFB) sitic Inse	compensating th e, common mod – resistive CM nsitive Switche 08 Hrs	
Buil Two Opar rejec detec Capa Buil Basi com	ding Blocks of stage Opamp, mp for stability ction ratio, po ctor, CMFB c acitor amplifier ding Blocks of c comparator parator – comp	f Da des y, ch wer comp s. f Da desi	ta Conversion ign of buffer s naracterizing t supply reject bensation. Sw ta Conversion gn – preamplor dc perform	Unit – II n Systems – Operational Transference stage, Operational Transference the Opamp open loop stion ratio. Common vitched Capacitor (So Unit –III n Systems – Compar lification, decision ci ance, transient respon	onal Amplifiers insconductance An gain, common m mode feedback C) circuits– Paras rators rcuit and output se, clocked compa	ode range (CMFB) sitic Inse buffer. C rators – c	compensating th e, common mod – resistive CM nsitive Switche 08 Hrs haracterizing th ase study.	
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Buil Two Opar rejec Capa Buil Basi comj Data SND Digi chara	ding Blocks of stage Opamp, mp for stability ction ratio, po ctor, CMFB c acitor amplifier ding Blocks of c comparator parator – comp a Converter S DR, DR, SFDR, tal to Analog acteristics, Idea	f Da des y, ch wer omp s. f Da desi arat Spec g C al D	ta Conversion ign of buffer s paracterizing t supply reject bensation. Sw ta Conversion gn – preample or dc perform ifications – St earity.	Unit – II n Systems – Operation stage, Operational Tra- the Opamp open loop tion ratio. Common vitched Capacitor (SO Unit –III n Systems – Compar lification, decision ci ance, transient respon Static specifications Unit –IV rehitectures - Static urve, offset, gain erro rrent steering DAC.	onal Amplifiers ansconductance An gain, common m mode feedback C) circuits– Paras recuits and output se, clocked compa - INL, DNL and c performance of	ode range (CMFB) sitic Inse buffer. C rators – c Dynamic	compensating th e, common mod – resistive CM nsitive Switche 08 Hrs haracterizing th ase study. specifications 07 Hrs – DAC transfe out code, Resisto	
Buil Two Opar rejec Capa Buil Basi comj Data SND Digi chara Strin	ding Blocks of stage Opamp, mp for stability ction ratio, po ctor, CMFB c acitor amplifier ding Blocks of c comparator parator – comp a Converter S DR, DR, SFDR, tal to Analog acteristics, Idea	f Da des y, ch wer omp s. f Da desi arat desi arat bpec g C al D ladd	ta Conversion ign of buffer staracterizing t supply reject bensation. Sw ta Conversion gn – preamplor dc perform ifications – Starity. Converter An AC transfer cu ler DACs, Cun	Unit – II n Systems – Operation stage, Operational Tra- the Opamp open loop operation ratio. Common vitched Capacitor (SO Unit –III n Systems – Compar lification, decision ci- ance, transient respon Static specifications Unit –IV rehitectures - Static urve, offset, gain error rrent steering DAC. Unit –V	onal Amplifiers ansconductance Angain, common m mode feedback C) circuits– Paras rators rcuit and output se, clocked compa - INL, DNL and c performance of r, monotonicity. E	ode range (CMFB) sitic Inse buffer. C rators – c Dynamic f DAC Digital Inp	compensating th e, common mod – resistive CM nsitive Switche 08 Hrs haracterizing th ase study. e specifications 07 Hrs – DAC transfe but code, Resisto 08 Hrs	
Buil Two Opar rejec detec Capa Buil Basi comp Data SND Digi chara Strin Ana	ding Blocks of stage Opamp, mp for stability ction ratio, po ctor, CMFB c acitor amplifier ding Blocks of c comparator parator – comp a Converter S DR, DR, SFDR, tal to Analog acteristics, Idea ng DAC, R-2R	f Da des y, ch wer omp s. f Da desi arate Spec , line g C al D ladd	ta Conversio ign of buffer s aracterizing t supply rejec- bensation. Sw ta Conversio gn – preampl or dc perform ifications – S earity. Converter An AC transfer co er DACs, Cun	Unit – II n Systems – Operation stage, Operational Tra- the Opamp open loop tion ratio. Common vitched Capacitor (SO Unit –III n Systems – Compar lification, decision ci ance, transient respon Static specifications Unit –IV rehitectures - Static urve, offset, gain erro rrent steering DAC.	onal Amplifiers ansconductance Angain, common m mode feedback C) circuits– Paras rators rcuit and output se, clocked compa - INL, DNL and c performance of r, monotonicity. E	ode range (CMFB) sitic Inse buffer. C rators – c Dynamic f DAC Digital Inp	compensating th e, common mod – resistive CM nsitive Switche 08 Hrs haracterizing th ase study. e specifications 07 Hrs – DAC transfe but code, Resisto 08 Hrs	
Buil Two Opar rejec detec Capa Buil Basi comj Data SND Data SND Digi chara Strin Ana	ding Blocks of stage Opamp, mp for stability ction ratio, po ctor, CMFB c acitor amplifier ding Blocks of c comparator parator – comp a Converter S DR, DR, SFDR, tal to Analog acteristics, Idea ng DAC, R-2R log to Digital Cs (Introduction	f Da des y, ch wer omp s. f Da desi arate Spec , line g C al D ladd	ta Conversio ign of buffer aracterizing t supply rejec- bensation. Sw ta Conversion gn – preampl or dc perform ifications – Se earity. Converter An AC transfer c ler DACs, Cun overter Archi ly)	Unit – II n Systems – Operational Tra- stage, Operational Tra- the Opamp open loop tion ratio. Common vitched Capacitor (SO Unit –III n Systems – Compar lification, decision ci- ance, transient respon Static specifications – Unit –IV rehitectures - Station urve, offset, gain error rrent steering DAC. Unit –V itectures - Flash ADO	ansconductance Angain, common m mode feedback C) circuits– Paras reuit and output se, clocked compa - INL, DNL and c performance of r, monotonicity. D C, SAR ADC, Pip	ode range (CMFB) sitic Inse buffer. C rators – c Dynamic f DAC - Digital Inp	compensating th c, common mod – resistive CM nsitive Switche 08 Hrs haracterizing th ase study. specifications 07 Hrs – DAC transfe out code, Resisto 08 Hrs DC, Delta Sigm	
Buil Two Opar rejecc Capa Buil Basi com Data SND Digi chara Strin Ana ADC CM	ding Blocks of stage Opamp, mp for stability ction ratio, po ctor, CMFB c acitor amplifier ding Blocks of c comparator parator – comp a Converter S DR, DR, SFDR, tal to Analog acteristics, Idea ng DAC, R-2R log to Digital Cs (Introduction OS Color and	f Da des y, ch wer omp s. f Da desi arate Spec g C al D ladd Cor n on l Im	ta Conversion ign of buffer staracterizing t supply reject bensation. Sw ta Conversion gn – preample or dc perform ifications – Starity. Converter An AC transfer c fer DACs, Cun werter Archi- ly) age Sensor	Unit – II n Systems – Operation stage, Operational Tra- the Opamp open loop operation ratio. Common vitched Capacitor (SO Unit –III n Systems – Compar lification, decision ci- ance, transient respon Static specifications Unit –IV rehitectures - Static urve, offset, gain error rrent steering DAC. Unit –V	ansconductance Angain, common m mode feedback C) circuits– Paras reuit and output se, clocked compa - INL, DNL and c performance of r, monotonicity. D C, SAR ADC, Pip	ode range (CMFB) sitic Inse buffer. C rators – c Dynamic f DAC - Digital Inp	compensating th c, common mod – resistive CM nsitive Switche 08 Hrs haracterizing th ase study. specifications 07 Hrs – DAC transfe out code, Resisto 08 Hrs DC, Delta Sigm	

Course	Course Outcomes: After completing the course, the students will be able to							
CO1:	Design various Sample and Hold circuits.							
CO2:	Analyze Switched Capacitor Amplifiers and its non idealities.							
CO3:	Design various types of ADC/DAC for a given specification							
CO4:	Evaluate the different performance parameters of ADC/ DAC							
-								

Refer	Reference Books							
1	CMOS Circuit Design, Layout and Simulation, R. Jacob Baker,4 th edition, 2019, IEEE Press							
1	Wiley Series on Microelectronic Systems, ISBN: 978-1-119-48151-5							
n	Design of Analog CMOS Integrated Circuits, Behzad Razavi,2 nd Edition, 2016, Mc Graw Hill,							
2	ISBN 9780072380323							
3	Data Converters, Franco Maloberti, 1 st Edition,2007, Springer, ISBN 978-0-387-32486-9							
4	CMOS Analog and Mixed-Signal Circuit Design- Practices and Innovations, Arjuna							
4	Marzuki,1st Edition, 2020, CRC Press, ISBN 978-0367430108							

CIE is executed by way of quizzes (Q), tests (T) and Assignment/Presentation/Project (A). A minimum of three quizzes are conducted and each quiz is evaluated for 10 marks adding up to 30 marks. All quizzes are conducted online. Faculty may adopt innovative methods for conducting quizzes effectively. The number of quizzes may be more than three also. The three tests are conducted for 50 marks each and the sum of the marks scored from three tests is reduced to 50. The marks component for experiential learning is 20.

Total CIE is 30(Q) +50(T) +20(EL) =100 Marks.

Semester End Evaluation (SEE); Theory (100 Marks)

SEE for 100 marksis executed by means of an examination. The Question paper for the course contains two parts, Part – A and Part – B. Part – A consists of objective type questions for 20 marks covering the complete syllabus. Part – B consists of five main questions, one from each unit for 16 marks adding up to 80 marks. Each main question may have sub questions. The question from Units I, IV and V have no internal choice. Units II and III have internal choice in which both questions cover entire unit having same complexity in terms of COs and Bloom's taxonomy level.

CO-PO Mapping												
CO/PO	PO1	PO2	PO3	PO4	PO5	PO6	PO7	PO8	PO9	PO10	PO11	PO12
CO1	3	2	3	3	3	-	-	-	-	2	1	2
CO2	3	2	-	2	3	1	-	-	-	2	1	2
CO3	3	3	2	2	3	2	-	3	2	2	1	2
CO4	3	3	2	-	3	-	-	-	-	2	1	2

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				Semester: VII			
			DESIGN I	FOR TESTING AND TEST	ABILITY		
				roup F: Professional Electiv			
Cou	rse Code	:	18EC7F3		CIE	:	100 Marks
Cred	dits: L:T:P	:	3:0:0		SEE	:	100 Marks
Tota	l Hours	:	39 L		SEE Duration	:	3.00 Hours
Cou				udents will be able to			
1				ors and faults. Understand di			associated with
-				ng by employing fault model			.1
2				of simulation and digital test		l us	e the
3				ing fault coverage specificati sequential circuit test generat			
4				ificance of testable design, of		e it	n Built In Self
7	-		h as MBIST an			-5 II	i Duiit in Sch
		Juei					
				Unit-I			08 Hrs
Intro	oduction to To	estir	ıg				•
		ting	g, Role of testi	ng VLSI circuits, VLSI tren	ds affecting testin	g, F	Faults in digita
circu							
	It Modeling	~	1	-			
				g, Types of Fault Models, St	uck-at Faults, Bri	dgir	ng Faults, cros
point	t faults, Fault I	qui	valence, Fault				00.11
Faul	lt Simulation			Unit – II			08 Hrs
		aori	ithm_ Serial P	arallel, Deductive and Concu	rrent Fault Simulat	ion	
				lity, Observability, SCOAF			
				Testability Analysis	incusures for c	0111	oniutionut un
				Unit –III			07 Hrs
ATP	G for Combin	nati	onal Circuits				I
Path	Sensitization	Me	thods, Roth's	D- Algorithm, Boolean Di	fference, Comple	xity	of Sequentia
	G, Time Fram						_
				ructured DFT- Scan method	, Scan Design Ru	les,	, Overheads o
Scan	Design, partia	l sc	an methods, m	ultiple chain scan methods.			
				Unit –IV			08 Hrs
	test And Test						1 1' 0
			1 0	ration for BIST, response c	ompaction - Parity	y c	checking, One
				analyser (SISR and MISR).			
Circular BIST, Logic BIST Architectures.							
14	T (•			Unit –V			08 Hrs
	nory Testing	` :	m Test Alasm	thema Dadward Eventional E	wite MADCII and	м	AT ala a with me
	generation for			thms, Reduced Functional Fa	auns-march and	11/17	A I + algorithm
rest	generation for	ъщ	IDEUUCU KAMS	. 1010131.			
Сош	rse Outcomes	Δ.f	ter completin	the course the students w	ill he able to		
Course Outcomes: After completing the course, the students will be able toCO1:Attain knowledge about testing, fault modeling & collapsing. The difference between defects							
COI	and faults	** 10		ng, num modering & collaps	mg. The unreference		
CO2		ario	us fault sim	lation methods. Design n	nethods/techniques	t t c	improve the
testability of digital circuits.							

CO3: Evaluate the significance of ATPG, how patterns are generated for combinational, sequential, and scanned circuits

CO4:	Get complete knowledge about different methods of LBIST and MBIST associated
	with testing. Design Logic BIST circuits based on LFSRs.

Refere	ence Books
1	Essentials of Electronic Testing for Digital, Memoryand Mixed-Signal VLSI Circuits, M. L. Bushnell and V. D. Agrawal, Kluwer Academic Publishers, 2000, ISBN:0-7923-7991-8.
2	VLSI Test Principles and Architectures, L. T. Wang, C. W. Wu, and X. Wen, Morgan Kaufmann, 2006, ISBN-13: 978-0-12-370597-6
3	Digital Circuit Testing and Testability, Parag.K.Lala, Academic Press.
4	Digital Systems Testing and Testable Design, M. Abramovici, M. A. Breuer, and A. D. Friedman, Computer Science Press, 1990, ISBN: 0-7167-8179-4.

CIE is executed by way of quizzes (Q), tests (T) and Assignment/Presentation/Project (A). A minimum of three quizzes are conducted and each quiz is evaluated for 10 marks adding up to 30 marks. All quizzes are conducted online. Faculty may adopt innovative methods for conducting quizzes effectively. The number of quizzes may be more than three also. The three tests are conducted for 50 marks each and the sum of the marks scored from three tests is reduced to 50. The marks component for experiential learning is 20.

Total CIE is 30(Q) +50(T) +20(EL) =100 Marks.

Semester End Evaluation (SEE); Theory (100 Marks)

SEE for 100 marksis executed by means of an examination. The Question paper for the course contains two parts, Part – A and Part – B. Part – A consists of objective type questions for 20 marks covering the complete syllabus. Part – B consists of five main questions, one from each unit for 16 marks adding up to 80 marks. Each main question may have sub questions. The question from Units I, IV and V have no internal choice. Units II and III have internal choice in which both questions cover entire unit having same complexity in terms of COs and Bloom's taxonomy level.

	CO-PO Mapping												
CO/PO	PO1	PO2	PO3	PO4	PO5	PO6	PO7	PO8	PO9	PO10	PO11	PO12	
CO1	2	2	2	-	2	-	-	-	-	1	-	1	
CO2	2	2	2	1	2	-	-	-	-	1	-	1	
CO3	2	3	2	2	2	-	-	-	-	1	-	1	
CO4	2	3	2	3	2	-	-	-	-	1	-	1	

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				Semester: VII					
				NANOELECTRONICS	S				
				roup F: Professional Ele	ctive)		•		
	rse Code	:	18EC7F4		CIE	:	100 Marks		
Crec	dits: L:T:P	:	3:0:0		SEE	:	100 Marks		
Tota	al Hours	:	39L		SEE Duration	:	03 Hours		
Cou				udents will be able to					
1				ing of contemporary relev					
2				factors like scaling and	dimension lead to	nov	vel behavior of		
	nanoelectronics components. Develop understanding of the importance of quantum ideas and their place in modeling of								
3					ideas and their pla	ice i	in modeling o		
	nanoelectronic				1		. 1.1.		
4				electronics phenomena,	nanoelectronics con	npor	ients and their		
	possible appli	cau	ons.						
				Unit-I			08 Hrs		
Revi	iew of Electron	15 (Duantum me	chanics: Electrons wave	particle duality. Wa	ive			
				er's Equation, The Tim					
				Well, Harmonic Oscillato					
	2: Chapter 1,2)		1	,	8				
<u>`</u>	• • • •			Unit – II			08 Hrs		
Bour Conf	nded Region of	f Sj	pace, and Qu	electrons, Periodic bound antum Numbers, Fermi I Vells, Quantum Dots, Wir	level and Chemical	pot	ential, Partiall		
				Unit –III			07 Hrs		
				tential: Electrons in peri					
				ry of Solids: Interacting s					
band	l transition, grap	her	e and carbon	nanotube, Simulation exar	nples. (Ref 1: Chapt	er 5)			
				Unit –IV			08 Hrs		
				of tunneling: Tunneling					
				ces, Applications of Tu					
				in MOSFETs, Scanning		ope,	Double Barrie		
Tunr	heling and the R	eso	nant Tunnelin	g Diode, Simulation exam	iples.		00 XX		
C		_	J (h ,	Unit –V	11 4' 10' 41		08 Hrs		
			0	lectron transistor: Tunne		•			
				Dot Circuit, The Singl					
				ET Structures, Carbon N					
	iconductor man	JW1	TE FE IS and S	ETs, Molecular SETs and	i wolecular Electron	ics.	(Ref 1: Chapte		
7)									
C		A C		g the course, the students					
	red I mitcomos	Att	er completin	y the course, the students	s will be able to				

Course	e Outcomes: After completing the course, the students will be able to								
CO1:	Define novel behavior of nanoelectronics devices and quantum behavior of matter at the nano								
	scale & modelling of nanoelectronics devices.								
CO2:	Comprehend principles of devices such as tunnelling diodes, single electron transistor,								
	spintronic devices.								
CO3:	Analysis fundamental concepts and methods of Analysis quantum tunnelling, resonant tunnelling, Coulomb blockade, density of quantum states, quantum statistics and quantum modelling.								
CO4:	Evaluate nano scale effects in futuristic electron devices & quantum level computing								

Electronics and Communication Engineering

Refere	ence Books
1	Fundamentals of Nanoelectronics, George W. Hanson, Pearson, 1 st edition, (2009), ISBN: 978-8131726792
2	Introduction to Quantum Mechanics, David J. Griffiths, Darrell F. Schroeter, 3 rd Edition, 2018, Cambridge: Cambridge University, ISBN: 9781107189638
3	Introduction to Nanotechnology, Charles P. Poole, Jr., Frank J. Owens, Wiley (15 January 2007), ISBN:978-8126510993
4	Nanoelectronics and Information Technology, Rainer Waser, Wiley VCH; 3 rd Revised edition (2012), ISBN: 978-3527409273

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Total CIE is 30(Q) +50(T) +20(EL) =100 Marks.

Semester End Evaluation (SEE); Theory (100 Marks)

SEE for 100 marksis executed by means of an examination. The Question paper for the course contains two parts, Part – A and Part – B. Part – A consists of objective type questions for 20 marks covering the complete syllabus. Part – B consists of five main questions, one from each unit for 16 marks adding up to 80 marks. Each main question may have sub questions. The question from Units I, IV and V have no internal choice. Units II and III have internal choice in which both questions cover entire unit having same complexity in terms of COs and Bloom's taxonomy level.

	CO-PO Mapping													
CO/PO	PO1	PO2	PO3	PO4	PO5	PO6	PO7	PO8	PO9	PO10	PO11	PO12		
CO1	3	2	-	-	-	1	2	-	-	-	-	2		
CO2	3	2	1	-	-	1	2	-	-	-	-	2		
CO3	3	3	2	-	2	1	2	-	-	-	-	2		
CO4	3	3	3	2	2	1	2	-	-	-	-	2		

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				Semester: VII			
				SPEECH PROCESSIN	G		
			(G	roup F: Professional Ele	ective)		
Cou	rse Code	:	18EC7F5	•	CIÉ	:	100 Marks
Cred	lits: L:T:P	:	3:0:0		SEE	:	100 Marks
Tota	l Hours	:	39L		SEE Duration	:	3.00 Hours
Cou				udents will be able to			
1	biomedical si	igna	l processing.	tical, scientific, and com	•		
2	biological sig	gnals	5.	/ in formulating proble			-
3	cultivate an u	ınde	rstanding of tl		-	cal p	henomena and
4	Foster effecti	ve i	nteraction skil	ls and teamwork commu	nication.		
				T T •/ T			00 YY
Treter	oduction to Di	~: +-	I Charle Ct-	Unit-I			08 Hrs
artic		ator	y and acoustic	speech production and so phonetics, Uniform tube			cessing, Human
	e Domain Mod			Unit – II			08 Hrs
appro		e au	tocorrelation	ro crossing, pitch peric function, Short time aver on function.			
				Unit –III			08 Hrs
Intro Samj	et Time Fourie duction, Defini pling rates of X trographic disp	itior K(e ^{jw}	ns and propert () in time and	es, Fourier transform inte frequency, Filter bank su	erpretation, linear fil mmation method of	lterin	- :
•		lays	5.			snort	time synthesis,
•			5.	Unit –IV		snort	time synthesis,
Extra Segn	nental and sup	n ame ra s	ntal frequency egmental feat	Unit –IV 7, Frequency domain fun ures of speech signal, Ce pefficients, MFCC feature	damental frequency epstral transform co	deteo	time synthesis, 08 Hrs ction algorithm,
Extra Segn	action of Funda nental and sup	n ame ra s	ntal frequency egmental feat	y, Frequency domain fun ares of speech signal, Ce	damental frequency epstral transform co	deteo	time synthesis, 08 Hrs ction algorithm,
Extra Segn extra Spee Text	action of Funda nental and sup- action, Mel-frec ech based App to speech syr	n ame ra s juen lica nthe	ntal frequency egmental feat cy Cepstral co tions sis, Automati	y, Frequency domain fun ures of speech signal, Ce pefficients, MFCC feature	damental frequency epstral transform co es vector. atistical modelling	detec	time synthesis, 08 Hrs tion algorithm, ents parameters 07 Hrs
Extra Segn extra Spee Text recog	action of Funda nental and sup- action, Mel-free ech based Appl to speech syr gnition, and Sp	n ame ra s juen lica nthe eech	ntal frequency egmental feat cy Cepstral co tions sis, Automati n based techno	r, Frequency domain fun- ures of speech signal, Ce pefficients, MFCC feature Unit –V c speech recognition, St logy development for e la	damental frequency epstral transform co es vector. atistical modelling earning.	detec	time synthesis, 08 Hrs tion algorithm, ents parameters 07 Hrs
Extra Segn extra Spee Text recog	action of Funda nental and sup- lection, Mel-free cch based App to speech syr gnition, and Sp rse Outcomes:	n ame ra s juen lican the eech	ntal frequency egmental feat cy Cepstral co tions sis, Automati n based techno ter completin	r, Frequency domain fun- ures of speech signal, Ce pefficients, MFCC feature Unit –V c speech recognition, St	damental frequency epstral transform co es vector. atistical modelling earning. ts will be able to	detec	time synthesis, 08 Hrs tion algorithm, ents parameters 07 Hrs

CO3: Formulate and solve basic problems in biomedical signal analysis.

CO4: Design of Signal processing algorithm to be used in DSP Processor

Refere	nce Books
1	Digital Processing of Speech Signals, L R Rabiner and R W Schafer, 1st Edition, 2004,
1	Pearson Education, ISBN: 0-13-213603-1
2	Digital Speech Processing, Synthesis and Recognition, SadoakiFurui, 2 nd Edition, 2002
2	MercelDekk er, ISBN-13: 978-0824704520
	Fundamentals of Speech Recognition, Rabiner and B.Juang, 2004, Pearson Education, ISBN-
3	13: 978-0130151575
4	Discrete-Time Speech Signal Processing: Principles and Practice, Thomas F. Quatieri,
4	1 st edition, (10 November 2008), Prentice Hall, ISBN:0-13-242942-X
5	Theory and Applications of Digital Speech Processing, L. R. Rabiner and R. W. Schafer, 1st
5	edition, (3 March 2010), Pearson, ISBN: 978-0136034285

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Total CIE is 30(Q) +50(T) +20(EL) =100 Marks.

Semester End Evaluation (SEE); Theory (100 Marks)

SEE for 100 marksis executed by means of an examination. The Question paper for the course contains two parts, Part – A and Part – B. Part – A consists of objective type questions for 20 marks covering the complete syllabus. Part – B consists of five main questions, one from each unit for 16 marks adding up to 80 marks. Each main question may have sub questions. The question from Units I, IV and V have no internal choice. Units II and III have internal choice in which both questions cover entire unit having same complexity in terms of COs and Bloom's taxonomy level.

	CO-PO Mapping													
CO/PO	PO1	PO2	PO3	PO4	PO5	PO6	PO7	PO8	PO9	PO10	PO11	PO12		
CO1	3	2	1	2	2					2	-	2		
CO2	2	2	2	1	2	1				2	-	3		
CO3	3	2	3	2	1	2					-	3		
CO4	3	2	3	3	2	1				2	-	2		

1				Semester: VII		
			RAD	AR SYSTEMS ENGINEERING		
			· · · · · · · · · · · · · · · · · · ·	roup F: Professional Elective)		
Cou	rse Code	:	18EC7F6	CIE	:	100 Marks
Cred	lits: L:T:P	:	3:0:0	SEE	:	100 Marks
	l Hours	:	36L	SEE Duration	:	03 Hours
Cou				udents will be able to		
1				undamentals of radar and parameters of generation		
2	radars and th	e FN	M-CW Altimet			
3	range gated l	Dop	pler filters and	I radar and delay line cancellers. Understand compare MTI radar with Pulse Doppler radar.		•
4				yze the detection of radar signals in noise a Beam steering	nd	demonstrate the
	c of Radar			Unit-I		07Hrs
and Deteo Signa	Operation, Ra ctable Single, al to Noise Ra	adar Reo tio,	Frequencies ceiver Noise, I Integration of	as Range, Simple form of RadarEquation, Ra and Applications.Predication of range perfor ModifiedRange Equation, Illustrative Problem Radar Pulses, Radar Cross Section ofTargets, the Ambiguities, SystemLosses, Illustrative Pro-	orm ns. Tra	ance, Minimum Radar Equation: ansmitter Power,
	•			Unit – II		08Hrs
Rece Rada	iver, Receiver r, Range and	Bar Dop	ndwidth Requi	Diagram, Isolationbetween Transmitter and Re rements, Applications of CW radar, Illustrative nent, Block Diagram and Characteristics (App Frequency CW Radar.	e Pı	oblems.FM-CW
0	//			Unit –III		07Hrs
Intro Trans Stagg	smitter, Delay gered PRFs.	ciple Lir Rai	e, MTI Rada ne Cancellers -	r with - Power AmplifierTransmitter and – Filter Characteristics,Blind Speeds, Double oppler Filters, MTIRadar Parameters, Li der radar.	e C	ancellation, And
 				Unit –IV		07Hrs
Tracl Com	parison Mono	pul	se (one- and	obing, Conical Scan, Monopulse Tracking two coordinates), Phase Comparison Monc terns, Comparison of Trackers.		
Kang		-		Unit –V		07Hrs
Rang						
Dete Intro and types	duction, Mate Cross correlat s. Duplexers –	hed ion -Brai	ReceiverRadar	r – ResponseCharacteristics and Derivation, C Receivers – Noise Figure and Noise Temp Balanced type, Circulators as Duplexers. Intr diation Pattern, Beam Steering and Beam Wid	oera odu	elation Function ture. Displays – action to Phased
Dete Intro and types Array	duction, Mate Cross correlat s. Duplexers – yAntennas – B	hed ion Bra asic	Filter Receiver ReceiverRadar nch type and l Concepts. Rad	r – ResponseCharacteristics and Derivation, C Receivers – Noise Figure and Noise Temp Balanced type, Circulators as Duplexers. Intr diation Pattern, Beam Steering and Beam Wid	oera odu	elation Function ture. Displays – action to Phased
Dete Intro and types Array	duction, Mate Cross correlat s. Duplexers – yAntennas – B rse Outcomes	hed ion Bras asic : Af	Filter Receiver ReceiverRadar nch type and le Concepts. Rad ter completing out radar funda	r – ResponseCharacteristics and Derivation, C Receivers – Noise Figure and Noise Temp Balanced type, Circulators as Duplexers. Intr	oera odu th c	relation Function ture. Displays – action to Phased changes.

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CO3:	Demonstrate the Doppler Effect and the concepts of continuous wave radars and the FM-CW
	Altimeter
CO4:	Analyze the detection of radar signals in noise and demonstrate the noise figure and radar receiver, Beam steering

Refere	ence Books
1	Introduction to radar systems, Skolnik, 2 nd Edition, 2007, McGraw Hill, ISBN 9780070634411
2	Radar Principles, Technology, Byron Edde, 1 st Edition, 2012, Pearson Education Limited, ISBN:139788131713839
3	Introduction to Radar Systems-Merill I Skolnik, 3 rd Edition,2001, MCGraw-Hill ISBN 13: 9780072909807
4	Radar Principles, Peyton Z Peebles, 1st Edition, 2007, Wiley India, ISBN 13: 9788126515271

Continuous Internal Evaluation (CIE); Theory (100 Marks)

CIE is executed by way of quizzes (Q), tests (T) and Assignment/Presentation/Project (A). A minimum of three quizzes are conducted and each quiz is evaluated for 10 marks adding up to 30 marks. All quizzes are conducted online. Faculty may adopt innovative methods for conducting quizzes effectively. The number of quizzes may be more than three also. The three tests are conducted for 50 marks each and the sum of the marks scored from three tests is reduced to 50. The marks component for experiential learning is 20.

Total CIE is 30(Q) +60(T) +10(A) =100 Marks.

Semester End Evaluation (SEE); Theory (100 Marks)

SEE for 100 marksis executed by means of an examination. The Question paper for the course contains two parts, Part – A and Part – B. Part – A consists of objective type questions for 20 marks covering the complete syllabus. Part – B consists of five main questions, one from each unit for 16 marks adding up to 80 marks. Each main question may have sub questions. The question from Units I, IV and V have no internal choice. Units II and III have internal choice in which both questions cover entire unit having same complexity in terms of COs and Bloom's taxonomy level.

	CO-PO Mapping												
CO/PO	PO1	PO2	PO3	PO4	PO5	PO6	PO7	PO8	PO9	PO10	PO11	PO12	
CO1	3	1	2	1	-	-	-	-	•	-	-	1	
CO2	3	2	2	1	-	1	-	-	-	-	-	1	
CO3	3	2	2	1	-	1	-	-	-	-	-	1	
CO4	3	1	2	1	-	1	-	-	-	-	-	-	

Low-1 : Medium-2: High-3

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Cour				Semester: VII							
Cour			AU	FOMOTIVE ELECTRON	NICS						
Cour			(Gi	roup G: Professional Elec	tive)						
	se Code		18EC7G1		CIE	:	100 Marks				
Credi	its: L:T:P	••	3:0:0		SEE	:	100 Marks				
Total	l Hours	••	39L		SEE Duration	:	3.00 Hours				
Cour				udents will be able to							
1	-		•	automotive domain fund	amentals, need o	f E	lectronics and				
				utomotive systems.	. 1. 1						
2 3	Apply various types of sensors, actuators and Motion Control techniques in Automotive systems Understand digital engine control systems and Embedded Software's and ECUsused in										
3	automotive systems.										
4	2			ostics, safety and advances	in Automotive elec	tron	ic Systems				
_ •	7 mary 50 the e		epis of Diugh	stres, surery and advances		uron.	le bystems.				
				Unit-I			08 Hrs				
	amentals of A										
				Automotive, Automotive S							
				k Ignition Engines and A		. Ig	nition System,				
				ons, Brakes and Steering S	ystems.						
	s of Electroni		0		· E · · · ·						
				ntrol, Concept of an Electrone performance terms, Eng							
				ce, Control Strategy, Elect							
	e manifold pres					sysic	III, Allalysis of				
munt				Unit – II			08 Hrs				
Auto	motive Sensor	's ai	nd Actuators								
Autor	motive Control	Sy	stem Applicat	ions of Sensors and Actuate	ors,						
				Crankshaft Angular Pos		ttle	Angle Sensor,				
				edback Control, Sensors	for Driver Assistar	ice S	System: Radar,				
	, Video Techno										
		ds,	Piezo Electric	Force Generators, Fluid 1	nechanical Actuato	ors, I	Electric Motors				
and S	witches.						07 11				
Digit	al Engina Con	140	Sustama	Unit –III			07 Hrs				
	al Engine Con			ontrol modes for fuel Co	ntrol (Seven Mod	ec)	FGR Control				
				d Loop Ignition timing,							
	rated Engine C			a hoop ignition unning,	spann navanoe (.0110	, section section,				
•	cle Motion Co		•								
				igital Cruise Control Sys	tem, Digital Spee	d S	ensor, Throttle				
Actua	ator, Digital C	ruis	se Control co	nfiguration, Cruise Contro	1 Electronics (Digi	tal	only), Antilock				
Brake	e System (ABS), E	lectronic Susp	ension System, Electronic	Steering Control.						
				Unit –IV			08 Hrs				
	motive Comm					_					
				ms, Technical principles,	1 07	7. B	uses in motor				
			•	net, IP, PSI5, MOST, D2B	and DSI.						
	motive Ember			e velopment software development li	facualas Orramia		ALTOCAD				
				SAR Architecture.	iccycles. Overvie	w	AUTUSAK				
ment	saorogy und pr			Unit –V			08 Hrs				

Electronics and Communication Engineering

Timing Light, Engine Analyzer, Electronic Control System Diagnostics: Onboard diagnostics, Offboard diagnostics, Expert Systems, Occupant Protection Systems – Accelerometer based Air Bag systems, Case study on ON-BOARD, OFF-BOARD diagnostics.

Advances in Automotive Electronic Systems:

Alternative Fuel Engines, Electric and Hybrid vehicles, Fuel cell powered cars, Collision Avoidance Radar warning Systems, Navigation: Navigation Sensors, Radio Navigation, dead reckoning navigation, Video based driver assistance systems, Night vision Systems.

Course	Outcomes: After completing the course, the students will be able to
CO1:	Acquire the knowledge of automotive domain fundamentals, need of Electronics and
	communication interfaces in Automotive systems.
CO2:	Apply various types of sensors, actuators and Motion Control techniques in Automotive
	systems
CO3:	Analyze digital engine control systems and Embedded Software's and ECUsused in
	automotive systems.
CO4:	Illustrate the concepts of Diagnostics, safety and advances in Automotive electronic Systems.
Refere	nce Books
1	Understanding Automotive Electronics, Williams. B. Ribbens, 6th Edition, 2003, Elsevier
1	science, Newness publication, ISBN-9780080481494.
2	Automotive Electronics Handbook, Robert Bosch, 2004, John Wiley and Sons, ISBN-
2	0471288357
	Automobile Electrical and Electronic Systems, Tom Denton, Third edition, Elsevier
3	Butterworth-Heinemann. ISBN 0-7506-62190.
4	Advanced Automotive Fault Diagnosis, Tom Denton, Second edition, Elsevier Butterworth-
4	Heinemann. ISBN 0-75-066991-8.

Continuous Internal Evaluation (CIE); Theory (100 Marks)

CIE is executed by way of quizzes (Q), tests (T) and Assignment/Presentation/Project (A). A minimum of three quizzes are conducted and each quiz is evaluated for 10 marks adding up to 30 marks. All quizzes are conducted online. Faculty may adopt innovative methods for conducting quizzes effectively. The number of quizzes may be more than three also. The three tests are conducted for 50 marks each and the sum of the marks scored from three tests is reduced to 50. The marks component for experiential learning is 20.

Total CIE is 30(Q) +50(T) +20(EL) =100 Marks.

Semester End Evaluation (SEE); Theory (100 Marks)

SEE for 100 marksis executed by means of an examination. The Question paper for the course contains two parts, Part – A and Part – B. Part – A consists of objective type questions for 20 marks covering the complete syllabus. Part – B consists of five main questions, one from each unit for 16 marks adding up to 80 marks. Each main question may have sub questions. The question from Units I, IV and V have no internal choice. Units II and III have internal choice in which both questions cover entire unit having same complexity in terms of COs and Bloom's taxonomy level.

CO-PO Mapping												
CO/PO	PO1	PO2	PO3	PO4	PO5	PO6	PO7	PO8	PO9	PO10	PO11	PO12
CO1	3	2	-	-	-	1	2	-	-	-	-	2
CO2	3	2	1	-	-	1	2	-	-	-	-	2
CO3	3	3	2	-	2	1	2	-	-	-	-	2
CO4	3	3	3	2	2	1	2	-	-	-	-	2

High-3: Medium-2: Low-1

Electronics and Communication Engineering

				Semester: VII						
			ОРТОЕ	LECTRONICS AND NETWORKS						
			(G	roup G: Professional Elective)						
Cou	rse Code	:	18EC7G2	CIE	:	100 Marks				
Crea	dits: L:T:P	:	3:0:0	SEE	:	100 Marks				
	l Hours	:	40L	SEE Duratio	on :	03 Hours				
Cou		-		tudents will be able to						
1				to manipulate the fundamental properties of	<u> </u>	t.				
2										
3		abil	ity to formula	ate problems related to photonic structures,	proce	sses and analyse				
4	them.	o fi	har naturaliza	protection schemes and passive optical net	vorka					
4	Describe basi	сп	bei networks,	protection schemes and passive optical new	NOIKS.					
				Unit-I		09 Hrs				
Rav	Optics									
Posta Wav	es, Paraxial V	Vav	ves, Simple (Complex Representation and Helmholtz Optical Components: Reflection and Ref rence: Two Waves and Multiple-Wave Inter	fractio	n, Transmission				
unot	ign Optical Col	npe	ments, interre	Unit – II		08 Hrs				
Bear	m Optics					UU III5				
		n: C	omplex Amp	itude, Properties, Power, Beam Width, Be	am Di	vergence, Depth				
	cus, Beam Qua					C I				
	istical Optics									
	-		•	ht: Optical Intensity, Temporal Coherence	and S	pectrum, Spatial				
and	Longitudinal Co	ohe	rence, Interfer	ence of Partially Coherent Light. Unit –III		07 11.00				
Phot	ton Optics			Unit –III		07 Hrs				
		Str	eams Interac	tions of Photons with Atoms.						
	SER Amplifiers									
LAS	-									
LAS Theo			umping, Co	mmon LASER amplifiers, Theory of	LAS	SER oscillation,				
Theo	acteristics of L	P		mmon LASER amplifiers, Theory of	LAS					
Theo Char		AS	ER Output.	mmon LASER amplifiers, Theory of Unit –IV	LAS	SER oscillation,				
Theo Char	iconductor Ph	AS	ER Output.	Unit –IV	LAS					
Theo Char Sem Ligh	iconductor Ph t-Emitting Dio	• P AS oto des,	ER Output. n Sources		LAS					
Theo Char Sem Ligh Sem	iconductor Ph t-Emitting Diod iconductor Ph	• P AS oto des, oto	ER Output. n Sources Semiconduct n Detectors	Unit –IV or Optical Amplifiers, Laser Diodes.		08 Hrs				
Theo Char Sem Ligh Sem	iconductor Ph t-Emitting Diod iconductor Ph	• P AS oto des, oto	ER Output. n Sources Semiconduct n Detectors	Unit –IV or Optical Amplifiers, Laser Diodes. otodiodes, Avalanche Photodiodes, Noise ir		08 Hrs				
Theo Char Sem Ligh Sem Phot	iconductor Ph t-Emitting Dioo iconductor Ph odetectors, Pho	• P AS oto des, oto	ER Output. n Sources Semiconduct n Detectors	Unit –IV or Optical Amplifiers, Laser Diodes.		08 Hrs				
Theo Char Sem Ligh Sem Phot	iconductor Ph t-Emitting Dioo iconductor Ph odetectors, Pho ical Networks	oto oto des, oto	ER Output. n Sources , Semiconduct n Detectors onductors, Ph	Unit –IV or Optical Amplifiers, Laser Diodes. otodiodes, Avalanche Photodiodes, Noise ir	n Phote	08 Hrs odetectors. 08 Hrs				
Theo Char Sem Ligh Sem Phot Opti Basic	iconductor Ph it-Emitting Diod iconductor Ph odetectors, Pho ical Networks c Networks, SC	oto des, oto	ER Output. n Sources Semiconduct n Detectors onductors, Ph ET/SDH, Broa	Unit –IV or Optical Amplifiers, Laser Diodes. otodiodes, Avalanche Photodiodes, Noise ir Unit –V	n Phote	08 Hrs odetectors. 08 Hrs outed Networks,				
Theo Char Sem Ligh Sem Phot Opti Basic Non	iconductor Ph it-Emitting Dio iconductor Ph odetectors, Pho ical Networks c Networks, SC linear effects of	oto oto des, oto btoc	ER Output. n Sources , Semiconduct n Detectors onductors, Ph ET/SDH, Broa Network per	Unit –IV or Optical Amplifiers, Laser Diodes. otodiodes, Avalanche Photodiodes, Noise in Unit –V dcast and select WDM Networks, Waveler	n Phote	08 Hrs odetectors. 08 Hrs outed Networks,				
Theo Char Sem Ligh Sem Phot Opti Basic Nonl Isola	iconductor Ph t-Emitting Dioo iconductor Ph odetectors, Pho ical Networks c Networks, SC linear effects o ttors, Circulator	• P AS oto des, oto otoc	ER Output. n Sources Semiconduct n Detectors onductors, Ph ET/SDH, Broa Network per Dptical CDMA	Unit –IV or Optical Amplifiers, Laser Diodes. otodiodes, Avalanche Photodiodes, Noise ir Unit –V udcast and select WDM Networks, Waveler formance, Performance of WDM + EDI A, Ultra High Capacity Networks.	n Phote	08 Hrs odetectors. 08 Hrs outed Networks,				
Theo Char Sem Ligh Sem Phot Opti Basio Nonl Isola	iconductor Ph t-Emitting Diod iconductor Ph odetectors, Pho ical Networks c Networks, SC linear effects of itors, Circulator rse Outcomes:	P AS oto des, oto toc DNH on rs, C Af	ER Output. n Sources Semiconduct n Detectors onductors, Ph ET/SDH, Broa Network per Dptical CDMA ter completin	Unit –IV or Optical Amplifiers, Laser Diodes. otodiodes, Avalanche Photodiodes, Noise ir Unit –V udcast and select WDM Networks, Waveler formance, Performance of WDM + EDI A, Ultra High Capacity Networks. g the course, the students will be able to	n Photo ngth R FA sy	08 Hrs odetectors. 08 Hrs outed Networks, stems, Solitons,				
Theo Char Sem Ligh Sem Phot Opti Basic Nonl Isola	iconductor Ph it-Emitting Diod iconductor Ph odetectors, Pho ical Networks c Networks, SC linear effects of itors, Circulator rse Outcomes:	oto oto des, oto oto oto oto oto oto oto oto oto ot	ER Output. n Sources Semiconduct n Detectors onductors, Ph ET/SDH, Broa Network per Dptical CDMA ter completin atical principl	Unit –IV or Optical Amplifiers, Laser Diodes. otodiodes, Avalanche Photodiodes, Noise ir Unit –V udcast and select WDM Networks, Waveler formance, Performance of WDM + EDI A, Ultra High Capacity Networks.	n Phota ngth R FA sy ze thei	08 Hrs odetectors. 08 Hrs outed Networks, rstems, Solitons, r performance.				

 Coherence.

 CO3:
 Design circuits involving optical sources and detectors based on given design parameters.

CO4:	Illustrate the networking aspect of optical fiber and describe various standards associated with
	it.

Refer	ence Books
1	Fundamentals of Photonics, B.E.A. Saleh, M.C.Teich, Wiley, 2 nd Edition, 2007, ISBN: 978-0-471-35832-9.
2	Optical Fiber Communications: Principles and Practice, John M. Senior, Pearson Prentice Hall, 3 rd Edition, 2009, ISBN: 978-0-13-032681-2.
3	Optical Fiber Communications, Gerd Keiser, Pearson Education, 3 rd Edition, 2010, ISBN: 978-8131732663.
4	Optical Networks: A Practical Perspective, Rajiv Ramaswami, Kumar N. Sivarajan and Galen H. Sasaki, 3 rd Edition, 2010, ISBN: 978-0-12-374092-2.

CIE is executed by way of quizzes (Q), tests (T) and Assignment/Presentation/Project (A). A minimum of three quizzes are conducted and each quiz is evaluated for 10 marks adding up to 30 marks. All quizzes are conducted online. Faculty may adopt innovative methods for conducting quizzes effectively. The number of quizzes may be more than three also. The three tests are conducted for 50 marks each and the sum of the marks scored from three tests is reduced to 50. The marks component for experiential learning is 20.

Total CIE is 30(Q) +60(T) +10(A) =100 Marks.

Semester End Evaluation (SEE); Theory (100 Marks)

SEE for 100 marksis executed by means of an examination. The Question paper for the course contains two parts, Part – A and Part – B. Part – A consists of objective type questions for 20 marks covering the complete syllabus. Part – B consists of five main questions, one from each unit for 16 marks adding up to 80 marks. Each main question may have sub questions. The question from Units I, IV and V have no internal choice. Units II and III have internal choice in which both questions cover entire unit having same complexity in terms of COs and Bloom's taxonomy level.

	CO-PO Mapping												
CO/PO	PO1	PO2	PO3	PO4	PO5	PO6	PO7	PO8	PO9	PO10	PO11	PO12	
CO1	3	3	2	-	-	-	-	-	-	2	-	3	
CO2	3	3	2	-	2	-	-	-	2	2	-	3	
CO3	3	3	3	2	-	-	-	-	2	2	-	3	
CO4	2	3	3	2	1	-	1	-	2	2	-	3	

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				Semester: VII						
			S	SYSTEM ON CHIP DESIGN	N					
				Froup G: Professional Electi	ive)					
Cou	rse Code	:	18EC7G3		CIE	:	100 Marks			
Cred	lits: L:T:P	:	3:0:0		SEE	:	100 Marks			
Tota	l Hours	:	39L		SEE Duration	:	3.00 Hours			
Cour				tudents will be able to						
1				Flow, Design challenges, goa						
2	Design appro	bach	es of Soc Des	ign, specifications, types of sp	pecifications, The	e Sy	stem design			
	process.									
3	System level design issues: IP verification and Integration, Hardware-Software codesign, Design									
	for timing closure, Logic design issues. Bus architecture and its limitations. Network on Chip (NOC) topologies. Mesh-based NoC.									
4										
	System on Cl		C. Packet swi	itching and wormhole routing	g, Concept of Mul	upi	ocessor –			
	System on C	шр								
				Unit-I			08 Hrs			
Moti	ivation for So	СD	esign				00 1115			
Čano requi Hard Mac Over Deve	IP, Design for TO Design Pro view of IP Dese cloping Hard I	sign cess sign	n, SoC Design Specification ing closure, , Key Features Pros	n flow - waterfall vs spiral, To , System Design process, Sy Unit – II s, Planning and Specification, Macros, The Hard Macro Des	, Macro design an	n is .d V	verification.			
Macr	ros.									
				Unit –III			07 Hrs			
Verif Reus VLS	e, approaches. I Packaging	Vei	ification and	erification methodology, Ver Device Test, Verification Plan ribution, Input/Output, Chip-	ns.	-				
Into				Unit –IV			08 Hrs			
Bus	rconnect Arch architecture ar oC. Packet swi	nd it	s limitations.	Network on Chip (NOC) topo	ologies. Mesh-bas	sed	NoC. Routing ir			
un 1 1	c c. i ucret SWI		ing und worth	Unit –V			08 Hrs			
			PSoCs, Techr	niques for designing MPSo	Cs. Performance	an	·			

Course	Course Outcomes: After completing the course, the students will be able to								
CO1:	Learn about the system on chip design and macro design process								
CO2:	Analyze the design flow, IP cores, routing used in system on chip								
CO3:	Exposure the concepts of verification methodology and interconnection methods in SoC								
CO4:	Design & Develop the algorithms required for the design of IP and SoC and Exposure to the								
	concept of MPSoCs.								

Refer	ence Books
1	Reuse Methodology manual for System-On-A-Chip Designs, Michael Keating, Pierre Bricaud,
1	Kluwer Academic Publishers, 2 nd edition,2001
2	SoC Verification-Methodology and Techniques, Prakash Rashinkar, Peter Paterson and Leena
2	Singh, Kluwer Academic Publishers,2001.
2	On-Chip Communication Architectures: System on Chip Interconnect",
3	Sudeep Pasricha and NikilDutt, Morgan Kaufmann Publishers © 2008
4	Introduction to system on package sop- Miniaturization of the Entire System, Rao R.
4	Tummala, Madhavan Swaminathan, McGraw-Hill, 2008.
5	Multiprocessor Systems-on-chips, A.A.Jerraya, W.Wolf, 1stEdition,Morgan Kaufmann, 2004

CIE is executed by way of quizzes (Q), tests (T) and experiential learning (EL). A minimum of three quizzes are conducted and each quiz is evaluated for 10 marks adding up to 30 marks. All quizzes are conducted online. Faculty may adopt innovative methods for conducting quizzes effectively. The number of quizzes may be more than three also. The three tests are conducted for 50 marks each and the sum of the marks scored from three tests is reduced to 50. The marks component for experiential learning is 20.

Total CIE is 30(Q) +50(T) +20(EL) =100 Marks.

Semester End Evaluation (SEE); Theory (100 Marks)

SEE for 100 marks is executed by means of an examination. The Question paper for the course contains two parts, Part A and Part B. Part A consists of objective type questions for 20 marks covering the complete syllabus. Part B consists of five main questions, one from each unit for 16 marks adding up to 80 marks. Each main question may have sub questions. The question from Units I, IV and V have no internal choice. Units II and III have internal choice in which both questions cover entire unit having same complexity in terms of COs and Bloom's taxonomy level.

CO-PO Mapping												
CO/PO	PO1	PO2	PO3	PO4	PO5	PO6	PO7	PO8	PO9	PO10	PO11	PO12
CO1	2	2	2	-	-	-	-	-	-		-	-
CO2	2	2	2	3	-	-	-	2	2		-	-
CO3	2	2	2	2	2	1	-	2	2		-	-
CO4	2	2	3	3	2	2	2	2	3	2	2	2

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	Semester: VII									
MULTIMEDIA COMMUNICATION										
(Group G: Professional Elective)										
CourseCode:18EC7G4CIE Marks:100 Marks										
Cred	Credits:L:T:P : 3:0:0 SEE Marks : 100 Marks									
Total Hours:39 LSEEDuration:3.00 Hours										
Cou	rse Learning	g O	bjectives: Tl	he students w	vill be able to					
1	Understand	l th	e basics of an	alog and digi	tal video: vide	o representation	and tra	nsm	ission	
2				video signals		•				
3	Analyze the fundamental video processing techniques & acquire the basic skill of designing video compression									
4	Design vid	eo t	ransmission	systems: erroi	r control and ra	ate control				
				Unit	-I				08 Hrs	
Mult	timedia Co	mm	unications:	multimedia	information	representation	, multi	ime	dia networks,	
mult	multimedia applications, network QoS and application QoS.									
	Unit-II 08 Hrs									
Text	Text and image compression, compression principles:lossless and lossy, Source encoders and									
desti	destination decoders, Entropy encoding, Source encoding, Statistical encoding text compression-									

 Runlength,static
 HuffmanCoding,Dynamic
 Huffman
 coding,Arithmetic
 coding,LZ,
 LZW,
 Image

 compression- GIF,
 TIFF and JPEG.
 08 Hrs

Audio and video compression: Introduction, audio compression, DPCM, ADPCM, APC, LPC, video compression principles.

 Unit-IV
 08 Hrs

 Video compression standards: H.261, H.263, MPEG, MPEG 1, MPEG 2, MPEG-4 and Reversible
 VLCs.

Unit-V08 HrsThe Internet: Introduction, IP datagrams, fragmentation, Internet protocol address, ARP and RARP,
QoS. Transport Protocol: Introduction, TCP/IP, TCP, UDP, RTP and RTCP, RSVP.

Course	Course Outcomes: After completing the course, the students will be able to								
CO1:	Describe and describe various multimedia data.								
CO2:	Analyze the representation of multimedia data.								
CO3:	Describe the concept involved in MPEG4 standards.								
CO4:	Develop algorithms for protocols like RTP,RTCP for multimedia communication over mobile networks.								

Reference Books

1.	Multimedia Communications, Fred Halsall, Pearson education, 2001. ISBN: 8131709949, 978-
	8131709948
2.	Multimedia Communication Systems, K. R. Rao, Zoran S. Bojkovic, Dragorad A. Milovanovic,
	Pearson education, 2004.ISBN: 013031398X978-0130313980
3.	Multimedia: Computing, Communications and Applications, Raifsteinmetz, Klara Nahrstedt,
	Pearson education, 2002, ISBN: 3540408673, 978-3540408673
4.	Multimedia: An Introduction, John Villamil, Louis Molina, PHI, 2002, ISBN: 1575765578, 978-
	1575765570

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Continuous Internal Evaluation (CIE): Theory (100 Marks)

CIE is executed by way of quizzes (Q), tests (T) and experiential learning (EL). A minimum of three quizzes are conducted and each quiz is evaluated for 10 marks adding up to 30 marks. All quizzes are conducted online. Faculty may adopt innovative methods for conducting quizzes effectively. The number of quizzes may be more than three also. The three tests are conducted for 50 marks each and the sum of the marks scored from three tests is reduced to 50. The marks component for experiential learning is 20. Total CIE is 30(Q) + 50(T) + 20(EL) = 100 Marks.

Semester End Evaluation (SEE); Theory (100 Marks)

SEE for 100 marksis executed by means of an examination. The Question paper for the course contains two parts, Part – A and Part – B. Part – A consists of objective type questions for 20 marks covering the complete syllabus. Part – B consists of five main questions, one from each unit for 16 marks adding up to 80 marks. Each main question may have sub questions. The question from Units I, IV and V have no internal choice. Units II and III have internal choice in which both questions cover entire unit having same complexity in terms of COs and Bloom's taxonomy level.

CO-PO Mapping												
CO/PO	PO1	PO2	PO3	PO4	PO5	PO6	PO7	PO8	PO9	PO10	PO11	PO12
CO1	2	3	3	3	3	-	-	-	-	-	-	2
CO2	3	1	3	-	2	-	-	-	-	-	-	2
CO3	2	3	1	2	2	-	-	-	2	-	-	1
CO4	3	3	-	2	3	-	-	-	2	-	-	1

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				Semester: VII							
				ASIC DESIGN							
			(G	roup G: Professional Elective)							
Cou	rse Code	:	18EC7G5	CIE		:	100 Marks				
Crea	dits: L:T:P	:	3:0:0	SEE		:	100 Marks				
Tota	Total Hours:39 LSEE Duration:3.										
Cou	rse Learning	Obj	ectives: The s	tudents will be able to	ľ						
1				of ASIC and its design methods							
2	Differentiate between ASICs and FPGAs, standard cells, cell libraries, IPs.										
3											
4	Analysing th	ne st	teps involved	in physical design of ASIC includ	ing floor pla	an	ning, placement				
	and Routing.	De	sign a digital s	ystem from specifications to GDSII	•						
				Unit-I			07 Hrs				
Intro	oduction to A	SIC	s								
Тур	es of ASICs: F	ull (Custom ASIC,	Semi-custom based ASICS, Standa	ard Cell base	ed					
	•			nneled gate array, Channelless gate	e array, Stru	ıct	ured gate array,				
	rammable logi	c de	evices, FPGA.								
Desi	gn flow.						I				
	OS Logic			Unit – II			08 Hrs				
		ıpile	CI 3								
	C Library Des ical effort: pro	sign		Unit –III gical area and logical efficiency, lo	ogical paths,	, n	08 Hrs				
Logi	ical effort: pre	s ign edict	ting delay, log	Unit –III gical area and logical efficiency, logs, Library cell design.	ogical paths,	, n					
Logi optir	ical effort: pre num delay, opt	sign edict	ting delay, log im no. of stage	gical area and logical efficiency, lo			nulti stage cells,				
Logi optir Prog	ical effort: pro num delay, op grammable AS	sign edict timu SIC	ting delay, log um no. of stage S: The Antifus	gical area and logical efficiency, lo s, Library cell design.			nulti stage cells,				
Logi optir Prog Acte gene Low Icons in pl ASIO Phys	ical effort: pre num delay, op grammable AS grammable AS action ACT: ACT rators, Timing r-Level Design s & Symbols, ace attributes, C Constructio sical Design, C	sign edict timu SIC: SIC: T1 1 mo En Net: Net: Net: AD	ting delay, log um no. of stage S: The Antifus s logic cells ogic module, dels and critica try: Schematic s, schematic e list, screener, I Floor Planning Tools, System	gical area and logical efficiency, lo s, Library cell design. e, Static RAM, EPROM and EEPR	OM technolo Multiplexer ing. ell library, N ored instanc	lo lo Nai	ulti stage cells, y. 08 Hrs gic as function mes, Schematic, and buses, Edit				
Logi optir Prog Acte gene Low Icons in pl ASIO Phys	ical effort: pre num delay, op grammable AS grammable AS action ACT: ACT rators, Timing r-Level Design s & Symbols, ace attributes, C Constructio sical Design, C	sign edict timu SIC: SIC: T1 1 mo En Net: Net: Net: AD	ting delay, log um no. of stage S: The Antifus s logic cells ogic module, dels and critica try: Schematic s, schematic e list, screener, I Floor Planning Tools, System	gical area and logical efficiency, logical area and logical efficiency, logical efficiency, logical estimation of the static RAM, EPROM and EEPROUNIT –IV Shannon's expansion theorem, Mal path, speed gating, worst case time c Entry: Hierarchical design. The c ntry for ASIC'S, connections, vector and annotation g and Power Planning Partitioning, Estimating ASIC size	OM technolo Multiplexer ing. ell library, N ored instanc	lo lo Nai	ulti stage cells, y. 08 Hrs gic as function mes, Schematic, and buses, Edit				
Logi optir Prog Acte gene Low Icons in pl ASIC Phys Floo	ical effort: pre- num delay, op grammable AS grammable AS eff ACT: ACT rators, Timing r-Level Design s & Symbols, ace attributes, C Constructio sical Design, C r planning tool C Constructio ement algorith gn flow globa	sign edictimu SIC: 5IC: 1 1 mo En Net Net Net Net Net Net Net Net Net Net	ting delay, log um no. of stage S: The Antifus s logic cells ogic module, dels and critica try: Schemati s, schematic e list, screener, I Floor Plannin Tools, System O and power p Placement, Ro iterative plac	gical area and logical efficiency, loss, Library cell design. e, Static RAM, EPROM and EEPRO Unit –IV Shannon's expansion theorem, Mal path, speed gating, worst case tim c Entry: Hierarchical design. The c ntry for ASIC'S, connections, vector Back annotation g and Power Planning h Partitioning, Estimating ASIC size planning, clock planning Unit –V	OM technolo Multiplexer ing. ell library, N ored instanc , partitioning placement	og lo Nai ses g r	ulti stage cells, y. 08 Hrs gic as function mes, Schematic, and buses, Edit nethods. 08 Hrs ethods. Physical				
Logi optir Prog Acte gene Low Icons in pl ASIO Phys Floo Desi DRC	ical effort: pro- num delay, opi grammable AS grammable AS grammable AS el ACT: ACT rators, Timing r-Level Design s & Symbols, ace attributes, C Constructio sical Design, C r planning tool C Constructio ement algorith gn flow globa	sign edictimu SIC: SIC: Ci 1 mo En Net: Net: Net: AD s, I/ n: H ms, 1 Rc	ting delay, log um no. of stage S: The Antifus s logic cells ogic module, dels and critica try: Schematic e list, screener, I Floor Plannin Tools, System O and power p Placement, Ro iterative plac buting, Local 1	gical area and logical efficiency, logical area and logical efficiency, logical static RAM, EPROM and EEPROUNT –IV Shannon's expansion theorem, Mal path, speed gating, worst case time c Entry: Hierarchical design. The c ntry for ASIC'S, connections, vector Back annotation g and Power Planning Partitioning, Estimating ASIC size blanning, clock planning Unit –V uting ement improvement, Time driven Routing, Detail Routing, Special R	OM technolo Multiplexer ing. ell library, N ored instanc , partitioning placement n outing, Circ	og lo Nai ses g r	ulti stage cells, y. 08 Hrs gic as function mes, Schematic, and buses, Edit nethods. 08 Hrs ethods. Physical				
Logi optir Prog Acte gene Low Icons in pl ASIO Phys Floo Desi DRC	ical effort: pre num delay, op grammable AS grammable AS a ACT: ACT rators, Timing r-Level Design s & Symbols, ace attributes, C Constructio sical Design, C r planning tool C Constructio ement algorith gn flow globa C.	sign edictimu SIC: SIC: T1 1 mo En Net: Net: Net: AD s, I/ n: I ms, 1 Rc : Af	ting delay, log um no. of stage S: The Antifus s logic cells ogic module, dels and critica try: Schematic e list, screener, I Floor Planning Tools, System O and power p Placement, Ro iterative plac buting, Local D	gical area and logical efficiency, logical area and logical efficiency, logical efficiency, logical static RAM, EPROM and EEPROUNIT –IV Shannon's expansion theorem, Mal path, speed gating, worst case time c Entry: Hierarchical design. The c ntry for ASIC'S, connections, vector ack annotation g and Power Planning Partitioning, Estimating ASIC size blanning, clock planning Unit –V suting ement improvement, Time driven Routing, Detail Routing, Special R	OM technolo Multiplexer ing. ell library, N ored instanc , partitioning placement n outing, Circ able to	og lo Naves g r me	ulti stage cells, y. 08 Hrs gic as function mes, Schematic, and buses, Edit nethods. 08 Hrs ethods. Physical t Extraction and				
Logi optir Prog Acte gene Low Icons in pl ASIO Phys Floo Desi DRC	ical effort: pre- num delay, op grammable AS grammable AS arators, Timing -Level Design s & Symbols, ace attributes, C Constructio sical Design, C r planning tool C Constructio ement algorith gn flow globa C rse Outcomes : Learn the	sign edict SIC: SIC: T1 1 mo En Net: Net: AD s, I/ n: H ms, I Rc I Rc	ting delay, log um no. of stage S: The Antifus s logic cells ogic module, dels and critica try: Schematic s, schematic e list, screener, I Floor Planning Tools, System O and power p Placement, Ro iterative plac buting, Local 1 <u>ter completin</u> es involved in	gical area and logical efficiency, logical area and logical efficiency, logical efficiency, logical estimation of the expansion of the energy of the expansion of the energy of the expansion of the energy of the expansion of the	OM technolo Multiplexer ing. ell library, N ored instanc , partitioning placement n outing, Circ able to	og lo Naves g r me	ulti stage cells, y. 08 Hrs gic as function mes, Schematic, and buses, Edit nethods. 08 Hrs ethods. Physical t Extraction and				
Logi optir Prog Acte gene Low Icons in pl ASIO Phys Floo Desi DRC Cou	ical effort: pro- num delay, op grammable AS grammable AS and ACT: ACT rators, Timing r-Level Design s & Symbols, ace attributes, C Constructio sical Design, C r planning tool C Constructio ement algorith gn flow globa C rse Outcomes : Learn the management	sign edict SIC: SIC: Cl 1 mo En Net Net Net Net Net Net Net Net S, I/ Net S, I/ S, I/ S, I/ S, I/ S, I/ S, I/ S, I/ S, I/ S, S, S	ting delay, log im no. of stage S: The Antifus ogic module, dels and critica try: Schemati s, schematic e list, screener, I Floor Planning Tools, System O and power p Placement, Ro iterative plac buting, Local D ter completin es involved in tool-flow, veri	gical area and logical efficiency, logical area and logical efficiency, logical efficiency, logical static RAM, EPROM and EEPROUNIT –IV Shannon's expansion theorem, Mal path, speed gating, worst case time c Entry: Hierarchical design. The c ntry for ASIC'S, connections, vector ack annotation g and Power Planning Partitioning, Estimating ASIC size blanning, clock planning Unit –V suting ement improvement, Time driven Routing, Detail Routing, Special R	OM technolo Multiplexer ing. ell library, N ored instanc , partitioning placement n outing, Circ able to	og lo Nar es g r me	ulti stage cells, y. 08 Hrs gic as function mes, Schematic, and buses, Edit nethods. 08 Hrs ethods. Physical t Extraction and				

Apply & analyze the design parameters for speed, area & power optimization.Develop the algorithms required for the design of ASIC CO2:

CO3:

CO4:	Apply the back-end physical design flow, including floor planning, placement, and
	Routing techniques,

Ref	ference Books
1	Application - Specific Integrated Circuits, M.J. S. Smith, Pearson Education, 2003, ISBN:978-817758-408-0
2	Advanced ASIC Chip Synthesis Using Synopsys Design Compiler Physical Compiler and Prime
	Time, H. Bhatnagar, -2nd edition, 2001, ISBN:0792385373
3	Logic Synthesis Using Synopsys, P. Kurup, T. Abbasi, ISBN 0-7923-9582-4
4	Multiprocessor Systems-on-chips, A.A.Jerraya, W.Wolf, 1 st Edition,Morgan Kaufmann, 2004

Continuous Internal Evaluation (CIE); Theory (100 Marks)

CIE is executed by way of quizzes (Q), tests (T) and experiential learning (EL). A minimum of three quizzes are conducted and each quiz is evaluated for 10 marks adding up to 30 marks. All quizzes are conducted online. Faculty may adopt innovative methods for conducting quizzes effectively. The number of quizzes may be more than three also. The three tests are conducted for 50 marks each and the sum of the marks scored from three tests is reduced to 50. The marks component for experiential learning is 20.

Total CIE is 30(Q) +50(T) +20(EL) =100 Marks.

Semester End Evaluation (SEE); Theory (100 Marks)

SEE for 100 marks is executed by means of an examination. The Question paper for the course contains two parts, Part A and Part B. Part A consists of objective type questions for 20 marks covering the complete syllabus. Part B consists of five main questions, one from each unit for 16 marks adding up to 80 marks. Each main question may have sub questions. The question from Units I, IV and V have no internal choice. Units II and III have internal choice in which both questions cover entire unit having same complexity in terms of COs and Bloom's taxonomy level.

	CO-PO Mapping														
CO/PO	CO/PO PO1 PO2 PO3 PO4 PO5 PO6 PO7 PO8 PO9 PO10 PO11 PO12														
CO1	2	2	2	-	-	-	-	-	-		-	-			
CO2	2	2	2	2	-	-	-	2	2		-	-			
CO3	2	2	2	3	-	-	-	2	2		-	-			
CO4	3	3	3	3	2	2	2	2	3	2	2	2			

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				Semester: VII										
			ARM PR	OGRAMMING AND OPTIM	IZATION									
				Group G: Professional Electiv										
Cou	rse Code	:	18EC7G6		CIE	:	100 Marks							
Crec	lits: L:T:P	:	3:0:0		SEE	:	100 Marks							
Total Hours : 39L SEE Duration : 3														
Cou	Course Learning Objectives: The students will be able to													
1														
2														
3 Identify the design issues ARM based														
4	4 Analyze the execution of instructions/program knowing the basic principles of ARM													
	⁴ architecture and assembly language.													
				11			00 11.40							
Intro	duction AD	ME	mily Oyomyia	Unit-I w, Data Path Architecture, Regi	istora Madaa Ev	0.010	08 Hrs							
	A Instruction		unity Overvie	w, Data Fatli Afcintecture, Regi	isters, modes, Ex	cep	lions							
			tructions Br	anch instructions, Load stor	e instructions	soft	ware interrunt							
				ster instructions, loading con										
	litional execu			the month of the second s		-	,							
				ster usage, ARM Thumb inter	working, Other l	oran	ch instructions,							
				le register load store instruct										
instr	uctions, stack	c inst	ructions, soft	ware interrupt instruction.		-								
				Unit-II			08 Hrs							
Prog	gramming i	in C	for ARM											
				ptimization, basic C data typ										
				aliasing, structure arrangement										
Endi	aness, divisio	on, fl	oating point,	inline functions and inline asser	nbly, portability	issu								
				Unit-III			08 Hrs							
				sembly Code	1 1 1		. 11 .							
				and cycle counting, instructi										
cond data	ittional exect	ltion	, looping cor	structs, Bit manipulation, efficient	cient switches. I	lanc	lling unaligned							
uata				Unit-IV			08 Hrs							
Onti	imized Prim	itive	8				00 1115							
				cation, Integer Normalization,	Counting Trailir	σ7	eros Division							
				n Division, Signed Division,										
			tal Functions			1.1	inter implicent							
	,			Unit-V			07 Hrs							
Exce	eption and I	nterr	upt Handlin				1							
Exce	ption Handli	ng, I	nterrupts, No	n-nested Interrupt handler, Re-e	ntrant Interrupt h	and	ler							
Firm	ware & Boot	t load	ler											
	edded Oper													
Fund	lamental Cor	npon	ents, Simple	Operating System										
				ng the course, the students wi			<u> </u>							
CO1				er's model of ARM processo	or and analyse	the	instruction set							
				lex operations.		-	11.1.2							
CO2						emb	edded software							
CO2 Apply the optimization methods available for ARM architectures to design embedded software to meet given constraints with the help of modern engineering tools.														

to meet given constraints with the help of modern engineering tools. Write optimized code to perform primitives mathematical & OS operations on different ARM CO3

	architectures by making use of software libraries.
CO4	Engage in self-study to formulate, design, implement, analyze and demonstrate an application
	realized on ARM development boards through assignments.

D C	
Refe	erence Books
1	ARM System Developer's Guide, Andrew N Sloss, Dominic Symes, Chris Wright, Elsevier,
	Morgan Kaufman publishers, 2008, ISBN-13:9788181476463
2	The Definitive Guide to the ARM Cortex-M3& M4 Processors, Joseph Yiu, 3rd Edition, 2014
	Newnes (Elsevier), ISBN:978-93-5107-175-4
3	ARM Architecture Reference Manual, David seal, Addison-Wesley, 2 nd Edition, 2009, ISBN-
	13:9780201737196
4	ARM System on Chip Architecture, Steve Furber, Pearson Education Limited, 2 nd Edition, ISBN-
	13:9780201675191
5	Technical reference manual for ARM processor cores including Cortex, ARM 11, ARM 9 &
	ARM 7 processor families.
6	User guides and reference manuals for ARM software development tools.

CIE is executed by way of quizzes (Q), tests (T) and Assignment/Presentation/Project (A). A minimum of three quizzes are conducted and each quiz is evaluated for 10 marks adding up to 30 marks. All quizzes are conducted online. Faculty may adopt innovative methods for conducting quizzes effectively. The number of quizzes may be more than three also. The three tests are conducted for 50 marks each and the sum of the marks scored from three tests is reduced to 50. The marks component for experiential learning is 20.

Total CIE is 30(Q) +60(T) +10(A) =100 M.

Semester End Evaluation (SEE); Theory (100 Marks)

SEE for 100 marksis executed by means of an examination. The Question paper for the course contains two parts, Part – A and Part – B. Part – A consists of objective type questions for 20 marks covering the complete syllabus. Part – B consists of five main questions, one from each unit for 16 marks adding up to 80 marks. Each main question may have sub questions. The question from Units I, IV and V have no internal choice. Units II and III have internal choice in which both questions cover the entire unit having the same complexity in terms of COs and Bloom's taxonomy level.

					CO-]	PO Ma	pping								
CO/PO	CO/PO PO1 PO2 PO3 PO4 PO5 PO6 PO7 PO8 PO9 PO10 PO11 PO12														
CO1	3	2	1	2	2	-	-	-	-	2	-	2			
CO2	2	2	2	1	2	1	-	-	-	2	-	3			
CO3	3	2	3	2	1	2	-	-	-	-	-	3			
CO4	3	2	3	3	2	1	-	-	-	2	-	2			

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				Semester: VII			
			UNN	IANNED AERIAL VEHICLE	S		
		-		Group H: Global Elective)	I		
	se Code	:	18G7H01		CIE	:	100 Marks
Credits: L:T:P		:	3:0:0		SEE	:	100 Marks
Hou		:	39L		SEE Duration:	:	3.00 Hours
Cour	se Learning O	bje	ctives: The stu	dents will be able to			
1			of the history of	-			
2	Understand th UAV	e in	nportance of ac	rodynamics, propulsion, struct	ures and avionics	in t	he design o
3			ity to address to not the test of	he various mission payloads - systems	on-board & off-b	oard	l, propulsior
4	Comprehend t	he i	mportance of gi	idance and navigation of a UA	V		
				T T •/ T			0=
0	• • • • • •		1 4 • 1 37 1 •	Unit-I	TTAX7 NT. 1 . C		07 Hrs
				cles and Systems: History of			
				System Composition, Classifica		ed o	n size, range
and e	ndurance, Basi	c we	orking of fixed,	rotary and flapping UAVs, App Unit – II	lications of UAVs.		08 Hrs
Aaro	dynamics of	Un	mannad Aaria	Vehicles: Airfoil nomencla	ture and its charge	octor	
	v			r, Types of drag, Aerodynam			· ·
	• •		-HTOL, VTOL		nes of fotaly and	Παj	oping wings
7 11110	ame comiguian	0115		Unit -III			08 Hrs
Strue	ctures of UAV	: M	echanic loading	, Load calculation, Materials u	sed for UAV (gene	ral i	
				s of structural elements use			ntroduction)
					u in UAV their	sign	
chara	cteristics.				a in UAV their	sıgn	
chara				eration, Powered Lift, Sources			ificance and
chara UAV	Propulsion Sy	yste					ificance and
chara UAV Gas t	Propulsion Sy urbine engines,	yste ele	ms: Thrust Gen ctric or battery p	oowered UAVs. Unit -IV	of Power for UAV	s- Pi	ificance and iston, Rotary 08 Hrs
chara UAV Gas t Payle	Propulsion Sy urbine engines, oads of UAVs	yste ele :No	ms: Thrust Gen ctric or battery p on-dispensable I	oowered UAVs. Unit -IV Payloads- Electro-optic Payload	of Power for UAVs	s- Pi	ificance and iston, Rotary
chara UAV Gas t Paylo Elect	Propulsion Sy urbine engines, oads of UAVs ronic Warfare F	yste ele :No Payl	ms: Thrust Gen ctric or battery p on-dispensable I oads, Dispensab	oowered UAVs. Unit -IV Payloads- Electro-optic Payload le Payloads and other payloads	of Power for UAVs Systems, Radar In	s- Pi	ificance and ston, Rotary 08 Hrs ng Payloads
chara UAV Gas t Paylo Elect Laur	Propulsion Sy urbine engines, oads of UAVs ronic Warfare F uch and Reco	yste ele No No Payl	ms: Thrust Gen ctric or battery p on-dispensable I oads, Dispensab y Systems for	bowered UAVs. Unit -IV Payloads- Electro-optic Payload le Payloads and other payloads UAVs: UAV Launch Metho	of Power for UAVs Systems, Radar In ds for Fixed-Wing	s- Pi magi g V	ificance and ston, Rotary 08 Hrs ng Payloads ehicles- Rail
chara UAV Gas t Paylo Elect Laun	Propulsion Sy urbine engines, oads of UAVs ronic Warfare F ach and Reco chers, Pneumat	yste ele No No Payl very ic I	ms: Thrust Gen ctric or battery p on-dispensable I oads, Dispensab y Systems for Launchers, Hydr	oowered UAVs. Unit -IV Payloads- Electro-optic Payload ele Payloads and other payloads UAVs: UAV Launch Metho aulic/Pneumatic Launchers, Ze	of Power for UAVs Systems, Radar In ds for Fixed-Wing ro Length RATO L	s- Pi magi g V Laun	ificance and iston, Rotary 08 Hrs ng Payloads ehicles- Rai ch of UAVs
chara UAV Gas t Payle Elect Laun UAV	Propulsion Sy urbine engines, oads of UAVs ronic Warfare H ich and Recor- chers, Pneumat Recovery Syst	yste ele No ayl very ic I	ms: Thrust Gen ctric or battery p on-dispensable H oads, Dispensab y Systems for Launchers, Hydr s-Conventional	Dowered UAVs. Unit -IV Payloads- Electro-optic Payload of Payloads and other payloads. UAVs: UAV Launch Metho aulic/Pneumatic Launchers, Ze Landings, Vertical Net Systems.	of Power for UAVs Systems, Radar In ds for Fixed-Wing ro Length RATO L	s- Pi magi g V Laun	ificance and iston, Rotary 08 Hrs ng Payloads ehicles- Rai ch of UAVs
chara UAV Gas t Payle Elect Laun UAV	Propulsion Sy urbine engines, oads of UAVs ronic Warfare H ich and Recor- chers, Pneumat Recovery Syst	yste ele No ayl very ic I	ms: Thrust Gen ctric or battery p on-dispensable I oads, Dispensab y Systems for Launchers, Hydr	owered UAVs. Unit -IV Payloads- Electro-optic Payload le Payloads and other payloads. UAVs: UAV Launch Metho aulic/Pneumatic Launchers, Ze Landings, Vertical Net Systems	of Power for UAVs Systems, Radar In ds for Fixed-Wing ro Length RATO L	s- Pi magi g V Laun	ificance and ston, Rotary 08 Hrs ng Payloads ehicles- Rail ch of UAVs /TOL UAVs
chara UAV Gas t Paylo Elect Laun UAV Mid-	Propulsion Synthesis and Soft UAVs or ads of UAVs ronic Warfare F ach and Record chers, Pneumat Recovery Syst Air Retrieval, S	vste ele No Payl very ic I ems hip	ms: Thrust Gen ctric or battery p on-dispensable I oads, Dispensab y Systems for Launchers, Hydr s-Conventional I board Recovery	bowered UAVs. Unit -IV Payloads- Electro-optic Payload ble Payloads and other payloads. UAVs: UAV Launch Methor raulic/Pneumatic Launchers, Ze Landings, Vertical Net Systems. Unit -V	of Power for UAVs Systems, Radar In ds for Fixed-Wing ro Length RATO L	s- Pi magi g V Laun	ificance and ston, Rotary 08 Hrs ng Payloads ehicles- Rail ch of UAVs
chara UAV Gas t Payle Elect Laun UAV Mid-	Propulsion Sy urbine engines, oads of UAVs ronic Warfare F ach and Reco chers, Pneumat Recovery Syst Air Retrieval, S	vste ele No Payl very ic I ems bhip	ms: Thrust Gen ctric or battery p on-dispensable H oads, Dispensable y Systems for Launchers, Hydr s-Conventional 1 board Recovery Guidance System	owered UAVs. Unit -IV Payloads- Electro-optic Payloads ble Payloads and other payloads. UAVs: UAV Launch Methor aulic/Pneumatic Launchers, Ze Landings, Vertical Net Systems Unit -V ns	of Power for UAVs Systems, Radar Ir ds for Fixed-Wing ro Length RATO L , Parachute Recover	s- Pi magi g V Laun ry, V	ificance and iston, Rotary 08 Hrs ng Payloads ehicles- Rail ch of UAVs TOL UAVs 08 Hrs
chara UAV Gas t Payle Elect Laun UAV Mid- UAV Navis	Propulsion Sy urbine engines, oads of UAVs ronic Warfare F och and Reco chers, Pneumat Recovery Syst Air Retrieval, S Navigation an gation, Dead Re	ele ele Nc Payl ic I ems hip d C	ms: Thrust Gen ctric or battery p on-dispensable H oads, Dispensable y Systems for Launchers, Hydr s-Conventional H board Recovery Guidance System	Dowered UAVs. Unit -IV Payloads- Electro-optic Payloads De Payloads and other payloads UAVs: UAV Launch Methor aulic/Pneumatic Launchers, Ze Landings, Vertical Net Systems Unit -V ns Radio Navigation, Satellite–Wa	of Power for UAVs Systems, Radar In ds for Fixed-Wing ro Length RATO I , Parachute Recover	s- Pi magi g V Laun ry, V	ificance and iston, Rotary 08 Hrs ng Payloads, ehicles- Rail ch of UAVs, /TOL UAVs, /TOL UAVs, 08 Hrs
chara UAV Gas t Payle Elect Laun UAV Mid- UAV Navis	Propulsion Sy urbine engines, oads of UAVs ronic Warfare F och and Reco chers, Pneumat Recovery Syst Air Retrieval, S Navigation an gation, Dead Re	ele ele No Payl ic I ems hip d C	ms: Thrust Gen ctric or battery p on-dispensable H oads, Dispensable y Systems for Launchers, Hydr s-Conventional H board Recovery Guidance System	owered UAVs. Unit -IV Payloads- Electro-optic Payloads ble Payloads and other payloads. UAVs: UAV Launch Methor aulic/Pneumatic Launchers, Ze Landings, Vertical Net Systems Unit -V ns	of Power for UAVs Systems, Radar In ds for Fixed-Wing ro Length RATO I , Parachute Recover	s- Pi magi g V Laun ry, V	ificance and iston, Rotary 08 Hrs ng Payloads ehicles- Rai ch of UAVs /TOL UAVs /TOL UAVs 08 Hrs
chara UAV Gas t Payle Elect Laun Laun UAV Mid- Naviş Type	Propulsion Sy urbine engines, oads of UAVs ronic Warfare F ich and Recor chers, Pneumat Recovery Syst Air Retrieval, S Navigation and gation, Dead Res s of guidance, U	ele ele No Payl ic I ems hip d C	ms: Thrust Gen ctric or battery p on-dispensable H oads, Dispensable y Systems for Launchers, Hydr s-Conventional H board Recovery Guidance System	Dowered UAVs. Unit -IV Payloads- Electro-optic Payloads De Payloads and other payloads UAVs: UAV Launch Methor aulic/Pneumatic Launchers, Ze Landings, Vertical Net Systems Unit -V ns Radio Navigation, Satellite–Wa	of Power for UAVs Systems, Radar In ds for Fixed-Wing ro Length RATO I , Parachute Recover	s- Pi magi g V Laun ry, V	ificance and iston, Rotary 08 Hrs ng Payloads ehicles- Rai ch of UAVs /TOL UAVs /TOL UAVs 08 Hrs
chara UAV Gas t Payle Elect Laun UAV Mid- Navia Type	Propulsion Synchronic Warfare Fronce Garage of UAVs ronic Warfare Fronce And Record chers, Pneumate Recovery Syste Air Retrieval, S Navigation and gation, Dead Re- s of guidance, U rse Outcomes:	ste ele international electronic electronic JAV	ms: Thrust Gen ctric or battery p on-dispensable H oads, Dispensable y Systems for Launchers, Hydr s-Conventional 1 board Recovery Guidance System oning, Inertial, I V communicatio	bowered UAVs. Unit -IV Payloads- Electro-optic Payloads ble Payloads and other payloads UAVs: UAV Launch Methor aulic/Pneumatic Launchers, Ze Landings, Vertical Net Systems Unit -V ns Radio Navigation, Satellite–Wa n systems, Ground control statio	of Power for UAVs Systems, Radar In ds for Fixed-Wing ro Length RATO I , Parachute Recover	s- Pi magi g V Laun ry, V	ificance and iston, Rotary 08 Hrs ng Payloads ehicles- Rai ch of UAVs /TOL UAVs /TOL UAVs 08 Hrs
chara UAV Gas t Paylo Elect Laun UAV Mid UAV Navig Type Cour At th	Propulsion Sy urbine engines, oads of UAVs ronic Warfare H ich and Recor chers, Pneumat Recovery Syst Air Retrieval, S Navigation an gation, Dead Re s of guidance, U rse Outcomes: e end of thiscou	vste ele Nc Payl ver hip d C ecko JAV	ms: Thrust Gen ctric or battery p on-dispensable H oads, Dispensable y Systems for Launchers, Hydr s-Conventional I board Recovery Guidance System oning, Inertial, I V communicatio	Dowered UAVs. Unit -IV Payloads- Electro-optic Payloads De Payloads and other payloads UAVs: UAV Launch Metho aulic/Pneumatic Launchers, Ze Landings, Vertical Net Systems Unit -V ns Radio Navigation, Satellite–Wa n systems, Ground control station I be able to :	of Power for UAVs Systems, Radar In ds for Fixed-Wing ro Length RATO I , Parachute Recover y point Navigation, on, Telemetry, UAS	s- Primagi g V Laun ry, V	ificance and iston, Rotary 08 Hrs ng Payloads ehicles- Rail ch of UAVs /TOL UAVs /TOL UAVs 08 Hrs V Guidance ure.
chara UAV Gas t Payle Elect Laun UAV Mid- Navia Type	Propulsion Sy urbine engines, oads of UAVs ronic Warfare F ich and Recor chers, Pneumat Recovery Syst Air Retrieval, S Navigation an gation, Dead Re s of guidance, U rse Outcomes: e end of thiscou Appraise the	vste ele iNC Payl very ic I eecko JAV	ms: Thrust Gen ctric or battery p on-dispensable H oads, Dispensable y Systems for Launchers, Hydn s-Conventional I board Recovery Guidance System oning, Inertial, H V communicatio the student will olution of UAVs	bowered UAVs. Unit -IV Payloads- Electro-optic Payloads ble Payloads and other payloads UAVs: UAV Launch Methor aulic/Pneumatic Launchers, Ze Landings, Vertical Net Systems Unit -V ns Radio Navigation, Satellite–Wa n systems, Ground control statio	of Power for UAVs Systems, Radar In ds for Fixed-Wing ro Length RATO L , Parachute Recover y point Navigation, on, Telemetry, UAS	s- Pi magi g V Laun ry, V UA S fut	ificance and iston, Rotary 08 Hrs ng Payloads ehicles- Rail ch of UAVs /TOL UAVs /TOL UAVs 08 Hrs V Guidance ure.

CO3 Determine and evaluate the performance of UAV designed for various Missions and applications

CO4 Appreciate the guidance and navigation systems for enabling the versatility of UAV systems

Ref	erence Books
1	Unmanned Aircraft Systems UAV design, development and deployment, Reg Austin, 1 st Edition, 2010, Wiley, ISBN 9780470058190.
2	Introduction to UAV Systems, Paul G Fahlstrom, Thomas J Gleason, 4 th Edition, 2012, Wiley, ISBN: 978-1-119-97866-4
3	Advances in Unmanned Aerial Vehicles: State of the Art and the Road to Autonomy, Kimon P. Valavanis, 1 st Edition,2007, Springer ISBN 9781402061141
4	Flight Stability and Automatic Control, Robert C. Nelson, 2 nd Edition, October 1, 1997, McGraw-Hill, Inc, ISBN 978-0070462731.
5	Design of Unmanned Air Vehicle Systems, Dr. Armand J. Chaput, 3 rd Edition, 2001, Lockheed Martin Aeronautics Company, ISBN: 978-1-60086-843-6

CIE is executed by way of quizzes (Q), tests (T) and experiential learning (EL). A minimum of three quizzes are conducted and each quiz is evaluated for 10 marks adding up to 30 marks. All quizzes are conducted online. Faculty may adopt innovative methods for conducting quizzes effectively. The number of quizzes may be more than three also. The three tests are conducted for 50 marks each and the sum of the marks scored from three tests is reduced to 50. The marks component for experiential learning is 20. Total CIE is 30(Q) + 50(T) + 20(EL) = 100 Marks.

Semester End Evaluation (SEE); Theory (100 Marks)

SEE for 100 marksis executed by means of an examination. The Question paper for the course contains two parts, Part – A and Part – B. Part – A consists of objective type questions for 20 marks covering the complete syllabus. Part – B consists of five main questions, one from each unit for 16 marks adding up to 80 marks. Each main question may have sub questions. The question from Units I, IV and V have no internal choice. Units II and III have internal choice in which both questions cover entire unit having same complexity in terms of COs and Bloom's taxonomy level.

	CO-PO Mapping														
CO/PO	CO/PO PO1 PO2 PO3 PO4 PO5 PO6 PO7 PO8 PO9 PO10 PO11 PO12														
CO1	3	3	3	1	1	3	2	2	-	-	-	1			
CO2	2	3	3	3	1	1	1	1	-	-	-	2			
CO3	1	-	3	3	-	-	-	-	-	-	-	2			
CO4	3	3	3	3	-	2	1	2	-	-	-	2			

				Semester: VII					
				BIOINFORMAT	ICS				
~	~ .	r –		(Group H: Global El	í í		400.75		
	rse Code	:	18G7H02		CIE	:	100 Marks		
	lits: L:T:P	:	3:0:0:0		SEE	:	100 Marks		
	l Hours	:	39 L		SEE Duration	:	3.00 Hours		
			ectives: The studen		in inciliaa racaarah				
 Acquire the knowledge of biological database and its role in insilico research Understand the essential algorithms behind the biological data analysis such as Dynamic programming, 									
2				tering algorithms alon					
3							tures of both macro and		
-				mics of macromolecul					
4		tati	on of unknown D	NA and Protein sequ	lences and explore	the	principles of molecular		
	modelling								
5		nov	vledge towards a	nalyzing the sequen	ces using program	ımin	g languages and Drug		
	development								
				Unit-I			08 Hrs		
Rior	nolecules and l	ntr	oduction to Bioin				00 1115		
Sequ sequ aligr Sear Phy Metl	ience analysis ence alignment iment, Database ch Tool (BLA: logenetics: Intr nods - Distance-	: I , A e Si ST) rodu Ba	lignment algorithn imilarity Searching , and FASTA. No uction, Terminolog sed, Character-Bas	ns Needleman & Wur g- Scoring matrices – ext Generation Seque gy, Forms of Tree F ed Methods and Phylo Unit –III	nch, Smith & Wate BLOSSUM and P encing – Alignmen Representation. Phy ogenetic Tree evalua	rmar AM, t and vloge	08 Hrs ace alignment, Multiple and Progressive globa Basic Local Alignmen d Assembly. Molecular netic Tree Construction 09 Hrs		
appr seco struc	oaches. ORFs fo ndary structure	or g , P met	ene prediction. De rotein structure ba thods using protein	tection of functional s asics, structure visual a sequence, Protein ide	ites and codon bias ization, compariso	in th n an	o and homology-based e DNA. Predicting RNA d classification. Protein tion. Structure prediction		
DEE	.т.т., 1	,		Unit –IV	0	• 1 •	07 Hrs		
Obje Type	ect Oriented Protester – Scalar, A	ogra rray	amming in Perl-C	lass and object, Poly array. Regular Exp	morphism, inherita	nce	es and Special variables and encapsulation. Data mponents of REGEX		
				Unit –V			07 Hrs		
Data aligr	base and subm	issi	on of sequence to	online Database, Ind	lexing and accessir	ng lo	Sequence retrieval from cal databases, Sequence ent, Parsing BLAST and		

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Course	Course Outcomes: After completing the course, the students will be able to							
CO1:	Demonstrate the knowledge of retrieval of the biological data in the essential formats and its analysis.							
CO2:	Analyse the gene, protein and RNA data to find the degree of similarities and identifying the patterns							
CO3:	Apply the drug designing methods for screening and inventing the new targets and drugs							
CO4:	Predict the structure of a compound and design the molecule.							

Refere	Reference Books						
1.	Essential Bioinformatics, JinXiong, 2006, Cambridge University Press, ISBN: 978-05-216-00828.						
2.	Bioinformatics: A Practical Guide to the Analysis of Genes and Proteins; D. Andreas Baxevanis and B. F; Francis Ouellette. 2009; Wiley-IEEE; 3rd edn; ISBN: 978-81-265-21920.						
3	Bioinformatics: Sequence and Genome Analysis; D W Mount; 2014; CSHL Press; 2nd edn; ISBN: 9780879697129.						
4	Computational Systems Biology; A Kriete and R Eils; 2006; Academic Press; Illustrated edn; ISBN: 978-01-208-87866.						

CIE is executed by way of quizzes (Q), tests (T) and experiential learning (EL). A minimum of three quizzes are conducted and each quiz is evaluated for 10 marks adding up to 30 marks. All quizzes are conducted online. Faculty may adopt innovative methods for conducting quizzes effectively. The number of quizzes may be more than three also. The three tests are conducted for 50 marks each and the sum of the marks scored from three tests is reduced to 50. The marks component for experiential learning is 20. **Total CIE is 30(Q) + 50(T) + 20(EL) = 100 Marks.**

Semester End Evaluation (SEE); Theory (100 Marks) SEE for 100 marksis executed by means of an examination. The Question paper for the course contains two parts, Part – A and Part – B. Part – A consists of objective type questions for 20 marks covering the complete syllabus. Part – B consists of five main questions, one from each unit for 16 marks adding up to 80 marks. Each main question may have sub questions. The question from Units I, IV and V have no internal choice. Units II and III have internal choice in which both questions cover entire unit having same complexity in terms of COs and Bloom's taxonomy level.

	CO-PO Mapping											
CO/PO	PO1	PO2	PO3	PO4	PO5	PO6	PO7	PO8	PO9	PO10	PO11	PO12
CO1	3	2	-	-	-	-	-	-	-	1	-	1
CO2	3	2	2	1	-	-	-	-	-	1	-	1
CO3	3	3	2	2	-	-	-	-	-	1	-	1
CO4	3	3	3	3	-	-	-	-	-	1	-	1

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				Semester: V	/II		
			INDUSTRIAL	SAFETY AND F	RISK MANAGEM	IEN	T
			(0	Group H: Global	Elective)		
Cou	rse Code	:	18G7H03		CIE	:	100 Marks
Crea	lits: L:T:P	:	3:0:0		SEE	:	100 Marks
Total Hours : 39 L			39 L		SEE Duration	:	3.00 Hours
Cou	rse Learning	Oł	jectives: The stud	ents will be able t	0		
1 Select appropriate risk assessment techniques.							
2 Analyze public and individual perception of risk.							
3							
4	Carry out ri	sk a	ssessment in proce	ess industries			

Unit-I	08 Hrs
Introduction: Introduction to industrial safety engineering, major industrial accidents, safety	ety and health
issues, key concepts and terminologies, Hazard theory, Hazard triangle, Hazard actuati	on, Actuation
transition, Causal factors, Hazard recognition.	
Unit – II	08 Hrs
Risk assessment and control: Individual and societal risks, Risk assessment, Ris	k perception,
Acceptable risk, ALARP, Prevention through design.	
Hazard Identification Methods: Preliminary Hazard List (PHL): Overview, methodology	y, worksheets,
case study. Preliminary Hazard Analysis (PHA): Overview, methodology, worksheets	s, risk index,
example.	
Unit –III	08 Hrs
Hazard analysis: Hazard and Operability Study (HAZOP): Definition, Process parar words, HAZOP matrix, Procedure, Example. Failure Modes and Effects Analy Introduction, system breakdown concept, methodology, example.	
Unit –IV	08 Hrs
Application of Hazard Identification Techniques: Case of pressure tank, system	n breakdown
structure, safety ontology, Accident paths, HAZOP application, risk adjusted discounted	rate method,
probability distribution, Hiller's model	
Unit –V	07 Hrs
Safety in process industries and case studies: Personnel Protection Equipment (PPE):	Safety glasses,
face shields, welding helmets, absorptive lenses, hard hats, types of hand PPE, types of f	oot PPE, types
of body PPE. Bhopal gas tragedy, Chernobyl nuclear disaster, Chemical plant explosi	
Course Outcomes: After completing the course, the students will be able to	
CO1: Recall risk assessment techniques used in process industry.	
·	

CO2	Interpret the various risk assessment tools.

- CO3:Use hazard identification tools for safety management.CO4:Analyze tools and safety procedures for protection in process industries.

Refer	ence Books
1	Functional Safety in the Process Industry: A Handbook of practical Guidance in the application of IEC61511 and ANSI/ISA-84, Kirkcaldy K.J.D Chauhan, 2012, North Carolina, Lulu publication, ISBN:1291187235
2	Safety Instrumented Systems Verification Practical probabilistic calculations, Goble and William M., 2005, Pensulvania ISA publication, ISBN:155617909X
3	Industrial safety and risk Management, Laird Wilson and Doug Mc Cutche, 1st Edition, 2003, The University of Albertapress, Canada, ISBN: 0888643942.
4	Industrial Safety, Health and Environment Management Systems, R K Jain, Sunil S Rao, 4th

Edition, 2005, Khanna Publishers, New Delhi, ISBN: 8174092102

Continuous Internal Evaluation (CIE); Theory (100 Marks)

CIE is executed by way of quizzes (Q), tests (T) and experiential learning (EL). A minimum of three quizzes are conducted and each quiz is evaluated for 10 marks adding up to 30 marks. All quizzes are conducted online. Faculty may adopt innovative methods for conducting quizzes effectively. The number of quizzes may be more than three also. The three tests are conducted for 50 marks each and the sum of the marks scored from three tests is reduced to 50. The marks component for experiential learning is 20. Total CIE is 30(Q) + 50(T) + 20(EL) = 100 Marks.

Semester End Evaluation (SEE); Theory (100 Marks)

SEE for 100 marksis executed by means of an examination. The Question paper for the course contains two parts, Part – A and Part – B. Part – A consists of objective type questions for 20 marks covering the complete syllabus. Part – B consists of five main questions, one from each unit for 16 marks adding up to 80 marks. Each main question may have sub questions. The question from Units I, IV and V have no internal choice. Units II and III have internal choice in which both questions cover entire unit having same complexity in terms of COs and Bloom's taxonomy level.

	CO-1 O Mapping											
CO/PO	PO1	PO2	PO3	PO4	PO5	PO6	PO7	PO8	PO9	PO10	PO11	PO12
CO1	2	3	-	1	-	1	1	1	-	-	1	-
CO2	2	3	1	-	1	1	-	-	-	-	-	-
CO3	3	2	1	1	2	-	1	-	-	1	1	-
CO4	3	-	1	-	-	-	-	-	1	-	1	-

CO-PO Mapping

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	Semester: VII							
	WEB PROGRAMMING							
(Group H: Global Elective)								
Cou	rse Code	:	18G7H04		CIE	:	100 Marl	KS
Crec	redits: L:T:P : 3:0:0 SEE		SEE	:	100 Marl	KS		
Tota	l Hours	:	39 L		SEE Duration	:	3.00 Hou	rs
		Ob	jectives: The stude	nts will be able to				
1					and its differences			
2	Adapt HTM	La	nd CSS syntax & se	emantics to build w	veb pages.			
3	Learn the de	efini	tions and syntax o		gramming tools su	ch	as JavaScri	pt, XML
			ign web pages.					
4					er-side executable	we	eb applicat	ions using
	different tech	hnic	ues such as CSS, J	avaScript, XML ar	nd Ajax.			
								0 -
T .				Unit-I				07 Hrs
			HTML and XHT		1 W-1 C	т		
					and Web Servers asic syntax, Standa			
				Tables, Forms, Fra		alu	siructure,	Dasic text
					l breaks, quotations	s n	reformatted	l text lists
					The audio Elem			
					ences between HTN			
oigu			s, The time Elemen	Unit – II		1L		08 Hrs
CSS	(Cascading S	Styl	e Sheet)					00 1115
				e specification for	mats, Selector forn	ns.	Property va	alue forms.
					The box model,			
<spa< td=""><td>in> and <div></div></td><th>tag</th><td>s, Conflict resolution</td><td>on.</td><th></th><td></td><td>•</td><th></th></spa<>	in> and <div></div>	tag	s, Conflict resolution	on.			•	
	Basics of Jav		-					
		-		. .	General syntactic c			Primitives,
opera	ations, and exp	pres			out; Control statem	ents	5.	
				Unit –III				09 Hrs
	JavaScript (continued): Object creation and modification; Arrays; Functions; Constructor; Pattern matching using regular							
				ays; Functions; Co	onstructor; Pattern	m	atching usi	ng regular
expressions; Errors in scripts.								
expro		s in						
_	Somint and U		I Dogumonta					
Java		ТМ	IL Documents:	The Document O	niect Model: Elem	ent	access in	JavaScript.
Java The	JavaScript ex	TM ecu	tion environment;		oject Model; Elem			
Java The Even	JavaScript ex nts and event	TM ecu han	tion environment; dling; Handling ev	ents from the Bod	ly elements, Buttor			
Java The Even	JavaScript ex nts and event	TM ecu han	tion environment; dling; Handling ev	ents from the Bod odel; The navigato	ly elements, Buttor			xt box and
Java The Even Pass	JavaScript ex ts and event word elements	TN ecu han s; T	tion environment; dling; Handling ev he DOM 2 event m	ents from the Bod	ly elements, Buttor			
Java The Even Pass	JavaScript ex its and event word elements amic Docume	TN ecu han s; T	tion environment; dling; Handling ev he DOM 2 event m with JavaScript:	ents from the Bod odel; The navigato Unit –IV	y elements, Buttor r object.	ı el	ements, Te	xt box and 08 Hrs
Java The Even Pass Dyna Intro	JavaScript ex its and event word elements amic Docume oduction to d	TN ecu han s; T ents yna	tion environment; dling; Handling ev he DOM 2 event m with JavaScript: mic documents; I	rents from the Bod odel; The navigato Unit –IV Positioning elemen	y elements, Buttor r object. nts; Moving elem	ents	ements, Te	xt box and 08 Hrs visibility;
Java The Even Pass Dyna Intro Char	JavaScript ex its and event word elements amic Docume induction to d nging colors a	TM ecu han s; T ents yna nd	tion environment; dling; Handling ev he DOM 2 event m with JavaScript: mic documents; I fonts; Dynamic con	rents from the Bod odel; The navigato Unit –IV Positioning elemer ntent; Stacking elem	y elements, Buttor r object. nts; Moving elem ments; Locating the	ents	ements, Te	xt box and 08 Hrs visibility;
Java The Even Pass Dyna Intro Char to a 1	JavaScript ex its and event word elements amic Docume induction to d nging colors a	TN ecu han s; T ents yna nd Slow	tion environment; dling; Handling ev he DOM 2 event m with JavaScript: mic documents; I fonts; Dynamic con movement of elem	rents from the Bod odel; The navigato Unit –IV Positioning elemer ntent; Stacking elem	y elements, Buttor r object. nts; Moving elem	ents	ements, Te	xt box and 08 Hrs visibility;
Java The Even Pass Dyna Intro Char to a 1 Intro	JavaScript ex its and event word elements amic Docume oduction to d iging colors a mouse click; S oduction to P	TM ecu han s; T ents yna nd blow HP	tion environment; dling; Handling ev he DOM 2 event m with JavaScript: mic documents; I fonts; Dynamic con movement of elem :	rents from the Bod odel; The navigato Unit –IV Positioning element ntent; Stacking elements; Dragging an	y elements, Buttor r object. nts; Moving elem ments; Locating the d dropping elemen	ents	ements, Te	xt box and 08 Hrs visibility; r; Reacting
Java The Even Pass Dyna Intro Char to a t Intro Orig	JavaScript ex its and event word elements amic Docume oduction to d aging colors a mouse click; S oduction to P ins and uses of	TN ecu han s; T ents yna ilow HP	tion environment; dling; Handling ev he DOM 2 event m with JavaScript: mic documents; I fonts; Dynamic con movement of elen : PHP; overview of 1	rents from the Bod odel; The navigato Unit –IV Positioning elementent; Stacking elementent; Stacking elementent; Dragging an PHP; General synt	y elements, Buttor r object. nts; Moving elem ments; Locating the	ents e m ts.	ements, Te s; Element ouse curso Primitives,	xt box and 08 Hrs visibility; r; Reacting Operations
Java The Even Pass Dyna Intro Char to a t Intro Orig and	JavaScript ex its and event word elements amic Docume oduction to d nging colors a mouse click; S oduction to P ins and uses o Expressions;	TN ecu han s; T ents yna nd : Slow HP of H	tion environment; dling; Handling ev he DOM 2 event m with JavaScript: mic documents; I fonts; Dynamic con movement of elen : PHP; overview of 1	rents from the Bod odel; The navigato Unit –IV Positioning elementent; Stacking elementent; Stacking elementent; Dragging an PHP; General synt	nts; Moving elements, Buttor nts; Moving elem ments; Locating the d dropping element actic characteristic	ents e m ts.	ements, Te s; Element ouse curso Primitives,	xt box and 08 Hrs visibility; r; Reacting Operations

XML:Introduction; Syntax; Document structure; Document Type definitions; Namespaces; XML schemas; Displaying raw XML documents; Displaying XML documents with CSS; XSLT style sheets. **Ajax:** Overview of Ajax; Basics of Ajax: The Application; The Form Document; The Request Phase; The Response Document; The Receiver Phase.

Course	Course Outcomes: After completing the course, the students will be able to						
CO1:	Understand the basic syntax and semantics of HTML/XHTML.						
CO2:	Apply HTML/XHTML tags for designing static web pages and forms using Cascading Style						
	Sheet.						
CO3:	Develop Client-Side Scripts using JavaScript and Server-Side Scripts using PHP and utilize the						
	concepts of XML & Ajax to design dynamic web pages.						
CO4:	Develop web-based applications using PHP, XML and Ajax.						

Reference Books

Refer	
1	Programming the World Wide Web – Robert W. Sebesta, 7 th Edition, Pearson Education, 2013, ISBN-13:978-0132665810.
2	Web Programming Building Internet Applications – Chris Bates, 3 rd Edition, Wiley India, 2006, ISBN: 978-81-265-1290-4.
3	Internet & World Wide Web How to H program – M. Deitel, P.J. Deitel, A. B. Goldberg, 3 rd Edition, Pearson Education / PHI, 2004, ISBN-10: 0-130-89550-4
4	The Complete Reference to HTML and XHTML- Thomas A Powell, 4 th Edition, Tata McGraw Hill, 2003, ISBN: 978-0-07-222942-4.

Continuous Internal Evaluation (CIE); Theory (100 Marks)

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Semester End Evaluation (SEE); Theory (100 Marks)

SEE for 100 marks is executed by means of an examination. The Question paper for the course contains two parts, Part A and Part B. Part A consists of objective type questions for 20 marks covering the complete syllabus. Part B consists of five main questions, one from each unit for 16 marks adding up to 80 marks. Each main question may have sub questions. The question from Units I, IV and V have no internal choice. Units II and III have internal choice in which both questions cover entire unit having same complexity in terms of COs and Bloom's taxonomy level.

	CO-PO Mapping											
CO/PO	PO1	PO2	PO3	PO4	PO5	PO6	PO7	PO8	PO9	PO10	PO11	PO12
CO1	1	-	2	-	1	1	1	-	-	-	-	1
CO2	-	-	2	-	1	1	-	-	-	-	-	-
CO3	-	-	-	-	2	-	-	-	2	-	-	2
CO4	-	-	3	-	2	-	-	-	2	-	-	2

				Semester: Vl	I		
SOLID WASTE MANAGEMENT AND STATUTORY RULES (Group H: Global Elective)							
							Course Code : 18G7H05 Cl
Cree	dits: L:T:P	:	3:0:0		SEE	:	100 Marks
Tota	al Hours	:	39 L		SEE Duration	:	3.00 Hours
Cou	rse Learning ()bje	ctives: The stude	nts will be able to			
1					waste management sy	stem	and to analyze th
	drawbacks.						-
2	Understand va	ario	us waste managen	nent statutory rules	for the present system		
3			÷		nt and design and deve		ecycling options for
-			aste by compostin	•	8	I	5 6 1
4	-			-	nd bio medical waste	and	their management
•	systems.			·			
				Unit-I			08 Hrs
Intr	oduction: Prese	ent	solid waste dispos	sal methods. Merit	s and demerits of ope	n dui	mping, incineration
Sour rate,	r ces : Sources o Problems.	of So		of solid waste, con	nposition of municipa		-
Sour rate, Coll Mun	rces: Sources o Problems. ection and tran icipal Solid wa	of So nspo	olid waste, types	of solid waste, con	nposition of municipa Collection of solid was rules with amendment	ste- se	ervices and system
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Sour rate, Coll Mun syste Con Verr Sani in la haza othe haza Bio of b	rces: Sources of Problems. ection and transicipal Solid waters. Prosting Solid waters. Prosting Aeron nicomposting, S itary land filling ndfill- Gas an ardous waster rdous waste, of r wastes (Manardous landfill si medical waster io medical wasters.	f So nspo aste bbic Site ng: I d L ma ager ite ma ste,	olid waste, types ortation of munic (Management and and anaerobic visit to compost p Definition, advanta eachate movement magement: Def e storage, collect: nent and Transbo nagement: Classi Biomedical waste	of solid waste, con- cipal solid waste: of d Handling) 2016 Unit – II composting - lant, Numerical pro- ages and disadvant t, Control of gas an Unit –III finitions, Identifica- ion, transfer and to bundary Movement Unit –IV ification of bio me e management (Collection of solid was rules with amendment process description, oblems. ages, site selection, me d leachate movement, ation of hazardous w ransport, processing, c) Rules, 2016 with an dical waste, collection Management & Har	ste- se s. Sit proc ethods <u>Site v</u> aste, dispo mend	ervices and system e visit to collection 08 Hrs cess microbiology s, reaction occurrin visit to landfill site. 08 Hrs Classification of sal, Hazardous an ments. Site visit to 08 Hrs sportation, dispose g Rules) 2016 wit
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Sour rate, Coll Mun syste Con Verr Sani in la Haz haza othe haza othe baza	rces: Sources of Problems. ection and transicipal Solid waters. posting Aeron nicomposting, S itary land fillin ndfill- Gas an ardous waster rdous waste, of r wastes (Manardous landfill si medical waster io medical wasters ndments. Site wasters	of So nsp aste blic Site ng : I ng : I ng ns it ma ste, visit	olid waste, types ortation of munic (Management and and anaerobic visit to compost p Definition, advanta eachate movement magement: Def e storage, collect: nent and Transbo nagement: Classi Biomedical waste	of solid waste, con- cipal solid waste: of d Handling) 2016 Unit – II composting - lant, Numerical pro- ages and disadvant t, Control of gas an Unit –III finitions, Identifica- ion, transfer and to undary Movement Unit –IV ification of bio me e management (serve biomedical y	Collection of solid was rules with amendment process description, oblems. ages, site selection, me d leachate movement, ation of hazardous w ransport, processing, c) Rules, 2016 with an dical waste, collection Management & Har	ste- se s. Sit proc ethods <u>Site v</u> aste, dispo mend	ervices and system e visit to collection 08 Hrs cess microbiolog s, reaction occurrin visit to landfill site. 08 Hrs Classification of sal, Hazardous an ments. Site visit to 08 Hrs usportation, disposs g Rules) 2016 witt ortation system an
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Cours	Course Outcomes: After completing the course, the students will be able to						
CO1:	Understand the current solid waste management system and statutory rules.						
CO2:	Analyse drawbacks in the present system and provide recycling and disposal options for each type of waste in compliance to rules.						
CO3:	Distinguish Hazardous waste, Biomedical waste, E waste and to provide scientific management						
	system.						
CO4:	Evaluate and monitor the Biomedical waste, Hazardous waste, E waste, Plastic and Municipal						
	waste management as per the rules laid by Ministry of Environment, Forest and Climate change.						

Refere	ence Books:
1	Integrated Solid Waste Management, George.C. Tchobanoglous, International edition ,1993,
1	McGraw hill publication. ISBN 978-0070632370
2	Electronic waste management, R.E. Hester, Roy M Harrison, Cambridge, UK, 2009, RSC
2	Publication, ISBN 9780854041121
3	Solid Waste Management Rules2016, Ministry of Environment, Forest and Climate Change
5	Notification, New Delhi, 8 th April 2016
4	Hazardous and other wastes (Management and Transboundary Movement) Rules, 2016, Ministry of
-	Environment, Forest and Climate Change Notification, New Delhi, 04th April 2016.
5	Biomedical waste management (Management & Handling Rules) 2016, Ministry of Environment
5	& Forest Notification, New Delhi, amendment on 28th March 2016.
6	E-waste (Management) Rules 2016, Ministry of Environment, Forest and Climate Change
U	Notification, New Delhi, 23 rd March 2016.
7	Plastic Waste (Management and Handling) Rules, 2011 as amended in 2018, Ministry of
/	Environment, Forest and Climate Change Notification, New Delhi, 27th March 2018.

CIE is executed by the way of Tests (T), Quizzes (Q),) and Experiential Learning (EL). Three tests are conducted for 50 marks each and the sum of the marks scored from three tests is reduced to 50. Minimum of three quizzes are conducted and each quiz is evaluated for 10 marks adding up to 30 marks. All quizzes are conducted online. Faculty may adopt innovative methods for conducting quizzes effectively. The number of quizzes may be more than three also. The marks component for experiential learning is 20. **Total CIE is 50 (T) +30 (O) +20 (EL) = 100 Marks.**

Semester End Evaluation (SEE); Theory (100 Marks)

SEE for 100 marksis executed by means of an examination. The Question paper for the course contains two parts, Part – A and Part – B. Part – A consists of objective type questions for 20 marks covering the complete syllabus. Part – B consists of five main questions, one from each unit for 16 marks adding up to 80 marks. Each main question may have sub questions. The question from Units I, IV and V have no internal choice. Units II and III have internal choice in which both questions cover entire unit having same complexity in terms of COs and Bloom's taxonomy level.

	CO-PO Mapping											
CO/PO	PO1	PO2	PO3	PO4	PO5	PO6	PO7	PO8	PO9	PO10	PO11	PO12
CO1	1	-	-	-	-	2	2	1	-	1	-	2
CO2	2	2	2	2	-	1	2	1	-	-	-	-
CO3	1	-	2	2	-	1	2	1	-	1	-	-
CO4	2	-	-	3	-	1	2	1	-	-	-	1

	Semester: VII											
IMAGE PROCESSING AND MACHINE LEARNING												
C	con Carla		10071100	(Group H: Global Elective		<u> </u>	100 M. J.					
Course Code		:	18G7H06 3:0:0		CIE		100 Marks					
Credits: L:T:P		:			SEE	:						
	al Hours	:	40 L	danta mill ha ahla ta	SEE Duration	:	3.00 Hours					
<u>Cou</u> 1				idents will be able to and techniques in image proc	accing and Mashin		orning					
2				yze image processing techni		= Le	annig					
2				sion methods, classification 1		mot	hode					
4				and Machine Learning know								
-	algorithms to so	-			ledge by designing	anu	Implementing					
	argorithins to so	0170	e praetiear pre									
				Unit-I			08 Hrs					
Intr	oduction to imag	ze n	processing:				00 1115					
				olications of image processin	g. Components of a	ın ir	nage processing					
				processing, Image formation								
				tion, PPI and DPI, Bitmap in								
				tier curve, Ellipsoid, Gamma								
				ed image concepts.			01 200111118 0110					
	88		8	Unit – II			08 Hrs					
Basi	ics of Python, Sc	ikit	image & Ad	vanced Image Processing u	using Open CV:							
				types, data structures, co		ditic	onal statements.					
1	<u> </u>		6, 6	Unit –III	, 8		uploading & viewing an image, Image resolution, gamma correction, determining structural similarities. Unit –III 08 Hrs					
Adv	anced Image pro	Advanced Image processing using Open CV										
Blending Two Images, Changing Contrast and Brightness Adding Text to Images Smoothing Images,							Uð Hrs					
	iding Two Image				ng Text to Images	Smo						
Blen		es, (Changing Co	ntrast and Brightness Addin			oothing Images,					
Blen Med	lian Filter, Gaus	es, (ssia	Changing Co n Filter, Bil	ntrast and Brightness Addinateral Filter, Changing the	Shape of Image		oothing Images,					
Blen Med	lian Filter, Gaus	es, (ssia	Changing Co n Filter, Bil	ntrast and Brightness Addin	Shape of Image		oothing Images,					
Blen Med Thre	lian Filter, Gaus esholding, Calcula	es, (ssia atin	Changing Co n Filter, Bil g Gradients, I	ntrast and Brightness Addin ateral Filter, Changing the <u>Performing Histogram Equal</u> Unit –IV	Shape of Image		oothing Images, Effecting Image					
Blen Med Thre	lian Filter, Gaus esholding, Calcula ge Processing us	es, (ssian atin	Changing Co n Filter, Bil g Gradients, I Machine Le	ntrast and Brightness Addin ateral Filter, Changing the Performing Histogram Equal Unit –IV arning	e Shape of Image ization	s, E	oothing Images, Effecting Image					
Blen Med Thre Ima Feat	lian Filter, Gaus esholding, Calcula ge Processing us ure mapping us	es, (ssian atin ing ing	Changing Co n Filter, Bil g Gradients, I Machine Le SIFT algori	ntrast and Brightness Addin ateral Filter, Changing the Performing Histogram Equal Unit –IV arning thm, Image registration us	e Shape of Image ization sing the RANSAC	s, E	oothing Images, Effecting Image 08 Hrs gorithm, Image					
Blem Med Three Ima Feat class	lian Filter, Gaus esholding, Calcula ge Processing us ure mapping us sification using A	es, o ssiar atin ing Arti	Changing Co n Filter, Bil g Gradients, I Machine Le SIFT algori ficial Neural	ntrast and Brightness Addin ateral Filter, Changing the Performing Histogram Equal Unit –IV arning	e Shape of Image ization sing the RANSAC	s, E	oothing Images, Effecting Image 08 Hrs gorithm, Image					
Blem Med Three Ima Feat class	lian Filter, Gaus esholding, Calcula ge Processing us ure mapping us	es, o ssiar atin ing Arti	Changing Co n Filter, Bil g Gradients, I Machine Le SIFT algori ficial Neural	ntrast and Brightness Addin ateral Filter, Changing the <u>Performing Histogram Equal</u> <u>Unit –IV</u> arning thm, Image registration us Networks, Image classifica	e Shape of Image ization sing the RANSAC	s, E	oothing Images, Effecting Image 08 Hrs gorithm, Image ge classification					
Blen Med Thre Ima Feat class usin	lian Filter, Gaus esholding, Calcula ge Processing us ure mapping us sification using A g machine learnir	es, 0 ssiar atin ing ing Arti ng A	Changing Co n Filter, Bil g Gradients, I Machine Le SIFT algori ficial Neural	ntrast and Brightness Addin ateral Filter, Changing the Performing Histogram Equal Unit –IV arning thm, Image registration us	e Shape of Image ization sing the RANSAC	s, E	oothing Images, Effecting Image 08 Hrs gorithm, Image					
Blen Med Three Ima Feat class usin Real	lian Filter, Gaus esholding, Calcula ge Processing us ure mapping us sification using A g machine learnin	es, (ssiar atin ing ing Arti ng A	Changing Co n Filter, Bil g Gradients, I Machine Le SIFT algori ficial Neural Approaches.	ntrast and Brightness Addin ateral Filter, Changing the Performing Histogram Equal Unit –IV arning thm, Image registration un Networks, Image classifica	e Shape of Image ization sing the RANSAC tion using CNNs, 1	s, F	oothing Images, Effecting Image 08 Hrs gorithm, Image ge classification 08 Hrs					
Blen Med Thre Ima Feat class usin Exha	lian Filter, Gaus esholding, Calcula ge Processing us ure mapping us sification using A g machine learnir I time use CASE austive vs. Stocl	es, (ssiat atin ing ing Arti ng A S hast	Changing Co n Filter, Bil g Gradients, I Machine Le SIFT algori ficial Neural Approaches.	ntrast and Brightness Addin ateral Filter, Changing the <u>Performing Histogram Equal</u> <u>Unit –IV</u> arning thm, Image registration un Networks, Image classifica <u>Unit –V</u> hapes, Contours, and App	e Shape of Image ization sing the RANSAC tion using CNNs, I earance Models. M	s, F	oothing Images, Effecting Image 08 Hrs gorithm, Image ge classification 08 Hrs n-shift tracking;					
Blen Med Thre Ima Feat class usin Exha	lian Filter, Gaus esholding, Calcula ge Processing us ure mapping us sification using A g machine learnir I time use CASE austive vs. Stocl	es, (ssiat atin ing ing Arti ng A S hast	Changing Co n Filter, Bil g Gradients, I Machine Le SIFT algori ficial Neural Approaches.	ntrast and Brightness Addin ateral Filter, Changing the Performing Histogram Equal Unit –IV arning thm, Image registration un Networks, Image classifica	e Shape of Image ization sing the RANSAC tion using CNNs, I earance Models. M	s, F	oothing Images, Effecting Image 08 Hrs gorithm, Image ge classification 08 Hrs n-shift tracking;					
Blen Med Three Ima Feat class usin Rea Exha Con	lian Filter, Gaus esholding, Calcula ge Processing us ure mapping us sification using A g machine learnir I time use CASE austive vs. Stoch tour-based model	es, (ssiar atin ing Arti S hast s, f	Changing Co n Filter, Bil g Gradients, l Machine Le SIFT algori ficial Neural Approaches. ic Search, S inding palm l	ntrast and Brightness Addin ateral Filter, Changing the <u>Performing Histogram Equal</u> <u>Unit –IV</u> arning ithm, Image registration us Networks, Image classifica <u>Unit –V</u> hapes, Contours, and App ines, Face Detection / Recog	e Shape of Image ization sing the RANSAC tion using CNNs, I earance Models. M nition, Tracking mo	s, F	oothing Images, Effecting Image 08 Hrs gorithm, Image ge classification 08 Hrs n-shift tracking;					
Blen Med Three Ima Feat class usin Rea Exha Con	lian Filter, Gaus esholding, Calcula ge Processing us ure mapping us sification using A g machine learnir I time use CASE austive vs. Stock tour-based model	es, o ssian atin ing Arti S hast s, ft	Changing Co n Filter, Bil g Gradients, l Machine Le SIFT algori ficial Neural Approaches. tic Search, S inding palm l r completing	ntrast and Brightness Addin ateral Filter, Changing the <u>Performing Histogram Equal</u> <u>Unit –IV</u> arning thm, Image registration un Networks, Image classifica <u>Unit –V</u> hapes, Contours, and App	e Shape of Image ization sing the RANSAC tion using CNNs, I earance Models. M nition, Tracking mo	s, F	oothing Images, Effecting Image 08 Hrs gorithm, Image ge classification 08 Hrs n-shift tracking;					

001.	Sam knowledge doodt basic concepts of image i focessing
CO2:	Identify machine learning techniques suitable for a given problem

CO3: Write programs for specific applications in image processing

CO4: Apply different techniques for various applications using machine learning techniques.

Refere	Reference Books						
1	Digital Image Processing, Rafael C. Gonzalez and Richard E. Woods Pearson Education, 3 rd Edition, ISBN 978-81-317-2695-2.						
2	Practical Machine Learning and Image Processing: For Facial Recognition, Object Detection, and Pattern Recognition Using Python, Himanshu Singh, 1 st Edition, Apress, ISBN:978-1-4842-4149-3						
3	Pattern Recognition and Machine Learning, Christopher Bishop, 1 st Edition Springer, 2008, ISBN: 978-0387-31073-2						
4	Computer Vision: A modern Approach, David Forsyth and Jean Ponce, 2 nd Edition, Prentice Hall India 2004, ISBN: 978-0136085928						

CIE is executed by way of quizzes (Q), tests (T) and Assignment. A minimum of three quizzes are conducted and each quiz is evaluated for 10 marks adding up to 30 marks. All quizzes are conducted online. Faculty may adopt innovative methods for conducting quizzes effectively. The number of quizzes may be more than three also. The three tests are conducted for 50 marks each and the sum of the marks scored from three tests is reduced to 50. The marks component for assignment is 20. Total CIE is 30(Q)+50(T)+20(EL)=100Marks

Semester End Evaluation (SEE); Theory (100 Marks)

SEE for 100 marksis executed by means of an examination. The Question paper for each course contains two parts, Part A and Part B. Part A consists of objective type questions for 20 marks covering the complete syllabus. Part B consists of five main questions, one from each unit for 16 marks adding up to 80 marks. Each main question may have sub questions. The question from Units I, IV and V have no internal choice. Units II and III have internal choice in which both questions cover entire unit having same complexity in terms of COs and Bloom's taxonomy level.

	CO-PO Mapping											
CO/PO	PO1	PO2	PO3	PO4	PO5	PO6	PO7	PO8	PO9	PO10	PO11	PO12
CO1	3	3	2	3	2	-	-	-	-	-	-	1
CO2	-	3	-	1	2	-	-	1	2	-	-	1
CO3	3	-	2	1	3	-	-	1	1	1	-	1
CO4	3	3	3	3	2	-	-	1	1	1	-	1

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				Semester: VII			
	RI	ENE	WABLE ENE	RGYSOURCES AND	STORAGE SYS	ГЕ	М
		1		roup H: Global Elect		-	
	ourse Code	:	18G7H07		CIE	:	100 Marks
-	redits: L:T:P	:	3:0:0		SEE	:	100 Marks
	otal Hours	:	39 L		SEE Duration	:	3.00 Hours
				tudents will be able to	1 11. 1 / 1 1		. 1.0
1	energy conver		• •	entional energy sources	and allied technol	ogy	required for
2				king and sizing of batte	erv for a given ann	licat	ion
2	-		solar and wind p	<u> </u>			
<u> </u>	Energy storage			jower systems.			
4	Ellergy storage		linques				
				UNIT-I			08 Hrs
B	sics of Renev	vabl	e Energy: En	ergy balance of the	earth. Solar radia	atio	
-	othermal energy						
				hnical description, heat			
				l generation, economic ion, Energy Plantatio			
				ssifications, Updraft,			
	oplications of B			, - _F ,			,
				Energy Resource, T	idal Power Basi	n,	Advantages and
Di	sadvantages of	Tida	l Power.				
				Unit – II			08 Hrs
-	- 4 - V- 14 - * - O						
				dule and array; Equiva			Open –circuit
vo	ltage and short			dule and array; Equiva and P-V curves, Array o			Open –circuit
vo Co	ltage and short omponents,	circu	uit current, I-V a	and P-V curves, Array	design, Peak powe	r Tr	Dpen –circuit acking, System
vo Co Gi	Itage and short omponents, rid Connected	circu So	uit current, I-V a	and P-V curves, Array or System: Introduct	design, Peak powe ion to grid con	r Tr nect	Dpen –circuit acking, System ted PV system,
vo Co Gi Co	Itage and short omponents, rid Connected onfiguration of	circu So Grie	iit current, I-V a blar PV Powe d-connected sol	and P-V curves, Array or er System: Introduct lar PV system, Comp	design, Peak powe ion to grid con onents of Grid –	r Tr nect con	Dpen –circuit acking, System ted PV system, nected solar PV
vo Co Gi Co sy	Itage and short omponents, rid Connected onfiguration of	circu So Grie nnec	it current, I-V a blar PV Powe d-connected sol ted PV system	and P-V curves, Array or System: Introduct	design, Peak powe ion to grid con onents of Grid –	r Tr nect con	Dpen –circuit acking, System ted PV system, nected solar PV
vo Co Gi Co sy sy	ltage and short opponents, rid Connected onfiguration of stems, Grid con stem design for	circu So Grid nnec pow	it current, I-V a blar PV Powe d-connected sol ted PV system ver plants.	and P-V curves, Array of er System: Introduct lar PV system, Comp Design for small pov Unit -III	design, Peak powe ion to grid con onents of Grid – ver Applications,	r Tr nect con Grio	Dpen –circuit acking, System ted PV system, nected solar PV d- connected PV
VC CC Gi CC sy sy Sy	Itage and short of omponents, rid Connected onfiguration of stems, Grid con stem design for ind Power: I	circu So Grid nnec pow	hit current, I-V a plar PV Powe d-connected sol ted PV system ver plants. duction, site	and P-V curves, Array of er System: Introduct lar PV system, Comp Design for small pov	design, Peak powe ion to grid con onents of Grid – ver Applications,	r Tr nect con Grio	Dpen –circuit acking, System ted PV system, nected solar PV d- connected PV
vo Ca Gi Sy sy Sy W	Itage and short of omponents, rid Connected onfiguration of stems, Grid con- stem design for ind Power: I stallations in the	Grid Grid nnec pow	hit current, I-V a blar PV Powe d-connected sol ted PV system ver plants. duction, site rld.	and P-V curves, Array of er System: Introduct lar PV system, Comp Design for small pov Unit -III selection, Advantages	design, Peak powe ion to grid con oonents of Grid – ver Applications, s and Disadvant	r Tr nect con Grid	Dpen –circuit acking, System ted PV system, nected solar PV d- connected PV 08 Hrs s, Wind power
vc Ca Gi Sy sy Sy W ina W	ltage and short omponents, rid Connected onfiguration of stems, Grid con stem design for ind Power: I stallations in the ind Speed and	So Grid nnec pow ntro wor	it current, I-V a blar PV Powe d-connected sol ted PV system rer plants. duction, site rld. hergy: Speed an	and P-V curves, Array of er System: Introduct lar PV system, Comp Design for small pov <u>Unit -III</u> selection, Advantages d Power Relations,Po	design, Peak powe ion to grid con onents of Grid – ver Applications, s and Disadvant wer Extracted fro	r Tr nect con Grid ages m t	Dpen –circuit acking, System ted PV system, nected solar PV d- connected PV 08 Hrs s, Wind power the wind. Rotor-
vo Co G Sy sy sy W in W Sy	Itage and short omponents, rid Connected onfiguration of stems, Grid con stem design for ind Power: I stallations in the ind Speed and vept Area, Air	So Grid nnec pow ntro wor I En Der	hit current, I-V a blar PV Powe d-connected sol ted PV system ver plants. duction, site rld. hergy: Speed an hsity,Global Wi	and P-V curves, Array of er System: Introduct lar PV system, Comp Design for small pov Unit -III selection, Advantages d Power Relations,Po ind Patterns, Wind Sp	design, Peak powe ion to grid con onents of Grid – ver Applications, s and Disadvant wer Extracted fro peed Distribution,	r Tr nect con Grid ages m t	Dpen –circuit acking, System ted PV system, nected solar PV d- connected PV 08 Hrs s, Wind power the wind. Rotor- bull Probability,
VC Ca G Sy Sy Sy W int W Sv Di	Itage and short of omponents, rid Connected onfiguration of stems, Grid con- stem design for ind Power: I stallations in the ind Speed and vept Area, Air stribution,Mode	circu Grid nnec pow Intro Wor I En Der e and	ait current, I-V a plar PV Powe d-connected sol ted PV system ver plants. duction, site rld. hergy: Speed an nsity,Global Wi d Mean Speeds	and P-V curves, Array of er System: Introduct lar PV system, Comp Design for small pov <u>Unit -III</u> selection, Advantages ad Power Relations,Po ind Patterns, Wind Sp , Root Mean Cube Sp	design, Peak powe ion to grid con onents of Grid – ver Applications, s and Disadvant wer Extracted fro peed Distribution, beed, Mode, Mean	r Tr nect con Grid ages m t Wei , ar	Dpen –circuit acking, System ted PV system, nected solar PV d- connected PV 08 Hrs s, Wind power the wind. Rotor- bull Probability, ad RMC Speeds,
VC Ca Sy Sy W ina W Sy Di Er W	Itage and short opponents, rid Connected onfiguration of stems, Grid con- stem design for ind Power: I stallations in the ind Speed and vept Area, Air stribution,Mode nergy Distributio ind Speed Predi	so Grid mec pow ntro wor I En Der e and on, I ction	ait current, I-V a blar PV Powe d-connected sol ted PV system ter plants. duction, site reld. hergy: Speed an nsity,Global Wi d Mean Speeds Digital Data Pro n,Wind Energy 2	er System: Introduct lar PV system, Comp Design for small pov <u>Unit -III</u> selection, Advantages ad Power Relations,Po ind Patterns, Wind Sp , Root Mean Cube Sp pocessing, Effect of Hub Resource Maps.	design, Peak powe ion to grid con onents of Grid – ver Applications, s and Disadvant wer Extracted fro peed Distribution, peed, Mode, Mean o Height, Importan	r Tr nect con Grid ages m t Wei , ar	Dpen –circuit acking, System ted PV system, nected solar PV d- connected PV 08 Hrs s, Wind power the wind. Rotor- bull Probability, nd RMC Speeds, of Reliable Data,
VC CC G Sy Sy Sy Sy Di CC Sy Sy Sy W In: W Di CC W W W W	Itage and short of omponents, rid Connected onfiguration of stems, Grid con- stem design for ind Power: I stallations in the ind Speed and vept Area, Air stribution,Mode nergy Distributio ind Speed Predi ind Power Sys	So Grid nnec pow ntro bewon I En Der e and con, I ction stem	ait current, I-V a blar PV Powe d-connected sol ted PV system ver plants. duction, site rld. hergy: Speed an nsity,Global Wi d Mean Speeds Digital Data Pro- n,Wind Energy: s: System Con-	er System: Introduct lar PV system, Comp Design for small pov <u>Unit -III</u> selection, Advantages ad Power Relations,Po ind Patterns, Wind Sp , Root Mean Cube Sp pocessing, Effect of Hub	design, Peak powe ion to grid con onents of Grid – ver Applications, s and Disadvant wer Extracted fro peed Distribution, peed, Mode, Mean o Height, Importan	r Tr nect con Grid ages m t Wei , ar	Dpen –circuit acking, System ted PV system, nected solar PV d- connected PV 08 Hrs s, Wind power the wind. Rotor- bull Probability, nd RMC Speeds, of Reliable Data,
VC C G Sy Sy W ina W Di Er W W	Itage and short opponents, rid Connected onfiguration of stems, Grid con- stem design for ind Power: I stallations in the ind Speed and vept Area, Air stribution,Mode nergy Distributio ind Speed Predi	So Grid nnec pow ntro bewon I En Der e and con, I ction stem	ait current, I-V a blar PV Powe d-connected sol ted PV system ver plants. duction, site rld. hergy: Speed an nsity,Global Wi d Mean Speeds Digital Data Pro- n,Wind Energy: s: System Con-	er System: Introduct lar PV system, Comp Design for small pov <u>Unit -III</u> selection, Advantages ad Power Relations,Po ind Patterns, Wind Sp , Root Mean Cube Sp pocessing, Effect of Hub Resource Maps.	design, Peak powe ion to grid con onents of Grid – ver Applications, s and Disadvant wer Extracted fro peed Distribution, peed, Mode, Mean o Height, Importan	r Tr nect con Grid ages m t Wei , ar	Dpen –circuit acking, System ted PV system, nected solar PV d- connected PV 08 Hrs s, Wind power the wind. Rotor- bull Probability, nd RMC Speeds, of Reliable Data,
VC C G Sy Sy W in: W D i Er W W R a	Itage and short of omponents, rid Connected onfiguration of stems, Grid con- stem design for ind Power: I stallations in the ind Speed and vept Area, Air stribution,Mode nergy Distributio ind Speed Predi- ind Power Sys- ating, Power vs	sircu So Grid nec pow ntro e woo l Er Der e and on, I Cction stem Spee	ait current, I-V a plar PV Powe d-connected sol ted PV system ver plants. duction, site rld. hergy: Speed an nsity,Global Wid d Mean Speeds Digital Data Pro n,Wind Energy 1 ss: System Con- ed and TSR.	er System: Introduct lar PV system, Comp Design for small pov Unit -III selection, Advantages d Power Relations,Po ind Patterns, Wind Sp , Root Mean Cube Sp ocessing, Effect of Hut Resource Maps. nponents, Tower, Tur Unit –IV	design, Peak powe ion to grid con onents of Grid – ver Applications, s and Disadvant wer Extracted fro peed Distribution, peed, Mode, Mean o Height, Importan bine, Blades, Spe	r Tr nect con Grid ages m t Wei , ar ce d ed (Dpen –circuit acking, System ted PV system, nected solar PV d- connected PV 08 Hrs s, Wind power the wind. Rotor- bull Probability, nd RMC Speeds, of Reliable Data, Control, Turbine 08 Hrs
VCC GCC sy sy W in: W Di Er W W Ra W	Itage and short of omponents, rid Connected onfiguration of stems, Grid con- stem design for ind Power: I stallations in the ind Speed and wept Area, Air stribution,Mode nergy Distributio ind Speed Predi- ind Power Sys- ating, Power vs S- ind Power Sys-	stem	ait current, I-V a plar PV Powe d-connected sol ted PV system rer plants. duction, site rld. nergy: Speed an nsity,Global Wi d Mean Speeds Digital Data Pro n,Wind Energy 1 se: System Con red and TSR.	er System: Introduct lar PV system, Comp Design for small pov <u>Unit -III</u> selection, Advantages d Power Relations,Po ind Patterns, Wind Sp , Root Mean Cube Sp pocessing, Effect of Hub Resource Maps. nponents, Tower, Tur <u>Unit -IV</u> Energy Capture, Maxim	design, Peak powe ion to grid con onents of Grid – ver Applications, s and Disadvant wer Extracted fro peed Distribution, beed, Mode, Mean o Height, Importan bine, Blades, Spe mum Power Oper	r Tr nect con Grid ages m t Wei , ar ce d ed atic	Dpen –circuit acking, System ted PV system, nected solar PV d- connected PV 08 Hrs s, Wind power the wind. Rotor- bull Probability, nd RMC Speeds, of Reliable Data, Control, Turbine 08 Hrs on Constant-TSR
VCC GCC Syy Sy W ina W Di Er W W Ra W Sc Sc	Itage and short of omponents, rid Connected onfiguration of stems, Grid con- stem design for ind Power: I stallations in the ind Speed and wept Area, Air stribution,Mode nergy Distributio ind Speed Predi- ind Power Sys- ting, Power vs st ind Power Sys- heme, Peak-Power Sys-	stem wer-	ait current, I-V a olar PV Powe d-connected sol ted PV system ver plants. duction, site rld. nergy:Speed an nsity,Global Wid d Mean Speeds Digital Data Pro- n,Wind Energy 1 set System Con- red and TSR. ms: Maximum F Tracking schem	er System: Introduct lar PV system, Comp Design for small pov <u>Unit -III</u> selection, Advantages ad Power Relations,Po ind Patterns, Wind Sp , Root Mean Cube Sp ocessing, Effect of Huk Resource Maps. nponents, Tower, Tur <u>Unit –IV</u> Energy Capture, Maxi- ne, System-Design Tra	design, Peak powe ion to grid con onents of Grid – ver Applications, s and Disadvant wer Extracted fro peed Distribution, beed, Mode, Mean o Height, Importan bine, Blades, Spe mum Power Oper de-offs, Turbine J	r Tr nect con Grid ages m t Wei , ar ce d ed atic	Dpen –circuit acking, System ted PV system, nected solar PV d- connected PV 08 Hrs s, Wind power the wind. Rotor- bull Probability, nd RMC Speeds, of Reliable Data, Control, Turbine 08 Hrs on Constant-TSR
VCC GCC Sy Sy W in: W DF W W Ra W Sc N	Itage and short of omponents, rid Connected onfiguration of stems, Grid con- stems, Grid con- stem design for ind Power: I stallations in the ind Speed and vept Area, Air stribution,Mode nergy Distribution ind Speed Predi- ind Power Sys- tting, Power vs ind Power Sys- heme, Peak-Po- umber of Blades	stem	ait current, I-V a olar PV Powe d-connected sol ted PV system ter plants. duction, site rld. nergy:Speed an nsity,Global Wid d Mean Speeds Digital Data Pro- n,Wind Energy: states: System Con- red and TSR. Is: Maximum F Tracking schem- tor Upwind or I	er System: Introduct lar PV system, Comp Design for small pov <u>Unit -III</u> selection, Advantages ad Power Relations,Po ind Patterns, Wind Sp , Root Mean Cube Sp becessing, Effect of Huk Resource Maps. nponents, Tower, Tur <u>Unit –IV</u> Energy Capture, Maxin e, System-Design Tra Downwind, Horizontal	design, Peak powe ion to grid con onents of Grid – ver Applications, s and Disadvant wer Extracted fro beed Distribution, beed, Mode, Mean b Height, Importan bline, Blades, Spe mum Power Oper de-offs, Turbine T vs. Vertical Axis.	r Tr nect con Grid ages m t Wei , ar ce d ed atic	Dpen –circuit acking, System ted PV system, nected solar PV d- connected PV 08 Hrs s, Wind power the wind. Rotor- bull Probability, nd RMC Speeds, of Reliable Data, Control, Turbine 08 Hrs on Constant-TSR
VCC GCC syy Sy W in: W SVI Er W Ra SVI Sy	Itage and short of omponents, rid Connected onfiguration of stems, Grid con- stems, Grid con- stem design for ind Power: I stallations in the ind Speed and vept Area, Air stribution,Mode ergy Distribution ind Speed Predi- ind Power Sys- tting, Power vs S- ind Power Sys- theme, Peak-Po- umber of Blades rstem Control I	stem stem	ait current, I-V a olar PV Powe d-connected sol ted PV system rer plants. duction, site rld. nergy:Speed an nsity,Global Wi d Mean Speeds Digital Data Pro n,Wind Energy s: System Con red and TSR. Is: Maximum H Tracking schem tor Upwind or I irements: Speed	er System: Introduct lar PV system, Comp Design for small pov <u>Unit -III</u> selection, Advantages ad Power Relations,Po ind Patterns, Wind Sp , Root Mean Cube Sp ocessing, Effect of Huk Resource Maps. nponents, Tower, Tur <u>Unit –IV</u> Energy Capture, Maxi- ne, System-Design Tra	design, Peak powe ion to grid con onents of Grid – ver Applications, s and Disadvant wer Extracted fro beed Distribution, beed, Mode, Mean b Height, Importan bline, Blades, Spe mum Power Oper de-offs, Turbine T vs. Vertical Axis. bl.	r Tr nect con Grid ages m t Wei , ar ce d ed ed Cow	Dpen –circuit acking, System ted PV system, nected solar PV d- connected PV 08 Hrs s, Wind power the wind. Rotor- bull Probability, nd RMC Speeds, of Reliable Data, Control, Turbine 08 Hrs on Constant-TSR ers and Spacing,

Energy storage

Batteries: Different types of batteries, Equivalent Electrical Circuit, Battery charging, Battery management

Flywheels: Energy Relations, Components, Benefits over battery

Other Storage devices: Superconducting magnetic energy storage, Compressed air, Pumped storage hydropower, Hydrogen Energy storage

Course	Course Outcomes: After completing the course, the students will be able to					
CO1:	Understand the concepts of power generation from various renewable sources.					
CO2:	Design the Size of the battery required for solar PV applications.					
CO3:	Design main components of solar and wind power systems.					
CO4:	Execute projects in renewable power generation.					

Reference Books

I I I I I I	ILCE DOORS
1	Renewable energy: Technology, Economics and Environment, Martin Kaltschmitt, Wolfgang Streicher Andreas Wiese, Springer Publication, 2007, ISBN 978-3-540-70947- 3
2	Solar photo voltaic Technology and systems, Chetan Singh Solanki, 3 rd edition (2013), PHI , Learning private limited New Delhi ISBN: 978-81-203-4711-3
3	Wind and solar power system design, Analysis and operation, Mukund R. Patel, 2 nd Edition. CRC Group, Taylor and Francis group, New Delhi, ISBN 978-0-8493-1570-1
4	Power System Energy Storage Technologies, Paul Breeze, Academic Press, 2018, ISBN 978-0-12-812902-9

Continuous Internal Evaluation (CIE); Theory (100 Marks)

CIE is executed by way of quizzes (Q), tests (T) and experiential learning (EL). A minimum of three quizzes are conducted and each quiz is evaluated for 10 marks adding up to 30 marks. All quizzes are conducted online. Faculty may adopt innovative methods for conducting quizzes effectively. The number of quizzes may be more than three also. The three tests are conducted for 50 marks each and the sum of the marks scored from three tests is reduced to 50. The marks component for experiential learning is 20.

Total CIE is 30(Q) +50(T) +20(EL) =100 Marks.

Semester End Evaluation (SEE); Theory (100 Marks)

SEE for 100 marksis executed by means of an examination. The Question paper for the course contains two parts, Part – A and Part – B. Part – A consists of objective type questions for 20 marks covering the complete syllabus. Part – B consists of five main questions, one from each unit for 16 marks adding up to 80 marks. Each main question may have sub questions. The question from Units I, IV and V have no internal choice. Units II and III have internal choice in which both questions cover entire unit having same complexity in terms of COs and Bloom's taxonomy level.

	CO-PO Mapping											
CO/PO	PO1	PO2	PO3	PO4	PO5	PO6	PO7	PO8	PO9	PO10	PO11	PO12
CO1	2	2	3	2	-	-	-	-	-	1	-	1
CO2	3	3	2	1	1	2	-	-	-	1	-	1
CO3	3	2	2	2	2	2	2	1	-	1	-	1
CO4	3	3	3	3	2	3	1	1	1	3	1	3

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				Semester: VII					
	MEMS AND APPLICATIONS								
			(0	Group H: Global Elect	tive)				
Cou	rse Code	:	18G7H08		CIE	:	100 Marks		
Cre	dits: L:T:P	:	3:0:0		SEE	:	100 Marks		
Tot	d Hours : 39 L			SEE Duration	:	3.00 Hours			
Cou	rse Learning O	bje	ctives: The stu	dents will be able to					
1	Understand the	ruc	liments of Mici	ro fabrication technique	es.				
2	Identify and associate the various sensors and actuators to applications.								
3	Analyze different materials used for MEMS.								
4	Design applicat	ior	s of MEMS to	disciplines.					

Unit-I	06 Hrs
Overview of MEMS & Microsystems: MEMS and Microsystems, Typical MEMS and micr	o system
products, Evolution of micro fabrication, Microsystems and microelectronics, Multidisciplina	•
of Microsystems, Design and manufacture, Applications of Microsystems in automotive, he	ealthcare,
aerospace and other industries.	
Working Principle of Microsystems: Biomedical and biosensors. Micro sensors: Acoustic, C	Chemical,
Optical, Pressure, Thermal.	
Unit – II	09 Hrs
Micro actuation: Using thermal forces, shape memory alloys, Piezoelectric crystals and electric	
forces. MEMS with micro actuators: Microgrippers, micromotors, microvalves and micro microaccelerometers, microfluidics.	ropumps,
Introduction to Scaling: Scaling in Geometry, Scaling in Rigid body dynamics, Sc	caling in
Electrostatic forces, scaling in electromagnetic forces and scaling in fluid mechanics.	8
Unit –III	09 Hrs
Materials for MEMS and Microsystems: Substrates and wafers, Active substrate materials	s, Silicon
as substrate material, Silicon Compounds, Si-Piezoresistors, GaAs, Quartz, Piezoelectric	Crystals,
Polymers and packaging materials. Three level of Microsystem packaging, Die level pa	ackaging,
Device level packaging, System level packaging. Interfaces in microsystem packaging.	Essential
packaging technologies: die preparation, Surface bonding, Wire bonding, Sealing, 3D packaging	ng.
Unit –IV	08 Hrs
Microsystem Fabrication Process: Introduction to microsystems, Photolithography, Ion Impl	
Diffusion, Oxidation, CVD, PVD-Sputtering, Deposition by Epitaxy, Etching, LIGA process:	General
description, Materials for substrates and photoresists, Electroplating and SLIGA process.	
Unit –V	07 Hrs
Micro Sensors, Actuators, Systems and Smart Materials: An Overview	
Silicon Capacitive Accelerometer, Piezo resistive Pressure sensor, Fibre-optic sensors, Conduc	
Gas Sensor, Electrostatic Comb drive, Magnetic Microrelay, Portable blood analyzer, Piezo	
Inkjet Print head, Micromirror array for Video projection, Micro-PCR Systems, Smart mate	rials and
systems.	
Course Outcomes: After completing the course, the students will be able to	

Course O	Jutcomes: After completing the course, the students will be able to
CO1:	Understand the operation of micro devices, micro systems and their applications.
CO2:	Apply the principle of material science to sensor design.
CO3:	Analyze the materials used for sensor designs.
CO4:	Conceptualize and design micro devices, micro systems.

Referen	ce Books	
1	MEMS & Microsystems Design and Manufacture, Tai-Ran Hsu, 2 nd Edition, 200	2, Tata

	McGraw Hill Education, New Delhi, ISBN-13:978-0-07-048709-3.
2	Micro and Smart Systems, G.K. Ananthasuresh, K.J. Vinoy, K.N. Bhat, V.K. Aatre, 2015, Wiley Publications, ISBN-:978-81-265-2715-1.
3	Foundations of MEMS, Chang Liu, 2012, Pearson Education Inc., ISBN-13:978-0-13-249736-7.
4	Smart Material Systems and MEMS, Vijay K Varadan, K. J. Vinoy, S. Gopalakrishnan, 2006, Wiley-INDIA, ISBN-978-81-265-3170-7.

CIE is executed by way of quizzes (Q), tests (T) and Assignment/Presentation/Project (A). A minimum of three quizzes are conducted and each quiz is evaluated for 10 marks adding up to 30 marks. All quizzes are conducted online. Faculty may adopt innovative methods for conducting quizzes effectively. The number of quizzes may be more than three also. The three tests are conducted for 50 marks each and the sum of the marks scored from three tests is reduced to 50. The marks component for experiential learning is 20.

Total CIE is 30(Q) + 60(T) + 10(A) = 100 Marks.

Semester End Evaluation (SEE); Theory (100 Marks)

SEE for 100 marks executed by means of an examination. The Question paper for the course contains two parts, Part – A and Part – B. Part – A consists of objective type questions for 20 marks covering the complete syllabus. Part – B consists of five main questions, one from each unit for 16 marks adding up to 80 marks. Each main question may have sub questions. The question from Units I, IV and V have no internal choice. Units II and III have internal choice in which both questions cover entire unit having same complexity in terms of COs and Bloom's taxonomy level.

					СО-	PO Maj	pping					
CO/PO	PO1	PO2	PO3	PO4	PO5	PO6	PO7	PO8	PO9	PO10	PO11	PO12
CO1	3	2	-	-	-	-	-	-	-	1	-	1
CO2	3	2	2	1	-	-	-		-	1	-	1
CO3	3	3	2	2	1	-	-		-	1	-	1
CO4	3	3	3	3	1	-	-		1	1	1	1

			Semester: VII	[
		PRO	OJECT MANAGI	EMENT		
		(G	roup H: Global E	lective)		
Course Code	:	18G7H09		CIE	:	100 Marks
Credits: L:T:P	:	3:0:0		SEE	:	100 Marks
Total Hours	:	39L		SEE Duration	:	3.0 Hours
Course Learning	Ob	jectives: The stude	nts will be able to			
1 To understa	nd t	he principles and co	omponents of proje	ct management.		
2 To apprecia	te th	e integrated approa	ch to managing pro	ojects.		
3 To explain	diffe	rent process groups	and knowledge ar	eas used to manage	e pro	ject.

Unit-I	07 Hrs
Introduction: What is project, what is project management, relationships among port	tfolio management,
program management, project management, and organizational project management, re	
project management, operations management and organizational strategy, business	value, role of the
project manager, project management body of knowledge.	
Unit – II	09 Hrs
Organizational influences & Project life cycle: Organizational influences on project	management,
project state holders & governance, project team, project life cycle.	-
Project Integration Management: Develop project charter, develop project manager	nent plan, direct &
manage project work, monitor & control project work, perform integrated change control	rol, close project or
phase.	
Unit –III	09 Hrs
Project Scope Management: Project scope management, collect requirements de	efine scope, create
WBS, validate scope, control scope.	
Project Time Management: Plan schedule management, define activities, sequence	activities, estimate
activity resources, estimate activity durations, develop schedule, control schedule.	
Unit –IV	07 Hrs
Project Cost management: Project Cost management, estimate cost, determine budge	t, control costs.
Project Cost management : Project Cost management, estimate cost, determine budge Project Quality management : Plan quality management, perform quality assurance, c	
Project Quality management: Plan quality management, perform quality assurance, c	ontrol quality. 07 Hrs
Project Quality management: Plan quality management, perform quality assurance, c Unit –V	ontrol quality. 07 Hrs
Project Quality management: Plan quality management, perform quality assurance, c Unit –V Project Risk Management: Plan risk management, identify risks, perform qualita	ontrol quality. 07 Hrs ative risk analysis,
 Project Quality management: Plan quality management, perform quality assurance, c Unit –V Project Risk Management: Plan risk management, identify risks, perform qualita perform quantitative risk analysis, plan risk resources, control risk. 	ontrol quality. 07 Hrs ative risk analysis,
 Project Quality management: Plan quality management, perform quality assurance, c Unit –V Project Risk Management: Plan risk management, identify risks, perform qualita perform quantitative risk analysis, plan risk resources, control risk. Project Procure mentManagement: Project procure ment Management, conductprocure 	ontrol quality. 07 Hrs ative risk analysis,
 Project Quality management: Plan quality management, perform quality assurance, c Unit –V Project Risk Management: Plan risk management, identify risks, perform qualita perform quantitative risk analysis, plan risk resources, control risk. Project Procure mentManagement: Project procure ment Management, conductprocure 	ontrol quality. 07 Hrs ative risk analysis,

CO1:	Understand the concepts, tools and techniques for managing large projects.
CO2:	Explain various knowledge areas and process groups in the project management framework.
CO3:	Analyze and evaluate risks in large and complex project environments.
CO4:	Develop project plans for various types of organizations.

Refere	ence Books
1	A Guide to the Project Management Body of Knowledge(PMBOK Guide), Project Management Institute, 5 th Edition, 2013, ISBN: 978-1-935589-67-9
2	Project Planning Analysis Selection Financing Implementation & Review, Prasanna Chandra, 7 th Edition, 2010, Tata McGraw Hill Publication, ISBN 0-07-007793-2.
3	Project Management A System approach to Planning Scheduling & Controlling, Harold Kerzner, 10 th Edition, 2009, CBS Publishers and Distributors, ISBN 047027806.

ſ		Strategic Project Management Made Simple: Practical Tools for Leaders and Teams, Terry
	-	Schmidt, 1 st Edition, 2009, John Wiley & Sons, ISBN: 978-0470411582

CIE is executed by way of quizzes (Q), tests (T) and experiential learning (EL). A minimum of three quizzes are conducted and each quiz is evaluated for 10 marks adding up to 30 marks. All quizzes are conducted online. Faculty may adopt innovative methods for conducting quizzes effectively. The number of quizzes may be more than three also. The three tests are conducted for 50 marks each and the sum of the marks scored from three tests is reduced to 50. The marks component for experiential learning is 20. Total CIE is 30(Q) + 50(T) + 20(EL) = 100 Marks.

Semester End Evaluation (SEE); Theory (100 Marks)

SEE for 100 marksis executed by means of an examination. The Question paper for the course contains two parts, Part – A and Part – B. Part – A consists of objective type questions for 20 marks covering the complete syllabus. Part – B consists of five main questions, one from each unit for 16 marks adding up to 80 marks. Each main question may have sub questions. The question from Units I, IV and V have no internal choice. Units II and III have internal choice in which both questions cover entire unit having same complexity in terms of COs and Bloom's taxonomy level.

					CO-	PO Ma	pping					
CO/PO	PO1	PO2	PO3	PO4	PO5	PO6	PO7	PO8	PO9	PO10	PO11	PO12
CO1	2	-	-	-	-	-	-	-	-	-	-	-
CO2	2	2	-	1	1	-	-	-	-	-	-	-
CO3	-	-	-	-	-	-	1	1	-	-	-	-
CO4	2	-	3	-	1	-	-	-	-	-	-	-

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				Semester: VII			
		C		ICS AND DIGITAL INVES	TIGATIONS		
C		Τ.		Group H: Global Elective)			100 M - 1 -
	rse Code dits: L:T:P	:	18G7H10 3:0:0		CIE EE	:	100 Marks 100 Marks
	al Hours	:	3:0:0 39 L		EE Duration	•	3.00 Hours
		: Ohid	ctives: The stude		EE DUration	:	5.00 Hours
1	To provide a cybercrime a	n un nd fe	derstanding Comp prensics.	uter forensics fundamental and			npact of
2				neasures for cybercrime, detec		ıg.	
<u>3</u> 4			•	e of Tools used in cyber forens ne and identify Legal Perspect			
4	Allaryse area	s all	ected by cyberchi	ne and identify Legal Perspect	ives in cyber se	curn	.y.
				Unit-I			09 Hrs
Cyb Cyb		How	Criminals Plan	Them : How Criminals Pla imes, Botnets: The Fuel for			
				Unit – II			08 Hrs
Mot	oile/Cell Phone			or Mobile Devices, Authentic curity Implications for organiz			
Han		s, M	obile Devices: Se	curity Implications for organiz al Security Policies and Me	zations, Organiz	atio	nal Measures fo Computing Era
Han Lap	dling Mobile tops.	s, M devi	obile Devices: Sec ces, Organization	curity Implications for organiz al Security Policies and Me Unit –III	zations, Organiz easures in Mob	ation ile	nal Measures fo Computing Era
Han Lapt Too Pass Steg	dling Mobile tops. Is And Metho sword Cracking anography, Do	s, M devi ods g, oS ar	Used In Cyberc Keyloggers and DDoS Attacks,	curity Implications for organiz al Security Policies and Me Unit –III rime: Introduction, Proxy Se Spywares, Virus and Worm SQL Injection, Buffer Overfi	zations, Organiz easures in Mob ervers and Anc ns, Trojan Hor low, Attacks on	ation ile onym	nal Measures fo Computing Era 07 Hrs nizers, Phishing and Backdoors
Han Lapt Too Pass Steg Phis	dling Mobile tops. Is And Metho sword Cracking anography, Do shing and Iden	s, M devi ods g, oS ar itity	Used In Cyberc Keyloggers and DOS Attacks, Theft: Introductic	curity Implications for organiz al Security Policies and Me Unit –III rime: Introduction, Proxy Se Spywares, Virus and Worm SQL Injection, Buffer Overflon, Phishing, Identity Theft (III Unit –IV	zations, Organiz easures in Mob ervers and Anc ns, Trojan Hor low, Attacks on O Theft).	ation ile onym ses Win	nal Measures fo Computing Era 07 Hrs nizers, Phishing and Backdoors reless Networks 08 Hrs
Han Lapp Too Pass Steg Phis Und Fore Ana App Und Moc Con	dling Mobile tops. Is And Metho sword Cracking anography, Do shing and Iden lerstanding C ensics Science, lysis of E-Ma roaching a C erstanding the lel to Compute puter Forensic	s, M devi ods g, SS ar ntity The ail, 1 Comp Req er F cs fro	Used In Cyberc Keyloggers and ad DDoS Attacks, Theft: Introduction uter Forensics: Need for Comp Digital Forensics puter Forensics uter Forensics puter Forensics	curity Implications for organiz al Security Policies and Me Unit –III rime: Introduction, Proxy Se Spywares, Virus and Worm SQL Injection, Buffer Overflon, Phishing, Identity Theft (III Unit –IV Introduction, Historical Back uter Forensics, Cyber forensi Life Cycle, Chain of Cust Investigation, Setting up a ater Forensics and Steganogra ics and Social Networking S erspective, Challenges in Con- rensics.	zations, Organiz easures in Mob ervers and Anc ns, Trojan Hor low, Attacks on D Theft). ground of Cyb cs and Digital tody Concept, Computer Fo uphy, Relevance lites: The Secur	ation ile	nal Measures fo Computing Era 07 Hrs nizers, Phishing and Backdoors reless Networks 08 Hrs orensics, Digitate dence, Forensics ics Laboratory the OSI 7 Laye Privacy Threats pecial Tools and
Han Lapy Too Pass Steg Phis Und Fore Ana App Und Moc Con Tecl	dling Mobile tops. Is And Metho sword Cracking anography, Do shing and Iden lerstanding C ensics Science, lysis of E-Ma roaching a C erstanding the lel to Compute puter Forensic aniques, Forensic	s, M devi ods g, oS ar tity omp The ail, 1 Comp Req er F cs fro sics 2	Used In Cyberc Keyloggers and DOS Attacks, Theft: Introduction uter Forensics: e Need for Comp Digital Forensics uter Forensics uter Forensics outer Forensics outer Forensics outer Forensics outer Forensics uter Forensics buter Forensics	curity Implications for organiz al Security Policies and Me Unit –III rime: Introduction, Proxy Se Spywares, Virus and Worm SQL Injection, Buffer Overflon, Phishing, Identity Theft (III Unit –IV Introduction, Historical Back uter Forensics, Cyber forensi Life Cycle, Chain of Cust Investigation, Setting up a uter Forensics and Steganogra ics and Social Networking S erspective, Challenges in Con- rensics. Unit –V	zations, Organiz easures in Mob ervers and Anc ns, Trojan Hor low, Attacks on D Theft). ground of Cyb cs and Digital tody Concept, Computer Fo uphy, Relevance sites: The Secun nputer Forensic	ation ile onym ses Win er fr Evid Net rens of f rity/J s, Sp	nal Measures fo Computing Era 07 Hrs nizers, Phishing and Backdoors reless Networks 08 Hrs orensics, Digitat dence, Forensics ics Laboratory the OSI 7 Laye Privacy Threats occial Tools and 07 Hrs
Han Lapy Too Passs Steg Phis Und Fore Ana App Und Moc Con Tecl Cyb	dling Mobile tops. Is And Metho sword Cracking anography, Do shing and Iden lerstanding C ensics Science, lysis of E-Ma roaching a C erstanding the lel to Compute puter Forensic aniques, Forensic percrime And Indian Contex	s, M devi ods g, oS ar ntity omp The ail, 1 Comp Req er F cos fro sics 2 Cyb	Used In Cyberc Keyloggers and ad DDoS Attacks, Theft: Introduction uter Forensics: witer Forensics uter Forensics uter Forensics uter Forensics outer Forensics outer Forensics outer Forensics ensity, Forensics outer forensics for compliance P Auditing, Anti-for er Security: The the Indian IT Act	curity Implications for organiz al Security Policies and Me Unit –III rime: Introduction, Proxy Se Spywares, Virus and Worm SQL Injection, Buffer Overflon, Phishing, Identity Theft (III Unit –IV Introduction, Historical Back uter Forensics, Cyber forensi Life Cycle, Chain of Cust Investigation, Setting up a ater Forensics and Steganogra ics and Social Networking S erspective, Challenges in Con- rensics.	zations, Organiz easures in Mob ervers and Anc ns, Trojan Hor- low, Attacks on D Theft). ground of Cyb cs and Digital tody Concept, Computer Fo uphy, Relevance Sites: The Secur nputer Forensic	ation ile onym ses Win er fd Evid Net rens of p rity/J s, Sp Ve N	nal Measures fo Computing Era 07 Hrs nizers, Phishing and Backdoors reless Networks 08 Hrs orensics, Digita lence, Forensics ics Laboratory the OSI 7 Laye Privacy Threats pecial Tools and 07 Hrs eed Cyber laws cenario in India
Han Lapp Too Pass Steg Phis Tore Ana App Und Moc Con Tecl Cyb The Digi	dling Mobile tops. Is And Metho sword Cracking anography, Do shing and Iden lerstanding C ensics Science, lysis of E-Ma roaching a C erstanding the lel to Compute nputer Forensic miques, Forensic ercrime And C Indian Contex ital Signatures a	s, M devi ods g, oS ar tity omp The ail, 1 Comp Req er F cs fro sics A Cyb	Used In Cyberc Keyloggers and ad DDoS Attacks, Theft: Introduction uter Forensics: e Need for Comp Digital Forensics puter Forensics uirements, Comptorensics, Forensics on Compliance P Auditing, Anti-for er Security: The the Indian IT Act,	curity Implications for organiz al Security Policies and Me Unit –III rime: Introduction, Proxy Se Spywares, Virus and Worm SQL Injection, Buffer Overflon, Phishing, Identity Theft (III Unit –IV Introduction, Historical Back uter Forensics, Cyber forensi Life Cycle, Chain of Cust Investigation, Setting up a ater Forensics and Steganogra ics and Social Networking S erspective, Challenges in Con- rensics. Unit –V Legal Perspectives-Introduct c, Challenges to Indian Law Amendments to the Indian IT	zations, Organiz easures in Mob ervers and Anc as, Trojan Hor low, Attacks on D Theft). ground of Cyb cs and Digital tody Concept, Computer Fo aphy, Relevance Sites: The Secun nputer Forensic ion, Why Do W and Cybercrime Act, Cybercrime	ation ile onym ses Win er fd Evid Net rens of p rity/J s, Sp Ve N	nal Measures fo Computing Era 07 Hrs nizers, Phishing and Backdoors reless Networks 08 Hrs orensics, Digita lence, Forensics ics Laboratory the OSI 7 Laye Privacy Threats pecial Tools and 07 Hrs eed Cyber laws cenario in India
Han Lap Too Pass Steg Phis Und Fore Ana App Und Moc Con Tecl Digi	dling Mobile tops. Is And Metho sword Cracking anography, Do shing and Iden lerstanding C ensics Science, lysis of E-Ma roaching a C erstanding the lel to Compute puter Forensic miques, Forensic niques, Forensic aniques, Forensic stal Signatures a urse Outcomes	s, M devi ods g, oS ar tity omp The ail, 1 Comp er F cs fro sics 2 Cyb ct, T and t : Aft	Used In Cyberc Keyloggers and ad DDoS Attacks, Theft: Introduction witer Forensics: e Need for Comp Digital Forensics uirements, Computer Forensics outer Forensics outer Forensics outer Forensics e Need for Computer Digital Forensics outer Forensics outer Forensics outer Forensics outer Forensics the Indian IT Act, the Indian IT Act,	curity Implications for organiz al Security Policies and Me Unit –III rime: Introduction, Proxy Se Spywares, Virus and Worm SQL Injection, Buffer Overflon, Phishing, Identity Theft (III Unit –IV Introduction, Historical Back uter Forensics, Cyber forensi Life Cycle, Chain of Cust Investigation, Setting up a atter Forensics and Steganogra ics and Social Networking S erspective, Challenges in Con- rensics. Unit –V Legal Perspectives-Introduct c, Challenges to Indian Law Amendments to the Indian IT e course, the students will be	zations, Organiz easures in Mob ervers and Anc ns, Trojan Hor low, Attacks on D Theft). ground of Cyb cs and Digital tody Concept, Computer Fo phy, Relevance ites: The Secun nputer Forensic ion, Why Do W and Cybercrime Act, Cybercrime able to	ation ile onym ses Win er fd Evid Net rens of p rity/J s, Sp Ve N	nal Measures for Computing Era 07 Hrs nizers, Phishing and Backdoors reless Networks 08 Hrs orensics, Digitate dence, Forensics orensics, Digitate dence, Forensics ics Laboratory the OSI 7 Laye Privacy Threats opecial Tools an 07 Hrs eed Cyber laws cenario in India
Han Lapp Too Pass Steg Phis Tore Ana App Und Moc Con Tecl Cyb The Digi	dling Mobile tops. Is And Metho sword Cracking anography, Do shing and Iden Ierstanding C ensics Science, lysis of E-Ma roaching a C erstanding the lel to Compute nputer Forensic nniques, Forensic nniques, Forensic stal Signatures a irse Outcomes I: Interpret th	s, M devi ods g, oS ar tity omp The ail, 1 Comp Req er F S fro sics 2 Cyb ct, T and t : Aff ie ba	Used In Cyberc Keyloggers and ad DDoS Attacks, Theft: Introduction uter Forensics: e Need for Comp Digital Forensics uter Forensics uter Forensics uter Forensics outer Forensics uter Forensics en Compliance P Auditing, Anti-for er Security: The The Indian IT Act, the Indian IT Act,	curity Implications for organiz al Security Policies and Me Unit –III rime: Introduction, Proxy Se Spywares, Virus and Worm SQL Injection, Buffer Overflon, Phishing, Identity Theft (III Unit –IV Introduction, Historical Back uter Forensics, Cyber forensi Life Cycle, Chain of Cust Investigation, Setting up a ater Forensics and Steganogra ics and Social Networking S erspective, Challenges in Con- rensics. Unit –V Legal Perspectives-Introduct c, Challenges to Indian Law Amendments to the Indian IT	zations, Organiz easures in Mob ervers and Anc ns, Trojan Hor low, Attacks on D Theft). ground of Cyb cs and Digital tody Concept, Computer Fo phy, Relevance ites: The Secun nputer Forensic ion, Why Do W and Cybercrime Act, Cybercrime able to	ation ile onym ses Win er fd Evid Net rens of p rity/J s, Sp Ve N	nal Measures for Computing Era 07 Hrs nizers, Phishing and Backdoors reless Networks 08 Hrs orensics, Digitate dence, Forensics orensics, Digitate dence, Forensics ics Laboratory the OSI 7 Laye Privacy Threats opecial Tools an 07 Hrs eed Cyber laws cenario in India

CO4: Demonstrate through use of proper tools knowledge on the cyber security, Cybercrime and

	forensics								
Reference Books :									
1	Cyber Security: Understanding Cyber Crimes, Computer Forensics And Legal Perspectives, SunitBelapure and Nina Godbole, , Wiley India Pvt Ltd, ISBN: 978-81-265-21791, 2013.								
2	Introduction to information security and cyber laws, Dr. Surya Prakash Tripathi, Ritendra Goyal, Praveen Kumar Shukla, KLSI. Dreamtech Press, ISBN: 9789351194736, 2015.								
3	Cybersecurity: Managing Systems, Conducting Testing, and Investigating Intrusions, Thomas J. Mowbray, Copyright © 2014 by John Wiley & Sons, Inc, ISBN: 978 -1-118 84965 -1								
4	Cyber Forensics, Technical Publications, I. A. Dhotre, 1 st Edition, 2016, ISBN-13: 978- 9333211475								

CIE is executed by the way of Tests (T), Quizzes (Q),) and Experiential Learning (EL). Three tests are conducted for 50 marks each and the sum of the marks scored from three tests is reduced to 50. Minimum of three quizzes are conducted and each quiz is evaluated for 10 marks adding up to 30 marks. All quizzes are conducted online. Faculty may adopt innovative methods for conducting quizzes effectively. The number of quizzes may be more than three also. The marks component for experiential learning is 20. **Total CIE is 50 (T) +30 (Q) +20 (EL) = 100 Marks.**

Semester End Evaluation (SEE); Theory (100 Marks)

SEE for 100 marksis executed by means of an examination. The Question paper for the course contains two parts, Part - A and Part - B. Part - A consists of objective type questions for 20 marks covering the complete syllabus. Part - B consists of five main questions, one from each unit for 16 marks adding up to 80 marks. Each main question may have sub questions. The question from Units I, IV and V have no internal choice. Units II and III have internal choice in which both questions cover entire unit having same complexity in terms of COs and Bloom's taxonomy level.

	CO-PO Mapping											
CO/PO	PO1	PO2	PO3	PO4	PO5	PO6	PO7	PO8	PO9	PO10	PO11	PO12
CO1	2	2	-	-	-	-	-	-	3	1	-	-
CO2	1	2	-	2	2	-	-	2	2	3	1	2
CO3	2	3	-	2	2	2	-	2	3	2	-	-
CO4	3	2	3	2	3	1	-	2	3	2	1	1

			Semester:	VII			
		RO	BOTICS AND A				
	1	1	(Group H: Globa	r í			
Course Code	:	18G7H11		CIE	:	:	100 Marks
Credits: L:T:P	:	3:0:0		SEE	:	:	100 Marks
Total Hours	:	39 L		SEE Duration	n :	:	3.00 Hours
			tudents will be ab				
			tics and automation				
			programming and onfiguration and k	robotic operation control			
			<u> </u>	s and processing industri	20		
				ing and processing industry			
5 Development	01 0	utomuton syst		ing and processing indust	1105		
			Unit-I				06 Hrs
Introduction - Ba	sics	of kinematics,	Anatomy of robo	t, Robot configuration, R	obot jo	oir	nts, Sensors an
drive system, Cont	rol	modes, Specific		bot programming metho	ds.		
			Unit – II				09 Hrs
				Objects coordinate fram			
			rdinate transforma	tions, Joint variables and	positio	n	of end effector
Homogeneous tran			U matrix Direct l	inamatic and invaria and	unio of		longr and 2
DoF robots.	na	conventions, D.	n maurx, Direct k	inematic and inverse anal	lysis of	p	lallal allu 5
D01 1000t3.			Unit –III				10 Hrs
Trajectory plann	ning	g - Introduction		trajectory, Joint-space	versus		
		,		trajectory planning, Thi			-
polynomial trajecto						_	
				upport systems, Automati			
strategies, Levels o	of A	utomation, Proc	Unit –IV	nd Mathematical models,	Nume	ri	08 Hrs
Machina Vision -	Oh	iect recognition		features used for object	identifi	ics	
				uted Tomography (CT), I			
				e detection and Depth a			
		•	11 0, 0	ting, Image data compre		· · ·	00
domain techniques	, In	terframe coding	, Compression tec	hniques, Colour images,	Heuris	ti	es, Application
of vision systems							
			Unit –V				06 Hrs
				AS - concepts, integratio	n in th	e	data processing
systems, FMS sche		U			1 1 11	ı.	
Storage and retriev			ors - $AGVS - Inc$	lustrial robots in materia	i nandi	lin	g – Automate
U			Database Manager	nent System and their ap	nlicatio	n	s in CAD/CAN
and FMS – distribu					Privatic	/11	
				tudents will be able to			
CO1: Understand	d th	e characteristics	and working prin	ciple of robots.			

CO2:	Apply the related mathematical model to formulate the kinematics and trajectory planning of industrial robot.
CO3:	Analyse the machine vision for effective Flexible Manufacturing Systems.

CO4: Develop model and integrate drives for industrial robots and automation systems.

Refer	rence Books
1	A Robot Engineering Textbook, Mohsen Shahinpoor, Harper& Row Publishers, 3 rd Edition, New York, ISBN:006045931X
2	Introduction to Robotics, John J. Craig, Pearson Education International, 3 rd Edition, ISBN:109876543, 1-13-123629-6
3	Automation, Production Systems, and Computer-integrated Manufacturing, Mikell P Groover, Pearson Publishing, 3 rd Edition, 2014, ISBN 978 81 203 3418 2
4	Flexible Manufacturing Systems in Practice Design: Analysis and Simulation, Joseph Talavage CRC Press, 1987, ISBN 9780824777180

CIE is executed by way of quizzes (Q), tests (T) and experiential learning (EL). A minimum of three quizzes are conducted and each quiz is evaluated for 10 marks adding up to 30 marks. All quizzes are conducted online. Faculty may adopt innovative methods for conducting quizzes effectively. The number of quizzes may be more than three also. The three tests are conducted for 50 marks each and the sum of the marks scored from three tests is reduced to 50. The marks component for experiential learning is 20. **Total CIE is 30(Q) + 50(T) + 20(EL) = 100 Marks.**

Semester End Evaluation (SEE); Theory (100 Marks)

SEE for 100 marksis executed by means of an examination. The Question paper for the course contains two parts, Part – A and Part – B. Part – A consists of objective type questions for 20 marks covering the complete syllabus. Part – B consists of five main questions, one from each unit for 16 marks adding up to 80 marks. Each main question may have sub questions. The question from Units I, IV and V have no internal choice. Units II and III have internal choice in which both questions cover entire unit having same complexity in terms of COs and Bloom's taxonomy level.

	CO-PO Mapping											
CO/PO	PO1	PO2	PO3	PO4	PO5	PO6	PO7	PO8	PO9	PO10	PO11	PO12
CO1	2	-	1	-	-	1	-	-	-	2	-	2
CO2	3	3	1	3	1	1	-	-	-	2	-	2
CO3	2	-	2	-	1	1	-	-	2	-	-	2
CO4	3	3	2	3	1	1	-	2	3	-	3	2

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			Sem	ester: VII		
				GY AND APPLICATIONS		
~	~ .	-		LOBAL ELECTIVE)		
Cou	irse Code	:	18G7H12	CIE	:	100 Marks
Cre	dits: L:T:P	:	3:0:0	SEE	:	100 Marks
Tot	al Hours	:	39 L	SEE Duration	:	3.00 Hours
Cou	rse Learning (Dbje	ctives: The students will	be able to		
1	Define the ear concepts.	rth	environment and its behav	viour, launching vehicles for satel	lites	s and its associated
2	Analyse satell	ites	in terms of technology, stru	acture and communications.		
3	Use satellites	for s	pace applications, remote s	sensing and metrology.		
4	Apply the space	ce te	chnology, technology miss	ion and advanced space systems to	nat	ion's growth.
			UNIT	-I		08 Hrs

	00 111 5								
Earth's environment: Atmosphere, ionosphere, Magnetosphere, Van Allen Radiativ Interplanetary medium, Solar wind, Solar- Earth Weather Relations.	on belts,								
Launch Vehicles: Rocketry, Propellants, Propulsion, Combustion, Solid, Liquid and Cryogenic engines,									
Control and Guidance system, Ion propulsion and Nuclear Propulsion.									
Control and Suldance system, for propulsion and reacted riopulsion.									
UNIT-II	07 Hrs								
Satellite Technology: Structural, Mechanical, Thermal, Power control, Telemetry, Teleco	omm and								
Quality and Reliability, Payloads, Classification of satellites.									
Satellite structure: Satellite Communications, Transponders, Satellite antennas.									
UNIT-III	08 Hrs								
Satellite Communications: LEO, MEO and GEO orbits, Altitude and orbit controls, Multipl	e Access								
Techniques.									
Space applications: Telephony, V-SAT, DBS system, Satellite Radio and TV, Tele-Education	on. Tele-								
medicine, Satellite navigation, GPS.)								
UNIT-IV	08 Hrs								
Remote Sensing: Visual bands, Agricultural, Crop vegetation, Forestry, water Resources, Land u									
mapping, geology, Urban development resource Management, and image processing techniques.	ise, Lanu								
Metrology: Weather forecast (Long term and Short term), weather modelling, Cyclone predictions,									
	edictions,								
Disaster and flood warning, rainfall predictions using satellites.									
Disaster and flood warning, rainfall predictions using satellites. UNIT-V	edictions, 08Hrs								
	08Hrs								
UNIT-V Space Missions: Technology missions, deep space planetary missions, Lunar missions, zero	08Hrs								
UNIT-V Space Missions: Technology missions, deep space planetary missions, Lunar missions, zero experiments, space biology and International space Missions.	08Hrs o gravity								
UNIT-V Space Missions: Technology missions, deep space planetary missions, Lunar missions, zero	08Hrs gravity								

Cours	Course Outcomes: After completing the course, the students will be able to									
CO1	Explain different types of satellites, orbit and associated subsystems.									
CO2	Apply the basics of launching vehicles, satellites and sub systems for space applications.									
CO3	Analyze the applications of satellite in the area of communication, remote sensing, metrology etc.									
CO4	Study technology trends, satellite missions and advanced space systems.									

Refe	Reference Books									
1	Atmosphere, weather and climate, R G Barry, Routledgepublications, 2009, ISBN- 10 :0415465702.									
2	Fundamentals of Satellite Communication, K N Raja Rao, PHI, 2012, ISBN: 9788120324015.									
3	Satellite Communication, Timothy pratt, John Wiley, 1986 ISBN: 978-0-471-37007 -9, ISBN 10: 047137007X.									
4	Remote sensing and applications, B C Panda, VIVA books Pvt. Ltd., 2009, ISBN: 108176496308.									

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CO/PO	PO1	PO2	PO3	PO4	PO5	PO6	PO7	PO8	PO9	PO10	PO11	PO12
CO1	2	1	-	-	-	-	-	-	-	-	1	-
CO2	2	2	1	1	-	-	-	-	-	-	1	-
CO3	2	2	1	-	-	-	-	-	-	-	1	-
CO4	2	2	1	-	-	-	-	-	-	-	1	-

				Semester: VII			
	INTRODUCTION TO ASTROPHYSICS						
	(Group H: Global Elective)						
	ourse Code	:	18G7H13		CIE	:	100 Marks
C	Credits: L: T:P : 3:0:0 SEE : 100 Marks						100 Marks
To	Total Hours:39 LSEE Duration:3.00 Hours						
C				students will be able to			
1				stial bodies and the laws gov			
2				cepts of relativity and establish			
3				fy and investigate the nature			
4				ures of any star by understand		pert	ies
5	Contemplate th	ne c	omplex system	n of the milky way galaxy and	1 its components		
				¥7. •/ ¥			07.11
E.	ndomental con		ta in Aatmono	Unit-I			07 Hrs
	ndamental con	-		ny: nstituents of the universe,	Cosmic Microway	D	Padiation (CMP)
	•			Retrograde Motion of planet			· · · · · · · · · · · · · · · · · · ·
				estial Sphere: Altitude-Azi			
	· · · · · · · · · · · · · · · · · · ·			anets - laws of motion of plan		-	, 1
0	ordinate System	, 50	fai System, 1	Unit – II	iets, inner planets, v	Juic	08 Hrs
Th	eory of Special	Re	lativity				00 1113
Tiı	ne & Space in S	Spec	ial Relativity,	of Galilean Transformations Momentum & Energy in Reple, the principle of minima	lativity, Doppler Ef	fect	for light (Red &
				t Cone diagram).	8		6,
				Unit –III			08 Hrs
Bla cyc De Sci	cle of stars (Bir termination using	on, C th, 1 ng ` e-de	Life & Death) Visual Binario pendent and	ween Color and Temperature , Hertzsprung-Russel Diagra es, Eclipsing Spectroscopic independent equations, Boltz	m, Classification o Binaries, Formatio	f Bi n o	nary Stars, Mass f Spectral Lines,
				Unit –IV			08 Hrs
Di He Sp De	Light and Matter: Dispersion of light (Prism & Grating), Spectral Lines, de-Broglie's Wavelength and Frequency, Heisenberg's Uncertainty Principle, Broadening of Spectral lines Spectral Characterization of Stars: Description of the Radiation Field, Stellar Opacity, Transfer Equation, Profile of Spectral Lines, Optical Telescopes, Radio Telescopes (Case Studies)						
	Unit –V 08 Hrs						
Th Ex Co	trasolar planets,	alax Me	thods of dete	the Stars, Historical Models, ction of extrasolar planets, D of Galaxies, Introduction to	istance to the Gala	ctic	Centre, Galactic

Course	Course Outcomes: After completing the course, the students will be able to					
CO1:	Contemplate the nature of our universe by identifying and studying the behavior of celestial					
	bodies.					
CO2:	Explain the usefulness of the theory of relativity, light and matter in establishing the fundamental					
	behavior of stellar bodies.					
CO3:	Utilize various techniques to discover the components of our universe and conclude their celestial					
	properties.					
CO4:	Interpret the spectral properties of any astronomical body to illustrate its properties.Inspect the					
	milky way galaxy to identify the proponents and their characteristic features.					

Refere	ence Books
1	Carroll Bradley W, and Dale A Ostlie, An Introduction to Modern Astrophysics. Reading, 2 nd
1	Edition, 1995, MA: Addison-Wesley Pub, ISBN: 9780201547306.
2	Padmanabhan, T, Theoretical Astrophysics, Vols.1-3, 2005, Cambridge University Press, ISBN-
2	9780521016278.
3	Shu F, The Physical Universe, New Edition, 1982, University of California, ISBN- 978-
5	0935702057.
4	Harwit M, Astrophysical Concepts, 3rd Edition, 2000, Springer-verlag, ISBN- 978-0387949437.
5	Shapiro, Stuart L, and Saul A Teukolsky, Black Holes, White Dwarfs, and Neutron Stars, 1st
5	Edition, 1983, Wiley, ISBN: 9780471873167.

CIE is executed by way of quizzes (Q), tests (T) and Assignment/Presentation/Project (A). A minimum of three quizzes are conducted and each quiz is evaluated for 10 marks adding up to 30 marks. All quizzes are conducted online. Faculty may adopt innovative methods for conducting quizzes effectively. The number of quizzes may be more than three also. The three tests are conducted for 50 marks each and the sum of the marks scored from three tests is reduced to 50. The marks component for Assignment/Presentation/Project 20.

Total CIE is 30(Q) +50(T) +20(A) =100 Marks.

Semester End Evaluation (SEE); Theory (100 Marks)

SEE for 100 marks is executed by means of an examination. The Question paper for the course contains two parts, Part – A and Part – B. Part – A consists of objective type questions for 20 marks covering the complete syllabus. Part – B consists of five main questions, one from each unit for 16 marks adding up to 80 marks. Each main question may have sub questions. The question from Units I, IV and V have no internal choice. Units II and III have internal choice in which both questions cover entire unit having same complexity in terms of COs and Bloom's taxonomy level.

	CO-PO Mapping											
CO/PO	PO1	PO2	PO3	PO4	PO5	PO6	PO7	PO8	PO9	PO10	PO11	PO12
CO1	3	3	1	2	-	-	1	-	1	-	-	2
CO2	3	2	2	2	-	-	1	-	1	-	-	2
CO3	2	3	1	2	2	1	1	-	2	1	-	2
CO4	3	3	1	2	2	1	2	-	3	3	-	2

			Semeste	er: VII					
МАТ	ERL	ALS FOR	ADVANCED TEC		AND SPECTR	OS	COPI	С	
CHARACTERIZATION (Group H: Global Elective)									
							Course Code	:	18G7H14
Credits: L:T:P	:	3:0:0			SEE	:	100	Marks	
Total Hours	_	40L			SEE Duration	:	3.00	Hours	
			e students will be ab						
			hemistry to develop		aterials for high	-tech	appli	cations in th	
area of Engine		-					"PP"		
2			e different fields of	f material ch	emistry so as to a	apply	y it to	the problem	
in engineering		•			5	11.		1	
			es of students so that	at they can c	haracterize, trans	sforn	n and	use material	
			ledge gained in solv						
			Unit-I					08 Hrs	
Coating and pac	kagii	ng material	S						
Surface Coating	mate	erials:							
			ymer coating mater			Polyv	vinyl o	chloride & it	
1 2		,	oly ethylene-HDPE,	LDPE, Poly	urethane.				
Properties require		10							
					chromate pigme	ents,	moly	bdate orange	
-		rine blue, ir	Inorganic pigments-titanium dioxide, zinc oxide, carbon black, chromate pigments, molybdate orange, chrome green, ultramarine blue, iron blue, cadmium red.						
Corrosion inhibiting pigments- zinc phosphate, zinc and barium chromate pigments, ceramic pigments,									
		pigments-			n chromate pigm	ents	cerar	nic pigments	
metal flake pigme	ents, e	pigments- : extenders.	zinc phosphate, zind	c and bariun					
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Ion exchange resins-Introduction, Types-cation and anion exchange resins, examples, physical properties, chemical properties-capacity, swelling, kinetics, stability, ion exchange equilibrium, regeneration. Applications of ion exchange resins-softening of water, demineralization of water, advantages and disadvantages of ion exchange resins-calcium sulphate fouling, iron fouling, adsorption of organic matter, bacterial contamination. Ion exchange membranes, Types-anion and cation exchange membranes. Classification of ion exchange membranes based on connection way between charged groups and polymeric matrix-homogeneous and heterogeneous ion exchange membranes, examples. Fabrication of ion exchange cottons- anion exchange cotton and cation exchange cotton. Application of ion exchange membranes in purification of water by electro dialysis method.

Unit –IV	08 Hrs

Spectroscopic Characterization of materials:

Electromagnetic radiation, interaction of materials with electromagnetic radiation.

UV- visible spectrophotometry: **Introduction**-Electronic transitions- factors influencing position and intensity of absorption bands-absorption spectra of dienes, polyene and α , β -unsaturated carbonyl compounds, Working of UV-Vis spectrophotometer, Theoretical calculation of λ_{max} by using Woodward-Fieser rules- for cyclic and α , β -unsaturated carbonyl compounds.

IR Spectroscopy: Introduction, principle, molecular vibrations, vibrational frequency, number of fundamental vibrations, factors influencing fundamental vibrations, instrumentation of IR spectrophotometer, sampling techniques, application of IR spectroscopy in characterization of functional groups.

Unit –V

NMR spectroscopy:

H¹ NMR Spectroscopy: Basic concepts- relaxation process. NMR spectrometer-FT NMR-Solvents used in NMR, internal standards-Chemical equivalence -Integrals and Integrations- chemical shift-Factors affecting chemical shifts- shielding and deshielding effects – chemical and magnetic equivalent –magnetic anisotropy-spin-spin splitting rules- Application of NMR on various compounds such as alkanes, alkenes, alkynes, alkyl halides, alcohols, ethers, amines, aldehydes, ketones, carboxylic acids, esters, amides & mono substituted aromatic compounds. Problems on prediction of structure of compounds. Application of NMR in magnetic resonance imaging (MRI).

Course	Course Outcomes: After completing the course, the students will be able to					
CO1:	Identify sustainable engineering materials and understand their properties.					
CO2:	Apply the basic concepts of chemistry to develop futuristic materials for high-tech applications in					
	different areas of engineering.					
CO3:	Analyze and evaluate the specific application of materials.					
CO4:	Design the route for synthesis of material and its characterization.					

Refer	ence Books
1	Materials Science by G.K.Narula, K.S.Narula&V.K.Gupta. 38thEdtion, Tata McGraw-Hill
1	Publishing Company Limited-2015, ISBN: 9780074517963
2	Solar Lighting by Ramachandra Pode and Boucar Diouf, Springer e-book, 2011, ISBN: 978-1-
2	4471-2133-6 (Print) 978-1-4471-2134-3 (Online).
2	Spectroscopy of organic compounds by P.S.Kalsi, New Age International (P) ltd, Publisher,
3	2005, ISBN 13: 9788122415438
4	Food Packaging Materials. Mahadeviah M & Gowramma RV, Tata McGraw Hill Publishing
4	Company Limited, 1996, ISBN :0074622382 9780074622384.

08 Hrs

CIE is executed by way of quizzes (Q), tests (T) and experiential learning (EL). A minimum of three quizzes are conducted and each quiz is evaluated for 10 marks adding up to 30 marks. All quizzes are conducted online. Faculty may adopt innovative methods for conducting quizzes effectively. The number of quizzes may be more than three also. The three tests are conducted for 50 marks each and the sum of the marks scored from three tests is reduced to 50. The marks component for experiential learning is 20. Total CIE is 30(Q) + 50(T) + 20(EL) = 100 Marks.

Semester End Evaluation (SEE); Theory (100 Marks)

SEE for 100 marksis executed by means of an examination. The Question paper for the course contains two parts, Part – A and Part – B. Part – A consists of objective type questions for 20 marks covering the complete syllabus. Part – B consists of five main questions, one from each unit for 16 marks adding up to 80 marks. Each main question may have sub questions. The question from Units I, IV and V have no internal choice. Units II and III have internal choice in which both questions cover entire unit having same complexity in terms of COs and Bloom's taxonomy level.

	CO-PO Mapping											
CO/PO	PO1	PO2	PO3	PO4	PO5	PO6	PO7	PO8	PO9	PO10	PO11	PO12
CO1	3	-	-	-	-	-	-	-	-	-	-	-
CO2	3	-	-	-	-	2	2	-	-	1	-	-
CO3	-	3	-	2	-	-	-	-	-	-	-	-
CO4	-	-	3	-	-	1	1	-	-	-	-	1

RV College of E	Engineering® –	Bengaluru - 59
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Somestory VII							
	Semester: VII APPLIED PSYCHOLOGY FOR ENGINEERS						
(Group H: Global Elective)							
Course	e Code	:	18G7H15		CIE	:	100 Marks
	s: L:T:P	:	3:0:0		SEE	:	100 Marks
Total I		:	39 L		SEE Duration	:	3.00 Hours
		Ob		tudents will be able to			1
1	0			ior and human mind in the	e context of learner	's in	nmediate society
	and enviro	nm	ent.				
2			-	ce of lifelong learning and	-	y to	sustain personal
				nt as the nature of work evo			
3				nowledge and skills for bu	uilding firm founda	ation	for the suitable
4	engineerin			on as effective Engineering	Davahala zista in	Ind	ustrial
4			l or consulting		; r sychologists in af	1 1110	usulal,
5			0	ychological knowledge, skil	lls, and values in oc	cupa	tional pursuits in
U				t personal goals and societa		oupu	formar parsants in
	v		0	1 0			
				Unit-I			07 Hrs
Intellig Theorie Types	ence and A s of Intellig	pti genceasu	e – Spearman	Unit – II and definition of Intelliger , Thurston, Guilford Verno elligence and Aptitude, Co	on. Characteristics of	of I	ntelligence tests,
Intellige	ence – Fluid	an	d Crystallized 1				0.0 11
D			1.1.0	Unit –III	<u> </u>	1	09 Hrs
Personality : Concept and definition of personality, Approaches of personality- psychoanalytical, Socio- Cultural, Interpersonal and developmental, Humanistic, Behaviorist, Trait and type approaches. Assessment of Personality: Self- report measures of Personality, Questionnaires, Rating Scales and Projective techniques, its Characteristics, advantages & limitations, examples. Behavioral Assessment. Psychological Stress: a. Stress- Definition, Symptoms of Stress, Extreme products of stress v sBurnout, Work Place Trauma. Causes of Stress – Job related causes of stress. Sources of Frustration, Stress and Job Performance, Stress Vulnerability-Stressthreshold,perceivedcontrol							
	, 0			Unit –IV			07 Hrs
the role in the develop	of psychol field of Ir ments in Ir	ogis nfor nfor	st in the organi mation Technor mation Technor	ing Environment: The pre- zation, Selection and Train ology. Distance learning, ology. Type A and Type Directed, Participative Cour	ing of Psychology Psychological cor B Psychological C	Profe isequ	ation technology, essionals to work ences of recent eling - Need for
				Unit –V			07 Hrs
Learni	ng: Definiti	on,	Conditioning -	- Classical Conditioning, B	asics of Classical C	ondi	tioning (Pavlov),

Learning: Definition, Conditioning – Classical Conditioning, Basics of Classical Conditioning (Pavlov), the process of Extinction, Discrimination and Generalization. Operant Conditioning (Skinner expt). The basics of operant conditioning, Schedules of reinforcement. Cognitive – Social approaches to learning – Latent Learning, Observational Learning, Trial and Error Method, Insightful Learning.

Course	Course Outcomes: After completing the course, the students will be able to					
CO1:	Understand the application of psychology in engineering and technology and develop a route to					
	accomplish goals in their work environment.					
CO2:	Define learning and compare the factors that cognitive, behavioral, and Humanistic					
	theorists believe influence the learning process.					
CO3:	Develop understanding of psychological attributes such as intelligence, aptitude, creativity, resulting in their enhancement and apply effective strategies for self-management and self-improvement.					
CO4:						

Refer	Reference Books						
1	Understanding Psychology Feldman R. S, IV edition, (1996) McGraw Hill India						
2	Psychology Robert A. Baron, III edition (1995) Prentice Hall India.						
3	Organizational Behaviour, Stephen P Robbins Pearson Education Publications, 13 th Edition, ISBN - 81-317 - 1132 - 3						
4	OrganisationalBehaviour: Human Behaviour at Work, JohnW.Newstrem and Keith Davis. Tata McGraw Hill India, 10th Edition, ISBN 0-07-046504-5						

CIE is executed by way of quizzes (Q), tests (T) and experiential learning (EL). A minimum of three quizzes are conducted and each quiz is evaluated for 10 marks adding up to 30 marks. All quizzes are conducted online. Faculty may adopt innovative methods for conducting quizzes effectively. The number of quizzes may be more than three also. The three tests are conducted for 50 marks each and the sum of the marks scored from three tests is reduced to 50. The marks component for experiential learning is 20. **Total CIE is 30(Q) + 50(T) + 20(EL) = 100 Marks.**

Semester End Evaluation (SEE); Theory (100 Marks)

SEE for 100 marksis executed by means of an examination. The Question paper for the course contains two parts, Part – A and Part – B. Part – A consists of objective type questions for 20 marks covering the complete syllabus. Part – B consists of five main questions, one from each unit for 16 marks adding up to 80 marks. Each main question may have sub questions. The question from Units I, IV and V have no internal choice. Units II and III have internal choice in which both questions cover entire unit having same complexity in terms of COs and Bloom's taxonomy level.

	CO-PO Mapping											
CO/PO	PO1	PO2	PO3	PO4	PO5	PO6	PO7	PO8	PO9	PO10	PO11	PO12
CO1	3	2	-	-	-	-	-	-	-	1	-	1
CO2	3	2	2	1	-	-	-	-	-	1	-	1
CO3	3	3	2	2	-	-	-	-	-	1	-	1
CO4	3	3	3	3	-	-	-	-	-	1	-	1

		ADVANCED	Semester: VI				
			COURSE IN ENT (Group H: Global E		NEUKSHIP		
Course Code	:	18G7H16			CIE	:	100 Marks
Credits: L:T:P	:	3:0:0		S	EE	:	100 Marks
Total Hours	:	39 L		S	EE Duration	:	3.00 Hours
Course Learning C	bjec	tives: The studer	nts will be able to	•			
1 Acquire addition	nal kn	owledge and ski	lls for developing ea	rly custome	er traction into a	a repe	atable business
			eving sustainable gro			heir p	product or servi
			trategy, making a sal			t	autuan ala
			ital presence, Develo				
e	media	a to reach new ci	ustomers cost effecti	vely, Devel	lop strategies to	o incre	ease revenues a
expand markets							
TT •4 T							
							07 11
	d	ata 8 Malas Da	···· D'·····	XX 71	4 - 1 41	1 D	07 Hrs
Intro to building P			pposition: Diagnose:	Where are	you today on t	he Pro	
Assess your Start-u	o's att	ractiveness					oduct Life Cycl
Intro to building P Assess your Start-uj Competition & tes	o's att	ractiveness	pposition: Diagnose: petition Analysis Ider				oduct Life Cycl ge
Intro to building P Assess your Start-uj Competition & tes Unit – II	o's att t ing :	ractiveness Conduct a Comp	petition Analysis Ider	ntify your C	Competitive Adv	vantaş	oduct Life Cycl ge 06 Hrs
Intro to building P Assess your Start-uj Competition & tes Unit – II Market Validation	o's att t ing : : Mar	ractiveness Conduct a Comp ket validation, C	petition Analysis Ider	ntify your C	Competitive Adv Analyzing Custo	vantag	oduct Life Cycl ge 06 Hrs feedback
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Intro to building P Assess your Start-uj Competition & tes Unit – II Market Validation Delivering Value: 1 Unit –III	o's att t ing : : Mar Enlist	ractiveness Conduct a Comp ket validation, C marketing chann	petition Analysis Ider Customer Usability Ir nels, Identify partner	ntify your C nterviews, A s for your v	Competitive Adv Analyzing Custo venture, Create	vantaş omer : a Sale	oduct Life Cycl ge 6eedback es plan 07 Hrs
Intro to building P Assess your Start-uj Competition & tes Unit – II Market Validation Delivering Value: 1 Unit –III Customer acquis	o's att ting: : Mar Enlist ition	ractiveness Conduct a Comp ket validation, C marketing cham & growth	Detition Analysis Ider Customer Usability Ir nels, Identify partner channels: Types	ntify your C nterviews, A s for your v of Mar	Competitive Adv Analyzing Custo venture, Create	vantag omer : a Sale nels:	oduct Life Cycl ge feedback es plan 07 Hrs TargetingBlog
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Intro to building P Assess your Start-up Competition & tes Unit – II Market Validation Delivering Value: 1 Unit –III Customer acquis UnconventionalPR, ads,displayadsander	o's att ting: (: Mar Enlist ition	ractiveness <u>Conduct a Comp</u> ket validation, C marketing chann & growth Search Er gplatforms,	Detition Analysis Ider Customer Usability Ir nels, Identify partner channels: Types ngineMarketing, EmailMarketing,	ntify your C nterviews, A s for your v of Mar Search Vira	Competitive Adv Analyzing Custo venture, Create	vantaş omer : a Sale nels: imiza	oduct Life Cycl ge feedback es plan 07 Hrs TargetingBlog
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Intro to building P Assess your Start-uj Competition & test Unit – II Market Validation Delivering Value: 1 Unit –III Customer acquis UnconventionalPR, ads,displayadsandez Magazines,Newspaj Unit –IV Business model: Re Financial Planning Unit –V	o's att ting: : Mar Enlist ition disting cor,Ra eiterat g: For	ractiveness <u>Conduct a Comp</u> ket validation, C marketing chann & growth Search Er gplatforms, adioandTVads, C teandRefineyour ecastingsalesand	betition Analysis Ider Customer Usability Ir nels, Identify partner channels: Types ngineMarketing, EmailMarketing, DfflineAds, TradeSho BusinessModelCanv Irevenueprojections,	ntify your C nterviews, A s for your v of Mar Search Vira ows as, Choose Cash-flows	Competitive Adv Analyzing Custoventure, Create execting Channer EngineOpt IMarketing, therightbusiness statement	omer : a Sale nels: imiza	oduct Life Cycl ge feedback es plan 07 Hrs TargetingBlog tion, Soci Affiliateprogram
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Course	Course Outcomes: After completing the course, the students will be able to					
CO1:	Develop strategies to increase revenues and expand markets, Explore licensing and franchising for					
	business expansion.					
CO2:	Leverage technologies and platforms for growth stage companies, Develop key metrics to track					
	progress.					
CO3:	Basics of registering a company, Understanding business regulations and compliances.					
CO4:	Advanced concepts of business finance, Financial planning.					

Refer	rence Books
1	Running Lean: Iterate from Plan A to a Plan That Works. O'Reilly Media, Maurya, A., 2012.
2	Entrepreneurship. Roy, R., 2012. Oxford University Press
3	Intellectual Property Law in India. Gupta, T. S., 2011. Kluwer Law International
4	Flow: The Psychology of Optimal Experience. Czikszentmihalyi, M., 2008. Harper Perennial Modern Classics

CIE is executed by way of tests (T) and Milestones (M). A minimum of four milestone submission have to be submitted and first three milestones (M1, M2, M3) are evaluated for 10 marks adding up to 30 marks and the final milestone (M4) is evaluated for 20 marks. All milestone submissions are online and as per format and portal prescribed by Wadhwani foundations. Faculty may adopt innovative methods for conducting quizzes effectively. The three tests are conducted for 50 marks each and the sum of the marks scored from three tests is reduced to 50. The marks component for experiential learning is 20.

Total CIE is 30(M1, M2 and M3) +50(T) +20(M4) =100 Marks.

Semester End Evaluation (SEE); Theory (100 Marks)

SEE for 100 marksis executed by means of an examination. The Question paper for the course contains two parts, Part – A and Part – B. Part – A consists of objective type questions for 20 marks covering the complete syllabus. Part – B consists of five main questions, one from each unit for 16 marks adding up to 80 marks. Each main question may have sub questions. The question from Units I, IV and V have no internal choice. Units II and III have internal choice in which both questions cover entire unit having same complexity in terms of COs and Bloom's taxonomy level.

	CO-PO Mapping											
CO/PO	PO1	PO2	PO3	PO4	PO5	PO6	PO7	PO8	PO9	PO10	PO11	PO12
CO1	3	2	-	-	-	-	-	-	-	1	-	1
CO2	3	2	2	1	-	-	-	-	-	1	-	1
CO3	3	3	2	2	-	-	-	-	-	1	-	1
CO4	3	3	3	3	-	-	-	-	-	1	-	1

	Semester VIII						
	MAJOR PROJECT						
Cours	se Code	:	18ECP81		CIE	:	100 Marks
Credi	its: L:T:P	••	0:0:16		SEE	:	100 Marks
Total	Hours	:	32		SEE Duration	:	3.00 Hours
Cours	se Learning Ob	jec	tives: The s	udents will be able to			1
1.	Acquire the a	bili	ty to make li	nks across different areas of	knowledge and t	o gei	nerate, develop
	and evaluate i	dea	s and inform	ation so as to apply these skil	ls to the project t	ask.	
2.	Acquire the skills to communicate effectively and to present ideas clearly and coherently to a						coherently to a
	specific audience in both written and oral forms.						
3.	3. Acquire collaborative skills through working in a team to achieve common goals.						
4.	Self-learn, ref	lect	on their lear	ning and take appropriate acti	ion to improve it.		
5.	Prepare sched	ules	s and budget	s and keep track of the progre	ss and expenditu	re.	

Major Project Guidelines:

- 1. The project topic, title and synopsis have to be finalized and submitted to their respective internal guide(s) before the beginning of the 8th semester.
- 2. The detailed Synopsis (approved by the department *Project Review Committee*) has to be submitted during the 1st week after the commencement of 8th semester.

Batch Formation:

- > Students are free to choose their project partners from within the program or any other program.
- Each student in the team must contribute towards the successful completion of the project. The project may be carried out In-house / Industry / R & D Institution.
- The project work is to be carried out by a team of two to four students, in exceptional cases where a student is placed in a company and offered an internship through the competitive process or student is selected for internship at national or international level through competitive process, the student can work independently.
- The students are allowed to do either a project for full 5 days in the industry or full 5 days in the college.
- In case the project work is carried out outside Bengaluru, such students must be available during Project Evaluation process scheduled by the respective departments and they must also interact with their guide regularly through Email / Webinar / Skype etc.

Project Topic Selection:

The topics of the project work must be in the *field of respective program areas or in line with* CoE's(Centre of Excellence) identified by the college or List of project areas as given by industry/Faculty. The projects as far as possible should have societal relevance with focus on sustainability.

Students can select courses in *NPTEL* from the discipline of *Humanities and Social Sciences, Management, Multidisciplinary and Design Engineering.* The course chosen could be either of *4w/8w/12w* duration. The students need to enrol for a course, register for the exam and submit the ecertificate to the department, as and when it is released by NPTEL. *The same will be considered as one of the components during project evaluation of phase 2 and phase 5.*

Project Evaluation:

Continuous monitoring of project work will be carried out and cumulative evaluation will be done.

- > The students are required to meet their internal guides once in a week to report their progress in project work.
- Weekly Activity Report (WAR) has to be maintained in the form of a diary by the project batch and the same has to be discussed with the Internal Guide regularly.
- In case of *Industry project*, during the course of project work, the internal guides will have continuous interaction with external guides and will visit the industry at least twice during the project period.
- For CIE assessment the project groups must give a final seminar with the draft copy of the project report.
- The presentation by each group will be for 20-30 minutes and every member of the team needs to justify the contributions to the project.
- The project team is required to submit Hard copies of the detailed Project Report in the prescribed format to the department.
- For CIE 50% weightage should be given to the project guide and 50% weightage to the project evaluation committee.
- Before the final evaluations the project group is required to produce a No dues certificate from Industry, Central Library and Department.

Cours	se Outcomes of Major Project:
1	Apply knowledge of mathematics, science and engineering to solve respective engineering
	domain problems.
2	Design, develop, present and document innovative/multidisciplinary modules for a complete
	engineering system.
3	Use modern engineering tools, software and equipment to solve problem and engage in life-long
	learning to follow technological developments.
4	Function effectively as an individual, or leader in diverse teams, with the understanding of
	professional ethics and responsibilities.

CIE Assessment:

The following are the weightings given for the various stages of the project.

1.	Selection of the topic and formulation of objectives	10%
2.	Design and Development of Project methodology	25%
3.	Execution of Project	25%
4.	Presentation, Demonstration and Results Discussion	30%
5.	Report Writing & Publication	10%
	1 0	

SEE Assessment:

The following are the weightages given during Viva Examination.

1. Written presentation of synopsis10%2. Presentation/Demonstration of the project30%3. Methodology and Experimental Results & Discussion30%4. Report10%5. Viva Voce20%

Calendar of Events for the Project Work:

Week	Event
Beginning of 7 th Semester	Formation of group and approval by the department committee.
7 th Semester	Problem selection and literature survey
Last two weeks of 7 th	Finalization of project and guide allotment
Semester	

II Week of 8 th Semester	Synopsis submission and preliminary seminar
III Week	First visit of the internal guides to industry (In case of project being
	carried out in industry)
III to VI Week	Design and development of project methodology
VII to IX Week	Implementation of the project
X Week	Submission of draft copy of the project report
XI and XII Week	Second visit by guide to industry for demonstration. Final seminar
	by Department project Committee and guide for internal assessment.
	Finalization of CIE.

Evaluation Scheme for CIE and SEE

Scheme of Evaluation for CIE		Scheme of Evaluation for SEE	
Particulars	%Marks	Particulars	%Marks
Project Evaluation I	10%	Project Synopsis (Initial Write up)	10%
Project Evaluation II	25%	Project Demo / Presentation	30%
Project Evaluation III	25%	Methodology and Results Discussion	30%
Project Evaluation Phase-IV (Submission of Draft Project Report for Verification)	30%	Project Work Report	10%
Project Evaluation Phase-V (Project Final Internal Evaluation)	10%	Viva-voce	20%
Total	100	Total	100